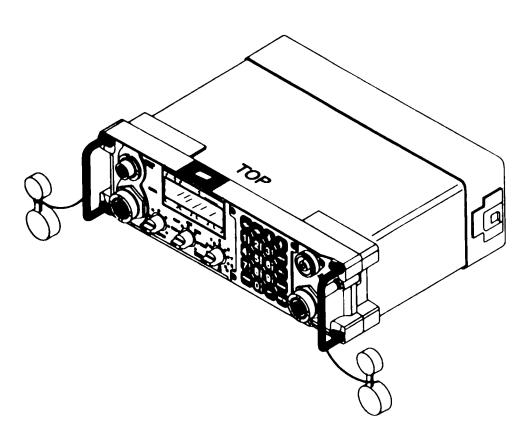
TECHNICAL MANUAL

UNIT AND DIRECT SUPPORT MAINTENANCE MANUAL



RECEIVER-TRANSMITTER, RADIO RT-1694A(P) (V)1/PRC-138 (NSN: 5820 01-417-5214) (EIC:N/A)

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HEADQUARTERS, DEPARTMENT OF THE ARMY

15 JUNE 1997



5

SAFETY STEPS TO FOLLOW IF SOMEONE IS THE VICTIM OF ELECTRICAL SHOCK



DO NOT TRY TO PULL OR GRAB THE INDIVIDUAL

IF POSSIBLE, TURN OFF THE ELECTRICAL POWER



IF YOU CANNOT TURN OFF THE ELECTRICAL POWER, PULL, PUSH OR LIFT THE PERSON TO SAFETY USING A DRY WOODEN POLE OR A DRY ROPE OR SOME OTHER INSULATING MATERIAL



SEND FOR HELP AS SOON AS POSSIBLE



AFTER THE INJURED PERSON IS FREE OF CONTACT WITH THE SOURCE OF ELECTRICAL SHOCK, MOVE THE PERSON A SHORT DISTANCE AWAY AND IMMEDIATELY START ARTIFICIAL RESUSCITATION

WARNING

HIGH VOLTAGE IS USED IN THE OPERATION OF THIS EQUIPMENT DEATH ON CONTACT MAY RESULT IF PERSONNEL FAIL TO OBSERVE SAFETY PRECAUTIONS

NEVER WORK ON ELECTRONIC EQUNT UNLESS THERE IS ANOTHER PERSON NEARBY WHO IS FAMILIAR WITH THE OPERATION AND HAZARDS OF THE EQUIPMENT AND WHO IS COMPETENT IN ADMINISTERING FIRST AID. WHEN THE TECHNICIANS ARE AIDED BY OPERATORS, THEY MUST BE WARNED ABOUT DANGEROUS AREAS.

WHENEVER POSSIBLE, THE POWER SUPPLY TO THE EQUIPMENT MUST BE SHUT OFF BEFORE BEGINNING WORK ON THE EQUIPMENT. TAKE PARTICULAR CARE TO GROUND EVERY CAPACITOR LIKELY TO HOLD A DANGEROUS POTENTIAL. WHEN WORKING INSIDE THE EQUIPMENT, AFTER THE POWER HAS BEEN TURNED OFF, ALWAYS GROUND EVERY PART BEFORE TOUCHING IT.

BE CAREFUL NOT TO CONTACT HIGH-VOLTAGE CONNECTIONS OR 115 VOLT AC INPUT CONNECTIONS WHEN INSTALLING OR OPERATING THIS EQUIPMENT.

WHENEVER THE NATURE OF THE OPERATION PERMITS, KEEP ONE HAND AWAY FROM THE EQUIPMENT TO REDUCE THE HAZARD OF CURRENT FLOWING THROUGH THE BODY.

WARNING DO NOT BE MISLED BY THE TERM "LOW VOLTAGE." POTENTIALS AS LOW AS 50 VOLTS MAY CAUSE DEATH UNDER ADVERSE CONDITIONS.

В

WARNING

SERIOUS INJURY OR EVEN DEATH CAN HAPPEN IF THE FOLLOWING ARE NOT CAREFULLY OBSERVED WHEN INSTALLING AND USING THE ANTENNAS USED WITH YOUR RADIO SETS.

BEFORE 1. ARE THERE ANY POWERLINES IN YOUR AREAOF OPERATION?

ANY MISSION

N 2. HOW HIGH ARE THESE POWERLINES?

3. HOW TALL ARE THE POLES OR TOWERS CARRYING POWERLINES?

MOBILE OPERATION WITH WHIP ANTENNAS



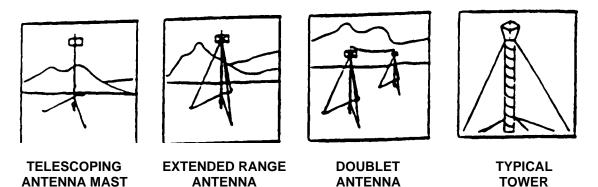
DO NOT STOP YOUR VEHICLE UNDER POWERLINES.

- If possible, try to maintain mobile communications with your antenna(s) tied down.
- Make sure an antenna tip cap is securely taped on the end of each whip antenna.
- Do not lean against or tough a whip antenna while the transmitter is on.
- During cross-county operation, do not allow anyone to stick an arm, leg or weapon over the sides of the vehicle. If your antenna accidentally touches a powerline, and a leg, arm or weapon contacts a damp bush or the ground, a serious or fatal accident can happen.
- If you am not sure that an antenna on your vehicle will clear a powerline, stop before you get close to the powerline and either carefully tie down the antenna or remove the antenna sections to make sure that you can drive safely under the powerline.

С

FIXED OPERATION WITH LING RANGE ANTENNAS

WARNING



NEVER ERECT LONG RANGE ANTENNAS DIRECTLY UNDER POWERUNES.

Before erecting a long range antenna, inspect all the parts making up the antenna kit. Do not erect the antenna if any parts are missing or damaged.

Do as much of the assembly work as possible on the ground.

When erecting the antenna. allow only team personnel in the erection area.

Make sure the area for the anchors is firm. If the ground is marshy or sandy, get specific instructions from your crew chief or supervisor on how to reinforce the anchors.

When selecting locations for anchors, avoid traveled areas and roads. If you cannot avoid these areas, get specific instructions from your supervisor as to what clearance your guy wires must have over the traveled areas and road.

Clearly mark all guy wires and ropes with the warning flags or signs supplied by your unit. In an emergency, use strips of white cloth as warning streamers.

If you suspect that powerlines have made accidental contact with your antenna, stop operations, rope off the antenna area, and notify your superiors.

If the weather in your area can cause ice to form on your long range antenna and its guy wires and ropes, add extra guys to support the system. Rope off the area and post it with warning signs like "BEWARE OF FALLING ICE."

Do not try to erect any antenna during an electrical storm.

Keep a sharp eye on your anchors and guys. Check them daily and immediately before and after bad weather.

D

REPORTING ERRORS AND RECOMMENDING IMPROVEMENTS

You can help improve this manual. If you find any mists, or if you know of a way to improve the procedures, please let us know. Mail your letter, DA form 2028 (Recommended Changes to Publications and Blank Forms), or DA form 2028-2 located in the back of this manual direct to: Commander, US Army Communications-Electronics Command and Fort Monmouth, ATTN: AMSEL-LC-LM-LT, Fort Monmouth, NJ 07703-5007. A reply will be sent to you.

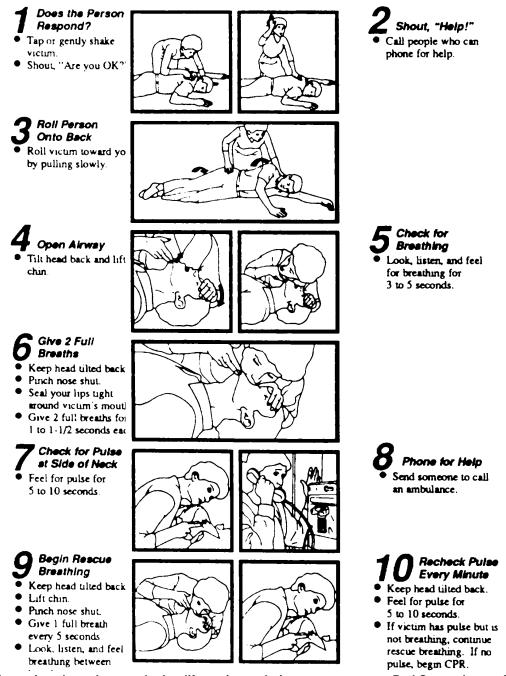
NOTE

All references in this manual that refer to the RT-1694(P) shall be substituted with RT-1 694A(P)(V)1/PRC-138 nomenclature.

E/F

When an Adult Stops Breathing

DO NOT attempt to perform the rescue breathing techniques provided on this page, unless certified Performance of these techniques by uncertified personnel could result in further injury or death to the victim.



For more information about these and other life-saving techniques, contact your Red Cross chapter for training "When Breathing Stops" reproduced with permission from an American Red Cross Poster

List of Abbreviations and Acronyms

Abbreviation	Term	
A, AMP	Ampere(s)	
ac, AC	Alternating Current	
ACE	Advanced Crypto Engine	
A/D	Analog-to-Digital Converter	
ADC	Analog-to-Digital Converter	
ADDR	Address	
ADP	Automated Data Processing	
ADT	Administrative Delay Time, Automated Data Terminal	
ADU	Automatic Dialing Unit	
AF	Audio Frequency	
AFC	Automatic Frequency Control	
AFSK	Audio Frequency Shift Keying	
A-G, A/G	Air-to-Ground	
AGC	Automatic Gain Control	
AIC	Analog Interface Chip	
ALC	Automatic Level Control	
ALE	Automatic Link Establishment	
AMD	Automatic Message Display	
AME	Amplitude Modulation Equivalent	
ANT	Antenna	
ANIIVOX	Voice-Operated Transmitter Key Inhibitor	
API	Analog Phase Interpolation	
ARQ	Automatic Repeat on Request	
ASI	Analog Signal Interface	
ASK	Amplitude Shift Keying	
ATE	Automatic Test Equipment	
AUD	Audio	
AUX	Auxiliary	
AVS	Analog Voice Security	
AWG	American Wire Gauge	
B/A	Buffer Amplifier	

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Abbreviation	Term	
вс	Broadcast, Binary Counter	
BCD	Binary-Coded Decimal	
BD	Baud, Binary Decoder	
BER	Bit Error Rate	
BFI	Beat-Frequency Oscillator	
BIT	Built-In Test	
BITE	Built-In Test Equipment	
BPI	Bits Per Inch	
bps	Bits Per Second	
BPSK	Binary Phase Shift Keying	
Btu	British Thermal Unit	
BW	Bandwidth	
CARC	Chemical Agent Resistive Coating	
СВ	Circuit Breaker	
CCW	Counterclockwise	
CDR	Critical Design Review	
CDRL	Contract Data Requirements List	
CFE	Contractor-Furnished Equipment	
CH, CHAN	Channel	
CI	Configuration Item	
СКТ	Circuit	
cm	Centimeter	
CMOS	Complimentary-Metal-Oxide-Semiconductor	
CNTL	Control	
CPU	Central Processing Unit	
CRC	Cyclic Redundancy Check	
CRT	Cathode Ray Tube	
CSM	Crypto Synch Message	
CTRL	Control	
стѕ	Clear to Send	
cw	Continuous Waved, Clockwise	
D/A	Digital-to-Analog Converter	

List of Abbreviations and Acronyms - Continued

iv

Abbreviation	Term
DAC	Digital-to-Analog Converter
DAM	Direct Access Memory
dB	Decibel(s)
dBm	Decibels referenced to 1 milliwatt
dc, DC	Direct Current
DCD	Data Carrier Detect
DE	Data Encryption
Demod	Demodulated
Diff	Differential
Dip, DIP	Dual In-Line Package
DMM	Digital Multimeter
DP	Double Pole
DPDT	Double Pole, Double Throw
DPRAM	Dual-Port RAM
DPST	Double Pole, Singlc Throw
DSP	Digital Signal Processor
DSR	Data Set Ready
DTL	Diode Transistor Logic
DTM	Data Text Message
DV	Digitized Voice
DTMF	Dual Tone Multi-Frequency
DTR	Data Terminal Ready
DUART	Dual Universal Asynchronous Receiver-Transmitter
DUSART	Dual Universal Synchronous/Asynchronous Receiver-Transmitter
0DVM	Digital Voltmeter
DVOM	Digital Volt-Ohm Meter
EAM	Embedded Adaptive Module
EAROM	Electronically Alterable Read Only Memory
ECM	Electronic Counter Measure
ECCM	Electronic Counter-Counter Measure
EEPROM,	Electrically Erasable Programmable Read Only Memory
E ² PROM	

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List of Abbreviations an	d Acronyms - Continued
--------------------------	------------------------

Abbreviation	Term	
ЕМІ	Electromagnetic Interference	
EOM	End of Message	
EPROM	Erasable Programmable Read-Only Memory	
FCC	Federal Communications Commission	
FD	Full Duplex	
FEC	Forward Error Correction	
FET	Field-Effect Transistor	
FIF	Flip-Flop	
FFT	Fast Fourier Transform	
FH	Frequency Hopping	
FSK	Frequency Shift Keying	
F/W, FW	Firmware	
G-A, G/A	Ground-to-Air	
GF	Government (or customer) Furnished	
GFE	Government-Furnished Equipment	
Gnd, GND	Ground	
GPIB	General Purpose Interface Bus	
HD	Half Duplex	
HDCP	Harris Data Communications Protocol	
HF	High Frequency	
HSS	High-Speed Synchronizer	
HSSB	High-Speed Serial Bus	
HWCI	Hardware Configuration Item	
Hz	Hertz	
IC	Integrated Circuit	
ID	Identification	
IDF	Intermediate Distribution Frame	
IF	Intermediate Frequency	
INT	Interrupt	
INTLK	Interlock	
INTR	Interrupt	

vi

Abbreviation	Term	
I/O	Input/Output	
ISB	Independent Sideband	
J	Joules	
k	Kilo (thousand)	
kbyte	Kilobyte	
kHz	Kilohertz	
km	Kilometer(s)	
kV	Kilovolt(s)	
kVA	Kilovolt Ampere(s)	
KVD	Keyboard Visual Display	
KVDU	Keyboard Visual Display Unit	
kW	Kilowatt(s)	
LBT	Listen Before Transmit	
LC	Inductive Capacitive	
LCD	Liquid Crystal Display	
LD	Lock Detect	
LED	Light-Emitting Diode	
LF	Low Frequency	
LLSB	Lower Sideband	
LOS	Line of Sight	
LP	Low Pass	
LPC	Linear Predictive Coding	
LQA	Link Quality Analysis	
LRU	Line Replaceable Unit	
LSB	Lower Sideband	
LSD	Least Significant Digit	
м	Meter, Mega (one million)	
m	Milli, one-one thousandth	
mA	Milliampere(s)	
Mbyte	Megabyte	
MDM	MODEM	

List of Abbreviations and Acronyms - Continued

vii

Abbreviation	Term
MHz.	Megahertz
MIC	Microphone
MIL-STD	Military Standard
mm	Millimeter(-)
Mod	Modification, Modulated
Mod/Demod	Modulator/Demodulator
Modem	Modulator/Demodulator
MOS	Metal Oxide Semiconductor
MOSFET	Metal Oxide Semiconductor Field Effect Transistor
ms, msec	Millisecond
MTBCF	Mean Time Between Critical Failure
MTBF	Mean Time Between Failure
МТВМ	Mean Time Between Maintenance
MTBR	Mean Time Between Replacement
MUF	Maximum Usable Frequency
Mux	Multiplex, Multiplexer
mVac	Millivolts Alternating Current
mVdc	Millivolts Direct Current
n	Nano(1 x 10 ⁻⁹)
NB	Narrowband
NC, N.C.	Normally Closed
N/C	Not Connected
NMOS	N-channel Metal-Oxide-Semiconductor
NO, N.O.	Normally Open
No.	Number
NPN	N-type, P-type, N-type (transistor)
nsec	Nanoseconds
Ω	Ohms, a unit of resistance measurement
O&M	Operation and Maintenance
O&R	operation and Repair
0.C.	Open Circuit or Open Collector

viii

Abbreviation	Term
ОЕМ	Original Equipment Manufacturer
Op Amp	Operational Amplifier
ocxo	Oven Controlled Crystal Oscillator
р	Pico
PA	Power Amplifier
PABX	Private Automatic Branch Exchange
РСВ	Printed Circuit Board
РСМ	Pulse Code Modulation
PEP	Peak Envelope Power
pF	Picofarad (1 x 10 ⁻¹² Farads)
PIV	Peak Inverse Voltage
PLL	Phase-Locked Loop
PNP	P-type, N-type, P-type (transistor)
P-P	Peak-to-Peak
PROM	Programmable Read Only Memory
PS	Power Supply
Pt Pt, Pt-Pt	Point-to-Point
PTT	Push-to-Talk
PWB	Printed Wiring Board
QTY	Quantity
R, RG	Receiver Circuit: Receive, Receive Ground (from teletype)
]RAD	Random Access Data
RAM	Random Access Memory
RC	Resistive Capacitive
RCU	Remote Control Unit
RCV/RX	Receive
RCVR	Receiver
RD	Read
RDY	Ready
REC	Receptacle
RETX	Retransmit

ix

Abbreviation	Term	
RF	Radio Frequency	
RFI	Radio-Frequency Interference	
RLPA	Rotatable Log Periodic Antenna	
RLSD	Receive Level Sense Detect	
RMS	Root Mean Squared	
ROM	Read-Only Memory	
RST	Reset	
RTC	Real Time Clock	
RTN	Return	
RTS	Request to Send	
RTTY	Radio Teletype	
RTU	Remote Terminal Unit	
S. SG	Send Circuit, Send Ground (to teletype)	
SA	Spectrun Analyzer	
SB	Sideband	
SCR	Silicon Controlled Rectifier	
SHLD	Shield	
SINAD	A ratio of (signal + noise + distortion) to (noise + distortion) used to measure the signal quality of a communication channel. SINAD is commonly used to evaluate the ability of a channel to pass voice traffic.	
Sip, SIP	Single In-Line Package	
SMD	Surface-Mount Device	
SNR	Signal-to-Noise Ratio	
SOM	Start of Message	
SP	Single Pole	
SPDT	Single-Pole, Double-Throw	
SSB	Single Sideband	
ST	Single Throw	
SWR	Standing Wave Ratio	
SYNC	Synchronous	
ТВ	Terminal Board	
тсхо	Temperature Controlled Crystal Oscillator	

Х

Abbreviation	Term
TDQPSK	Time Differential Quaternary Phase Shift Keying
TGC	Transmitter Gain Control
T/R	Transmit/Receive
тт	Teletype
ТТГ	Transistor-Transistor Logic
TT VF'T	Teletype Voice Frequency Tone
ТТҮ	Teletype
тх	Transmit
u	Micro(1 x 10^{-6})
UART	Universal Asynchronous Receiver-Transmitter
uF	Microfarad (1 x10 ⁻⁶ Farads)
UHF	Ultra High Frequency
USART	Universal Synchronous/Asynchronous Receiver-Transmitter
USB	Upper Sideband
usec	Microseconds
UUSB	Upper Upper Sideband
UUT	Unit Under Test
uW	Microwave
V	Volt
VA	Volt-Ampere
Vac	Volts, Alternating Current
VCA	Voltage Controlled Attenuator
vco	Voltage Controlled Oscillator
VDC, Vdc	Volts, Direct Current
VDU	Video Display Unit
VECT	Vector
VF	Voice Frequency
VFO	Variable Frequency Oscillator
VFR	Voice Frequency Repeater
VHF	Very High Frequency
VLF	Very Low Frequency

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List of Abbreviations and Acronyms - Continued

Abbreviation	Term
vmos	V-groove Metal-Oxide -Semiconductor
VOM	Volt-Ohm-Meter
vox	Voice Operated Transmitter
Vpp	Volts peak-to-peak
vswr	Voltage Standing Wave Ratio
w	Watt(s)
WRL	Wire Run List
XCVR	Transceiver
хмт	Transmit
XMTR	Transmitter

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SAFETY SUMMARY

1. INTRODUCTION

All operators and maintenance personnel must observe the following safety precautions during operation and maintenance of this equipment. Specific warnings and cautions are provided in the manual and at the end of this Safety Summary. Warnings, Cautions, and Notes appear before various steps in the manual and will be used as follows:

- WARNING Used when injury or death to personnel and damage to equipment is possible
- CAUTION Used when there is a possibility of damage to equipment
- NOTE Used to alert personnel to a condition that requires emphasis

2. PERSONNEL AND EOUIPMENT SAFETY

Basic safety precautions consider factors involved in protecting personnel from injury or death. Electrical, mechanical, electromagnetic radiation (EMR), material, or chemical hazards are the most common types of hazards found in electronic equipment. The following are types of hazards that may exist:

- **ELECTRICAL** Hazardous voltage and current levels may exist throughout the equipment. Contact with these hazards could cause electrocution, electrical shock, bums, or injury due to involuntary reflexes of the body.
- **MECHANICAL** Mechanical hazards are created when heavy assemblies and components must be removed and replaced. Moving parts (such as fan blades) and hot surfaces are potential mechanical hazards.
- THERMAL Burn hazards may exist in the equipment that could cause personal injuries and/or serious equipment damage. Internal surfaces of the equipment may be in excess of 65°C, the point at which personnel could be burned. Extreme caution should be used when working with any hot assemblies (for example, power supply or power amplifier assemblies). Physical injury or damage may result to personnel and/or equipment as a result of a reflex action to a burn.
- **CHEMICAL** Chemicals or materials used for servicing the equipment may present potential hazards. Many chemical agents, such as cleaners and solvents, may be toxic, volatile, or flammable. If used incorrectly, these agents can cause injury or death.
- **EMR** Overexposure to electromagnetic radiation results from amplified radio frequencies may produce a health hazard.

3. OPERATIONAL AND MAINTENANCE SAFETY GUIDELINES

Good safety discipline is critical to prevent injury to personnel. All other safety measures are useless if personnel do not observe the safety precautions and do not follow safety disciplines. Once aware of a hazard, personnel should ensure that all other personnel are aware of the hazard. The following basic safety disciplines are stressed:

- a. Read a procedure entirely before performing it. Personnel must always perform each assigned task in a safe manner.
- b. Prior to applying equipment power after maintenance, personnel must ensure that all unsecured hand tools and test equipment are disconnected from the serviced/maintained equipment and properly stored.

- c. Power to the equipment must the removed before a piece of equipment is removed.
- d. Extreme care must be used when adjusting or working on operating equipment. Voltages in excess of 70 V or current sources in excess of 25 A are covered with barriers. Barriers include warning information about the heard encountered upon barrier removal.
- e. Personnel must react when someone is being electrically shocked. Perform the following steps:
 - 1. Shut oft power
 - 2. Call for help.
 - 3. Administer first aid if qualified.

Under no circumstances should a person come directly in contact with the body unless the power has been removed When immediate removal of the power is not possible, personnel must use a non-conductive material to try to jolt or pry the body away from the point of shock.

- f. Personnel should work with one hand whenever possible to prevent electrical current from passing through vital organs of the body. In addition, personnel must never work alone. Someone must be available in the immediate area to render emergency first aid, if necessary.
- g. Lifting can cause injury Items weighing more than 37 pounds must be lifted by two or more people.
- h. Some electrolytic capacitors contain aluminum oxide or tantalum. If connected incorrectly, the capacitor will explode when power is applied. Extreme care must be used when replacing and connecting these capacitors The capacitor terminals must always be connected using the correct polarity: positive to positive and negative to negative.

The next section contains general safety precautions not directly related to specific procedures or equipment. These precautions are oriented toward the maintenance technician However, all personnel must understand and apply these precautions during the many phases of operation and maintenance of the equipment. The following precautions must be observed:

DO NOT SERVICE EQUIPMENT ALONE

Never work on electrical equipment unless another person familiar with the operation and hazards of the equipment is near When the maintenance technician is aided by operators, ensure that operators are aware of the hazards.

GROUNDING

Always ensure that all equipment and assemblies are properly grounded when operating or servicing.

TURN OFF POWER AND GROUND CAPACITORS

Whenever possible, power to equipment should be turned off before beginning work on the equipment Be sure to ground all capacitors that are potentially dangerous

KEEP AWAY FROM LIVE CIRCUITS

Operators and maintainers must observe all safety regulations at all times Do not change components or make adjustments inside equipment with a high voltage supply on unless required by the procedure. Under certain conditions, dangerous potentials may exist in circuits with power controls off, due to charges retained h! capacitors

DO NOT BYPASS INTERLOCKS

Do not bypass any interlocks unnecessarily. If it is necessary to employ an interlock bypass for equipment servicing, use extreme care not to come in contact with hazardous voltages.

USE CARE HANDLING HEAVY EQUIPMENT

Never attempt to lift large assemblies or equipment without knowing their weight. (;se enough personnel or a mechanical lifting device to properly handle the item without causing personal injury.

HEED WARNINGS AND CAUTIONS

Specific warnings and cautions are provided to ensure the safety and protection of personnel and equipment. Be familiar with and strictly follow all warnings and cautions on the equipment and in technical manuals.

PROTECTIVE EYEWEAR

All personnel must wear protective eyewear when servicing or maintaining equipment. Protective eyewear must be worn at all times when using tools.

4. PROTECTION OF STATIC-SENSITIVE DEVICES



Diode input-protection is provided on all CMOS devices. This protection is designed to guard against adverse electrical conditions such as electrostatic discharge. Although most static-sensitive devices contain protective circuitry, several precautionary, steps should be taken to avoid the application of potentially damaging voltages to the inputs of the device.

To protect static-sensitive devices from damage, the following precautions should be observed

- a. Keep all static-sensitive devices in their protective packaging until needed This packaging is conductive and should provide adequate protection for the device. Storing or transporting these devices in conventional plastic containers could be destructive to the device.
- b. Disconnect power prior to insertion or extraction of these devices. This also applies to PWBs containing such devices.
- c. Double check test equipment voltages and polarities prior to conducting any tests.
- d. Avoid contact with the leads of the device. The component should always be handled carefully by the ends or side opposite the leads.
- e. Avoid contact between PWB circuits or component leads and synthetic clothing.
- f. Use only soldering irons and tools that are properly grounded. Ungrounded soldering tips or tools can destroy these devices. <u>SOLDERING GUNS MUST NEVER BE USED.</u>

5. EXPLANATION OF HAZARD SYMBOLS



The symbol of drops of a liquid onto a hand shows that the material will cause burns or irritation of human skin or tissue.



The symbol of a person wearing goggles shows that the material will injure your eyes.



The symbol of a flame shows that a material can ignite and bum you.



The symbol of a human figure in a cloud shows that vapors of a material present danger to your life or health.

The symbol of a skull and crossbones shows that a material is poisonous or a danger to life.



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RT-1694 (P) RECEIVER-TRANSMITTER

INTERMEDIATE MAINTENANCE MANUAL

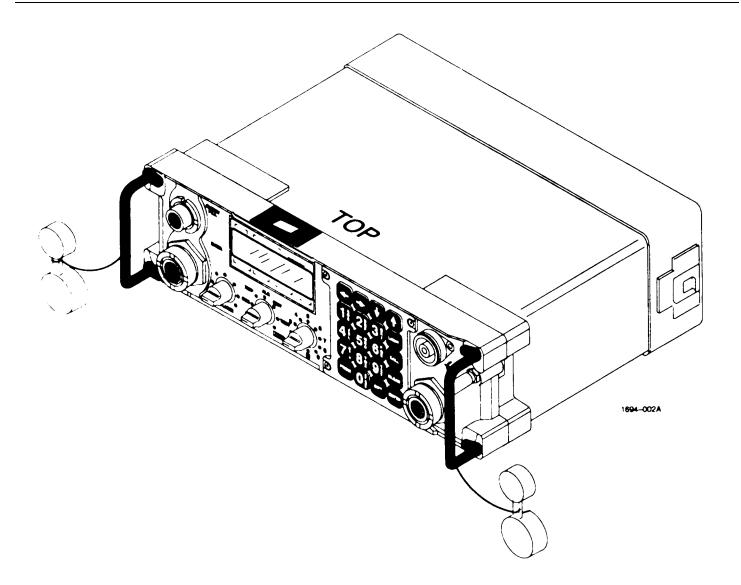


Figure 1-1. RT-1694(P) Receiver-Transmitter

CHAPTER 1

GENERAL INFORMATION

1.1 SAFETY PRECAUTIONS

All safety precautions necessary for the protection of personnel and equipment are cross-referenced in the following list. The WARNING or CAUTION is referenced to the paragraph number where it is used in the manual, and a brief subject phrase indicating the content is provided. Read these items in their entirety before performing the referenced procedure.

- CAUTION Paragraph 4.2.1.2 If Power Amplifier is installed, provide adequate RF protection for Signal Generator
- WARNING Paragraph 6.3.1 High voltages are present if power is not removed
- CAUTION Paragraph 6.3.2 Use precautions when handling electrostatic sensitive devices
- CAUTION Paragraph 6.3.5 Use correct tool
- CAUTION Paragraph 6.3.6 Caution on damaging wires, cables, or connectors during repair
- WARNING Paragraph 6.4.2.1 High voltages are present if power is not removed
- WARNING Paragraph 6.4.2.2 High voltages are present when applying power
- WARNING Paragraph 6.5.1 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- WARNING Paragraph 6.5.2 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- WARNING Paragraph 6.5.3 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.3 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.4 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.4 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.5 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.5 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.6 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.6 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.7 Remove electrical connections to receiver-transmitter before removing and replacing assemblies

- CAUTION Paragraph 6.5.7 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.8 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.8 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.9 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.9 Use precautions when handling electrostatic sensitive devices
- CAUTION Paragraph 6.5.9.1 Do not overextend W2 Coaxial Cable Assembly
- WARNING Paragraph 6.5.10 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.10 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.11 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.11 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6 5.12 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- CAUTION Paragraph 6.5.12 Use precautions when handling electrostatic sensitive devices
- WARNING Paragraph 6.5.13 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- WARNING Paragraph 6.5.14 Remove electrical connections to receiver-transmitter before removing and replacing assemblies
- WARNING Paragraph 8.2.3 Do not daisy-chain ground connections

1.2 MAINTENANCE LEVELS

1.2.1 Introduction

Harris RF Communications designs its products and systems to be supported by up to four maintenance levels See Figure 1-2. Each maintenance level relics on a defined set of support documentation and equipment in order to fulfill its maintenance tasks. The tasks performed at each level grow in complexity as fault isolation is narrowed to the component causing the fault This concept assists the maintainer by supplying only the information and materials required for that maintenance level. These levels may be combined to sustain any particular user maintenance philosophy.

1.2.1.1 Level I

This level is restricted to fault recognition and detection Fault isolation is not usually performed at this level An operator who detects a faulty condition alerts Maintenance Level 11 for repair.

1.2.1.2 Level 11

The maintenance technician repairs the radio system by utilizing a System (Level 11) manual to fault isolate to the faulty unit (for example, receiver-transmitter, power amplifier, antenna coupler. etc.) The faulty Line Replaceable Unit (LRU) is replaced with a spare and sent to Maintenance Level 111.

1.2.1.3 Level III

The faulty unit is serviced at a facility that has support equipment available, typically a hot test bed radio system. The suspected faulty unit is inserted into the hot test bed radio system and troubleshot down to the faulty assembly using a Maintenance (Level 111) manual. The faulty Shop Replaceable Unit (SRU) is replaced with a spare and passed to Maintenance Level IV.

1.2.1.4 Level IV

The faulty SRU is returned to Harris/RF Communications for repair. If Level IV maintenance capabilities are available onsite, the maintenance technician can identify the faulty component on the SRL, using a Depot Maintenance (Level IV) manual that outlines the electronic maintenance techniques and test fixtures necessary to repair the SRU.

1.2.2 Purpose of this Manual

This manual provides the user with all technical information required to support Level III maintenance as described in Paragraph 1.2.1.3.

The overall intent of this manual is to help the maintainer expedite repair of the unit in a reasonable amount of time, resulting in reduced down-time and increased system availability. Detailed information that will be useful to the maintainer is provided: unit configuration. equipment specifications, fault isolation and repair techniques, required tools and test equipment, and functional descriptions of assemblies.

1.2.3 Maintenance Support Packages

Hams RF Communications designs maintenance packages that support these levels Packages include the necessary spare pans. training. technical manuals, tools, test equipment, and maintenance aids such as interface cables, extender cards, and test fixtures.

Refer to Chapter 9, Accessories, for more information on support packages designed to enhance the effectiveness of this unit.

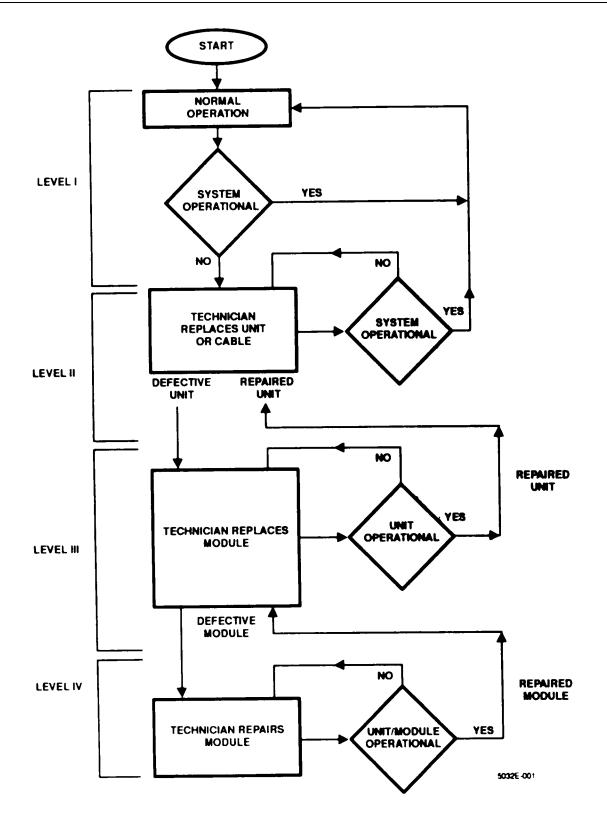


Figure 1-2. Typical Maintenance Flow Chart

1.2.4 Scope

This manual contains operation information, functional description, scheduled maintenance, troubleshooting, corrective maintenance, parts lists, and installation information for the receiver-transmitter. This publication does not supersede any previous manual or technical documentation. The information contained in this manual only applies to the RT-1694(P) Receiver-Transmitter [RT-1694(P)] configuration of the receiver-transmitter.

1.2.5 Warranty

Harris Corporation guarantees that if the RT-1694(P) fails from normal use within one year from the date of shipment due to a defect in workmanship or materials, Harris will repair or replace the receiver-transmitter at no charge. Repairs made by Harris to the receiver-transmitter under this warranty are warranted to be free from defects in material and workmanship for 60 days from the date of repair.

For information on how to process a claim under this warranty, and on what is not covered by this warranty, refer to the warranty information printed on the inside front cover of this manual.

1.3 GENERAL EOUIPMENT DESCRIPTION

1.3.1 General

Figure 1-1 shows the RF- 1694(P).

The RT-1694(P) operates from 1.6 MHz to 59.9999 MHz. All functions are controlled from the front panel of the receivertransmitter, or from a remote terminal. Optional modules are installed in the chassis.

1.3.2 Front Panel

A 32-character, alphanumeric display provides system status and reflects data entry to simplify operation aid programming. The receiver-transmitter is also connected to the antenna and external system units via front panel connectors.

1.3.3 Rear Panel

When used in the manpack configuration, the battery case is attached to the rear panel of the receiver-transmitter.

1.3.4 Features

The RT-1694(P) has the following features:

- Frequency range of 1.6 MHz to 59.9999 MHz
- Lower Side-Band (LSB), Upper Side-Band (USB), Amplitude Modulation Equivalent (AME), Frequency Modulation (FM), and Continuous Wave (CW) modes of operation
- 100 preset channels available
- 50 ohm nominal, unbalanced RF input/output impedance
- RS-232C or MIL-188C Data Interface
- Optional plug-in modules (refer to Paragraph 1.3.5)
- 15 mW audio output to external handset

1.3.5 Configuration Information

Figure 1-3 shows the RT-1694(P) family tree, which identifies all of the assemblies that make up a receiver-transmitter. Two plug-in modules are a-available to provide the exact radio features desired

- RF-5161-01 Performance Option (A3LPC Vocoder Assembly)
- RF-5170 Security Option (A1A2 Encryption PWB Assembly)

For more information on these options, refer to Chapter 3, Functional Description.

1.3.5.1 Ancillary Kit

The RT-1694(P) (10372-1000-01) is not ,applied with an ancillary items kit See the RT-1694(P), Figure 1-3

1.3.5.2 Unit Identification

Receiver-transmitter identification information is located on the front panel identification tag. This tag contains model, part, and serial number information. See MP21 on Figure 7-1.

1.3.6 General System Relationship

Figure 1-4 shows the receiver-transmitter in the manpack configuration. Figure 1-5 shows the receiver-transmitter in the vehicular configuration. For information on installation variations, refer to Chapter 8, Installation. Also refer to the RF-5200 FALCON Series Tactical Communications Manpack System Manual (10515-0006-4200).

When used in the manpack configuration, batteries provide +24 Vdc to the RT-1694(P). The exciter assembly provides a low-power Radio Frequency (RF) signal to the power amplifier assembly. This assembly amplifies the signal up to 20 watts. The power amplifier assembly passes the amplified RF signal to the antenna coupler assembly, which passes the signal to the OE-505 Antenna.

When used in the vehicular configuration, the RT-1694(P) is the exciter and controller for an external power amplifier and antenna coupler. The vehicle alternator/battery system provides +28 Vdc to the power amplifier. The low-power exciter RF output is passed to the external power amplifier via the RT-1694(P)-PA coax cable. The high-power RF output of the power amplifier is sent to the external antenna coupler via the PA-coupler coax cable. The RT-1694(P) communicates with the antenna coupler via the RT-1694(P)-PA control cable and the PA-coupler control cable. For more system information, refer to Chapter 3, Functional Description.

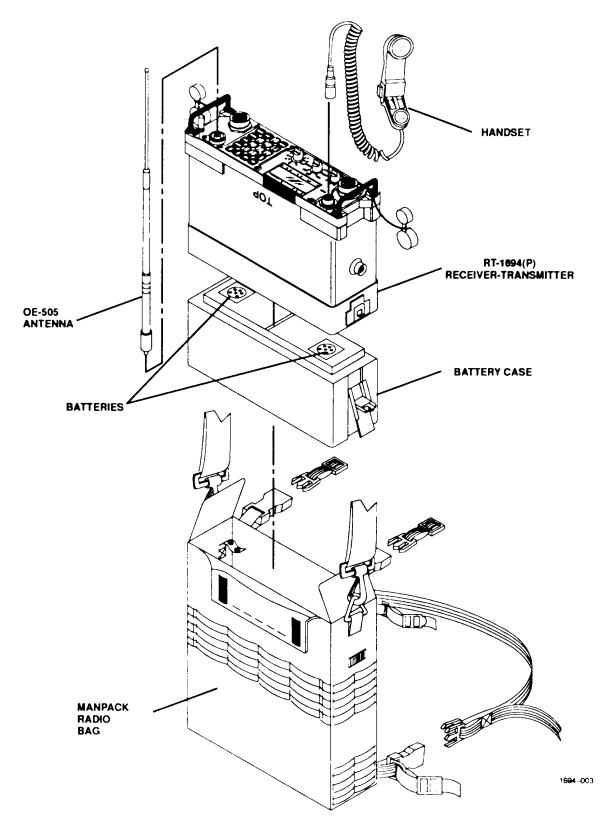


Figure 1-4. RT-1694(P) Receiver-Transmitter In Manpack Configuration

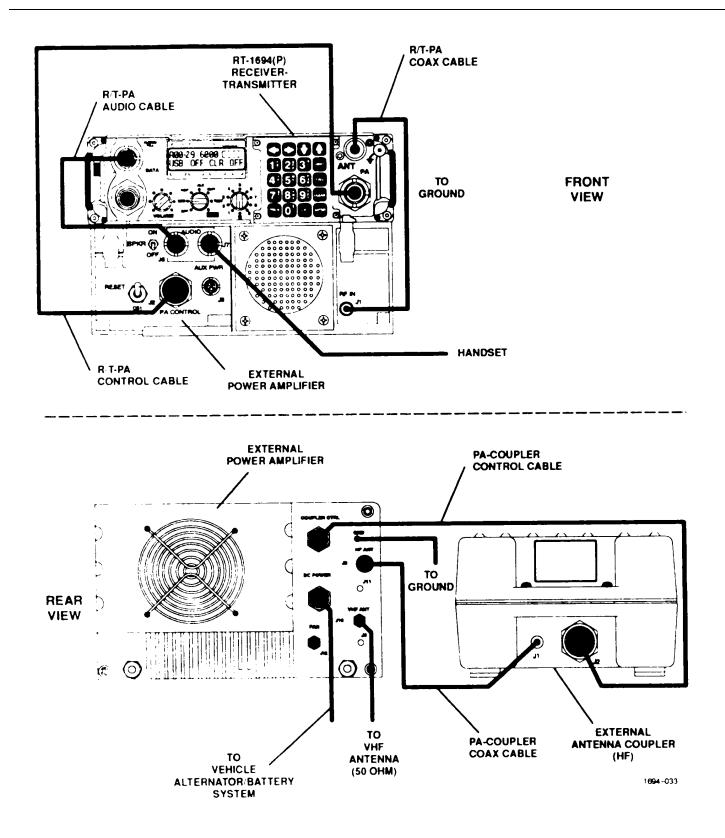


Figure 1-5. RT-1694(P) Receiver-Transmitter In Typical Vehicular Configuration

1.3.7 Specifications

The following tables provide information covering the specifications of the RT- I 694(P), the RF-5 161 -01 Performance Option, and the RF-S 170 Security Option. Refer to the following tables for specifications:

- Table 1-1 for RT- I694(P) specifications
- Table 1-2 for high-speed data modem specifications
- Table 1-3 for Automatic Link Establishment (ALE) specifications
- Table 1-4 for voice processor specifications
- Table 1-5 for frequency hopping specifications
- Table 1-6 for digital encryption specifications

Table 1-1. RT-1694(P) Receiver-Transmitter Specifications

ification		
GENERAL		
r or lower, suppressed sideband plus full ca		
suppressed carrier)		
ced		
1.6 to 60	MHz	
1.6 to 60	MHz	
3.5 to 30	MHz	
3 to 30N	Hz	
onous RS-232C and M	IL- 1 88C	
26.4W >	21 .6D x 7.8H cm	
(10.4W	(8.5D x 3.1H in.)	
	33.8D x 7.8H cm	
(10.4W	(13.3D x 3.1H in.)	
tery	/	
nd two Ni-Cd batteries		
Option (A3 LPC Vocod	er Assembly);	
A1A2 Encryption PWB		

Function	Specification	
	RECEIVER	
Sensitivity (without preamplifier)	SSB: -110dBm (0.7 uV) for 10 dB SINAD	
	(2.7 kHZ bandwidth)	
	AM: -98 dBm (2.8 uV) for 10 dB SINAD	
	(6 kHz bandwidth 30% modulation)	
	CW: -117 dBm (0.3 uV) for 10 dB (S+N)/N	
	(0.35 kHz bandwidth) FM: -107 dBm (1.0 uV) for 10 dB SINAD	
Audio Output	15 mW at 1000 ohms into external handset	
Squelch	Front panel selectable, 150Hz subcarrier (FM) or RWAS (HF SSB)	
Image and IF Rejection	Greater than 80 dB	
Spurious Responses	Less than 10 greater than -90dBm equivalent input;	
	fewer than 500 are greater than -120 dBm equivalent input	
AGC Characteristics	Mode dependent, selectable from front panel	
Intermodulation Distortion	In band -45dB or better for two -20 dBm signals within the IF passband	
	Out of band: -80 dB or better for two -35 dBM signals separated	
	100 kHz or more	
Overload Protection	Receiver protected to 70 Vms	
	TRANSMITTER	
Power Output	SSB, CW, AME: 1, 5, 20 watts PEP/Average	
	FM: 1, 5, 10 watts	
Carrier Suppression	Greater than 60 dB below PEP output (J3E mode)	
Undesired Sideband Rejection	Greater than 60 dB below PEP output	
Intermodulation Distortion	1.6 - 29 9999 MHz. 24 dB minimum 30.0 - 59.9999 MHz: 18 dBm minimum	
Audio Input	Handset: 1 5 mVrms into 150 ohms	
	Fixed Level: 0.774 Vrms into 600 ohms	
ΝΟΤΕ		

Table 1-1. RT-1694(P) Receiver-Transmitter Specifications - Continued

Because Harris engineers continuously strive to maintain all aspects of Harris equipment, specifications are subject to change without notice.

Function	Specification
	39-TONE MODE
Data Rates	2400, 1200, 600, 300, 150, 75 bps
Transmission Mode	Half duplex
FEC Coding	(14, 10, 2) Reed-Solomon Code at 24(X) bps
	(7, 3, 2) Reed-Solomon Code at lower bps rates
Interleaving	Four levels (short, long, alternate short, alternate long)
Tone Library	39 Tones, 675 to 2812.5 Hz, 56.25-Hz tone spacing,
	Doppler tracking tone: 393.75 Hz
Modulation	TDQPSK (four phase)
Demodulation	128-point FFT
Doppler Correction	75 Hz, tracking up to 3.5 Hz per second
Channel Bandwidth	3000 Hz
	BINARY FSK MODE
Data Rate	300, 150, 75 bps
Transmission Mode	Half duplex
Signaling	Phase Continuous Binary FSK
FSK Modes	Front-Panel Selectable
	Wide Shift: 2000 Hz ± 425 Hz (75, 150, 300 bps)
	Narrow Shift: 2805 Hz <u>+</u> 42.5 Hz (75 bps)
	Alternate: 20(X) Hz ± 85 Hz (75, 150 bps)
	Variable: Programmable mark/space: 350 Hz - 3000 Hz
	(75, 150, 300 bps)
	DATA INTERFACES
Data	Asynchronous (4800, 2400, 1200, 600, 300, 150, 75 bps), ASCII
	Synchronous (2400, 1200, 600, 300, 150, 75 bps;
	internal or external clock)
Control	RTS CTS, XON-XOFF, CTRL-B (key), CTRL-C (unkey)
Electrical	RS-232C, MIL-STD- 188C
Remote Control	Full function
	I
	1-13

Table 1-2. High-Speed Data Modem Specifications

Function	Specification	
	PROGRAMMING	
Parameters	Radio channel groups, local addresses, individual (remote) addresses, network addresses, time of day, LQA start time and repeat interval, antenna coupler tune time, link timeout 1 year minimum	
Retention	r year minimum	
	CHANNELS	
Number Frequency Range Full Performance: 1.6 to 30 MHz	100 simplex and/or half duplex Operating: 1.6 to 59.9999 MHz	
Mode Channel Scan Groups	USB, LSB, AME, FSK, CW, data. digital voice 10	
SCAN		
Rate Scanned Channels Channel Scan Groups	5 channels per second 100 channels maximum 10	
	SELECTIVE CALLING	
Types	Individual, net, al call may be placed from front panel or remote. Any calls, selective any calls, and wildcard calls may be placed from remote only. Group calls can be received, but not placed.	
Channel Selection	Automatic or manual	
Handshake	3-way for individual, net, group, any, wildcard; 1-way for allcalls	
Other	Digital squelch, listen before transmit (ALE traffic only), key-to-call	
ADDRESSES		
Format Local Address Network Addresses Individual Addresses	1 to 15 character, alphanumeric 20 maximum 20 maximum 200 maximum	

Table 1-3. Automatic Link Establishment	(ALE)	Specifications
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Table 1-3. Automatic Link Establishment (ALE) Specifications - Conti	nued
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Function	Specification	
LINK QUALITY ANALYSIS		
Types	Sounding (1 way) and exchange (3 way handshake)	
Measurement	Weighted average based on SINAD and pseudo bit error rate (PBER) as per MIL-STD-188-141A	
Start Time	Immediate, or programmed time-of-day	
Repeat Interval	One time, or interval (hours/minutes)	
Addresses Queued	10 maximum	
LQA Score Storage	100 channels x 200 addresses x 2 directions	
	SIGNALING	
Modulation	Phase continuous 8-ary FSK	
Symbol Rate	125 baud	
Bit Rate	375 bps	
Coding	Golay FEC, 2/3 majority vote, interleaving	
Calling Cycle	1 to 79 seconds (depending on call type, channels scanned, and call sign	
length)		
BUILT-IN TEST		
Functions Tested	ALE, radio, power amplifier, antenna coupler	
REMOTE CONTROL		
Interface	RS-232C	
Rate	300 to 9600 baud asynchronous	
Other	2 stop bits, 8 data bits, no parity ASCII character based (compatible with existing RF-5000 remote control)	

Function	Specification	
	GENERAL	
Audio Input	Handset connector: 1.5 mVrms into 150 ohms. 600 ohm auxiliary connector: 0/-10 dBm	
VOICE DIGITIZATION		
Algorithm	LPC-10-52E	
Bit Rates	24(X) (single channel) or X(X) bps (frequency hopping)	
Bit Error Tolerance	2 x 10 ⁻² random BER for DRT greater than 80	
Synchronization Tracking	Frame synchronization at beginning of message Continuous synchronization during message	
End of Message	End of message data or loss of tracking data for two seconds	
ANALOG VOICE SECURITY (AVS)		
Encryption Algorithm Bands Maximum Transmit Delay Number of Codes	Split band inversion with time diversity scrambling 24 0.5 second 10 ⁺⁸	

Function	Specification
Frequency Range Hopping Restrictions Hop Rate Data Rate Forward Error Correction Hop Nets Hopping Bandwidths	2.0 MHz to 29.9950 MHz Wide Band and List modes not available when internal antenna coupler is enabled or external antenna coupler is attached 20 hops/second 75, 150, 3(X) bps Frequency diversity (all rates); 14, 10, 2 Reed-Soloman (75, 150, 300 bps) 10 (synchronization on only one of the ten nets at a time) Wide Band: Programmable bandwidth: 70 kHz to 2 MHz Minimum lower frequency: 2.0 MHz Maximum upper frequency: 29.995 MHz Narrow Band: Center frequency: 15 MHz \leq Fc \leq 29.995 MHz Bandwidth: 300 kHz
	Bandwidth: 300 kHz NB spacing: 5 kHz Center frequency: 5 MHz \leq Fc \leq 15 MHz Bandwidth: 100 kHz NB spacing: 2.5 kHz Center frequency: 3.5 MHz \leq Fc \leq 5 MH7 Bandwidth: 50 kHz NB spacing: 2.5 kHz Center frequency: 1.6 MHz \leq Fc \leq 3.5 MHz
Frequency Spacing Frequency List Hopset Exclusions PN Generator Initial Sync Time Late Net Entry Time	Bandwidth: 17.5 kHz (7.5 kHz - Iow, 10 kHz - high) Frequency List: Programmable bandwidth: 70 kHz to 2 MHz Minimum lower frequency: 2.0 MHz Maximum upper frequency: 29.995 MHz Wide Band Mode: 5 kHz. Narrow Band Mode: 5 kHz. Narrow Band Mode: 2.5 kHz, 5 kHz center frequency dependent Frequency List Mode: 5 kHz 15 to 100 frequencies Sub-bands (10 total) - wideband hopping only Non-linear, repeat cycle > 5 years 29 seconds - required once per 8-hour penod 29 seconds

Table 1-5.	Frequency Hopping Specifications
10010 1 0.	

Table 1-5. Frequency Hopping Specifications - Continued	
Function	Specification
In-Net Message Sync	Coarse Synchronization: continuous for up to 8 hours Fine Synchronization : 300 millisecond typical after key-down.
Excision Filtering	Excision of up to two single frequency interfering signals within the audio passband (typically provides greater than 25 dB equivalent filtering)

Function	Specification
	GENERAL
Frequency Range	The radio is capable of operating in digital voice mode from 1.6 MHz to 59.9999 MHz and meets full performance specifications in this mode from 1.6 MHz to 29.9999 MHz.
Algorithm	LPC-10-52E
Bit Rates	2400 bps in single channel or 800 bps in frequency hopping
Synchronization	Frame synchronization at beginning of message
Tracking	Continuous synchronization during message
End of Message	End of message data or loss of tracking data for two seconds
	PROGRAMMERS
RF-5960 Master Code Programmer	The RF-5960 Master Code Programmer provides programming of the
	Data Encryption Option with six key codes with up to 1×10^{52} possible
	combinations in a portable configuration. Operates from 115/230 Vac,
	50/60 Hz, or as a portable unit on an internal BB-590/U rechargeable Nickel-Cadmium battery. The internal battery is automatically recharged
	when operated on AC.
Available Codes	1×10^{52} possible settings
Power	115/230 Vac, 50/60 Hz, or internal BB-590/U rechargeable
Sinc	Nickel-Cadmium battery
Size Weight	5.38H x 7.5W x 8.5D in. (11.8H x 16.5W x 18.7D cm) 11.5 lb (29 kg)
RF-5961 Field Code Programmer	The RF-5961 Field Code Programmer is a pocket-sized unit that permits
	programming of the Digital Encryption Unit option (each with six key
	codes having up to 10 ⁵² combinations). A self-contained lithium battery
	retains codes, and has an emergency code dump feature. RF-5960
	Master Code Programmer is required to insert codes
Key Codes	Stores six of the available 1 x 10^{52} codes for loading
Power	Internal lithium battery
Size	1.25H x 1.93W x 5.6D inches (2.8H x 4.2W x 12.3D cm)
Weight	0.5 lbs. (1.3 kg)

Table 1-6. Digital Encryption Specifications

1.4 GENERAL DESCRIPTION OF MAJOR ASSEMBLIES

1.4.1 General

Table 1-7 lists the major assemblies of the receiver-transmitter. Figure 1-6 shows the locations of the assemblies in the receiver-transmitter.

Reference Designation	Assembly/Subassembly Name	Function
A1A1	Interface PWB Assembly	Provides the data interface between the RT- 1694(P) and various types of external devices. If A1A2 Encryption PWB Assembly (RF-5 170 option) is installed, it connects directly to A1A1 Interface PWB Assembly.
A1A2	Encryption PWB Assembly (RF-5170 option)	Provides the receiver-transmitter with the ability to encrypt and decrypt digital data. If A3 LPC Vocoder Assembly (RF-5161-01 option) is also installed, A1A2 PWB Assembly provides digital voice capabilities.
А3	Linear Predictive Coding (LPC) Vocoder Assembly (RF-5161-01 option)	A3 LPC Vocoder Assembly can be factory configured to provide either Digital Voice or Analog Voice security. When configured for digital voice, this assembly provides secure voice communications using Forward Error Correction (FEC) with a similarly equipped receiver- transmitter. When used with the RF-5170 option, encrypted digital voice provides an extremely high level of security. When configured for Analog Voice Security (AVS), this assembly provides secure voice by scrambling the transmitted audio signal.
A4	Signal Processor PWB Assembly	Provides control and coordination of all functional part.> of the receiver-transmitter during operation and self-test. This assembly is divided into five functional areas: Main Controller, Digital IF/AGC, Modem, Frequency Hopping, and Automatic Link Establishment (ALE). For more information on each of these functional areas, refer to Chapter 3, Functional Description.
A5	Receiver/Exciter Assembly	When receiving, this assembly converts HF and VHF signals to an intermediate frequency for processing by A4 Signal Processor PWB Assembly. When transmitting, this assembly converts the intermediate frequency from A4 Signal Processor PWB Assembly to a 100 milliwatt RF output signal.
		1-19

Table 1-7.	Assemblies and	Reference	Designators
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Reference Designation	Assembly/Subassembly Name	Function
A6	Synthesizer Assembly	A6 Synthesizer Assemble consists of a reference generator assembly and a synthesizer assembly The reference generator assembly contains a temperature-compensated crystal oscillator that provides a stable frequency reference for the radio The synthesizer assembly generates the first Local Oscillator (first LO) signal that is used to convert a received or transmitted signal between 1.600 and 59.9999 MHz to an IF frequency of 80.5 MHz.
A7	Power Supply Assembly	This assembly is a switching power supply that generates the fixed voltages used throughout the receiver-transmitter.
A8	Power Amplifier/Battery Charger Assembly	AX Power Amplifier/Battery Charger Assembly consists of a power amplifier/battery charger assembly and a harmonic filter assembly The power amplifier/battery charger assembly amplifies the 100 milliwatt output signal from A5 Receiver/Exciter Assembly up to 20 watts. This assembly also charges batteries attached to the receiver-transmitter. The harmonic filter assembly provides eight harmonic filters that reduce spurious emission levels.
A9	Antenna Coupler Assembly	Provides an L-C matching network that compensates for changing antenna tuning conditions The result is a VSWR that is less than 2:1.
A10	Front Panel Assembly	Provides an interface to all connections and functions of the receiver-transmitter This assembly also mutes, buffers, and performs analog processing on all audio antenna and exiting the radio.
A11	Motherboard Assembly	Provides interconnection of all PWB assemblies for signal routing, control. and power distribution.
W1	PA - Coupler Coaxial Cable Assembly	Provides an RF path between AX Power Amplifier/Battery Charger Assembly and A9 Antenna Coupler Assembly.
W2	PA R/L Coaxial Cable	Provides an RF path between AX Power Amplifier/Battery Charger Assembly and AS Receiver/Exciter Assembly.

Table 1-7.	Assemblies and Reference Designators - Continued

1.5 PARTS LISTS OF ITEMS SHIPPED WITH UNIT

There are no additional items shipped with the RT-1694(P). Table 1-8 provides cage code information for the manufacturers of items listed in this manual.

Cage Code	Manufacturer Name and Address
14304	Harris Corporation RF Communications Division
	1680 University Avenue Rochester, NY 14610-2842
19915	Diamond Tool and Horseshoe Company
10010	4604/4704 Grand Avenue
	P.O. Box 6246
	Duluth, MN 55806
28480	Hewlett-Packard Company
	Corporate Headquarters
	3000 Hanover Street
	Palo Alto, CA 94304-1112
55719	Snap On Tools Corporation
	2801 80th Street
	Kenosha, WI 53141-1410
70998	Bird Electronics Corporation
	30303 Aurora Road
20052	Solon, OH
80058	Joint Electronics Type Designation System Formerly Communication Electronics Subpanel of
	Standardization Panel Joint Communications Electronics
	Committee
81349	Military Specifications
010-0	Promulgated by Military
	Departments/Agencies
	Under Authority of Defense
	Standardization Manual 4120 3-M
89536	Fluke Corporation
	6920 Seaway Boulevard
	P.O. Box 9090
	Everett, WA 98206-9090
96508	Cooper Industries, Inc.
	Cooper Tools Division
	Lufkin Road
	P.O. Box 728
00000	Apex, NC 27502
96906	Military Standards
	Promulgated by Military Departments Under Authority of Defense
	Standardization Manual 4120 3-M
_953	1-23

Table 1-8.	List of Manufacturers
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1.6 LIST OF ITEMS REQUIRED BUT NOT SUPPLIED

Table 1-9 lists the test equipment required for troubleshooting and repairing the receiver-transmitter. Table 1-10 list, the tools required for removing and replacing receiver-transmitter assemblies. A known-good radio system, called a Hot Test Bed, is also required when making Level III repairs. Table 1-11 lists the Hot Test Bed items. For Hot Test Bed interconnect information, refer to Chapter 8, Figure 8-2.

Description	Part Number	Cage Code
Signal Generator, RF	8657A	28480
Breakout Box	1008-1100	14304
Audio Analyzer	8903B	28480
Attenuator, 200 Watt	77B6-30	70998
Power Meter, RF	437B	28480
Power Sensor	8482B	28480
Frequency Counter	5385A	28480
Digital Multimeter	AN/PSM45A	89536

Table 1-9.	Test Equipment Required, But Not Supplied
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Table 1-10	Master Required	I Tools and	Materials List
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Description	Part Number	Cage Code
Screwdriver, No. 0 cross-tip	X-100	96508
Screwdriver, No. 1 cross-tip	X-101	96508
Screwdriver, No. 2 cross-tip	X-102	96508
Hex Screwdriver Bit, 5/32 inch	99-25	96508
Jewelers Pliers, 4 inch	LN54	19915
Socket Wrench, 3/16 inch	99-6	96508
Screwdriver Handle	99-1	96508
Ground Strap	3M-2064	20999
ESD Mat	1872	20999

Table 1-11. Hot Test Bed Items

Description	Part Number	Cage Code
RT-1694(P) Receiver-Transmitter	10372-1000-01	14304
Power Supply	6268B	28480
Handset (H-250/U)	10075-1344-01	14304
DC Power Cable Assembly	10394-9010	14304
Adapter, N-type (m) to BNC (f)	M55339/20-00201	81349
Adapter, N-type (f) to BNC (f)	M55339/01-00001	81349
Cable Assembly, RF, BNC (m)	10503A	28480
Cable Assembly, Auxiliary	10372-9850	14304
Battery Eliminator	10372-9330	14304

CHAPTER 2

OPERATION

2.1 INTRODUCTION

2.1.1 General

This chapter contains information necessary for operation of the RT-1694(P) Receiver-Transmitter [RT-1694(P) at this maintenance level. This information consists of operator controls and indicators, and operating instructions.

2.2 OPERATOR CONTROLS AND INDICATORS

2.2.1 General

Figure 2-1 shows the front panel of the RT-1694(P).

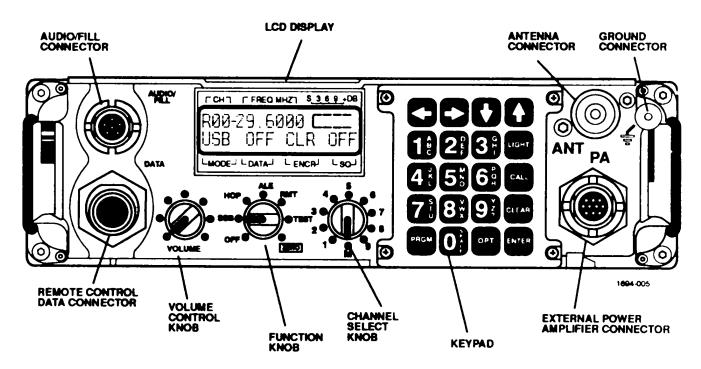


Figure 2-1. RT-1 694(P) Receiver-Transmitter Front Panel

2.3 CONNECTORS

Figure 2-1 shows the front panel of the receiver-transmitter. Five connectors are located on the front panel

- The AUDIO/FILL connector is where a handset or headset is connected to the receiver-transmitter. This connector is also where a fill gun is attached for loading encryption keys into the radio Refer to the RF-5200 FALCON [™] Series Tactical Communications Manpack System Manual (10515-0006-4200 for further information on loading encryption keys
- The D.A connector is where a remote control device is connected to the receiver-transmitter.
- A whip antenna or an external power amplifier is connected to the receiver-transmitter via the ANT (antenna) connector.
- An external power amplifier's control line is connected to the PA connector on the receiver-transmitter.
- The receiver-transmitter is grounded via the ground connector

The only connectors on the rear panel of the receiver-transmitter are the battery pack connectors (J5 and J6).

2.4 OPERATING PROCEDURES

2.4.1 Initial Settings and Power Up

Initial settings and power up consists of turning on the unit and executing the Built-In Test (BIT). Refer to Table 2-2 for the initial settings and power-up procedure.

2.4.1.1 Built-In Test (BIT)

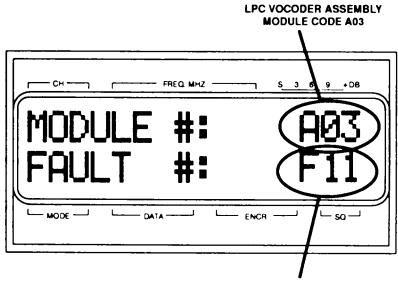
BIT is executed from the front panel of the receiver-transmitter or from a terminal connected to the DATA connector The self test function of the receiver-transmitter automatically tests the receiver-transmitter. If an external power amplifier and antenna coupler are connected to the receiver-transmitter, these units are also tested by BIT

BIT is a built-in diagnostic routine in the receiver-transmitter The test verifies operation of receiver-transmitter internal assemblies (and the external power amplifier and antenna coupler, if attached). If a problem is located, a code is displayed on the front panel identifying the fault. Refer to Table 2-1 for an index of module codes and assemblies A fault code is also displayed The fault code helps identify how the Shop Replaceable Unit (SRU) tailed See Figure 2-2. Refer to Table 5-4 for a complete list of receiver-transmitter fault codes. Fault codes pertaining to the RF-5(45 Pre/Postselector (A28), external power amplifiers (A30), or an external antenna coupler (A40) may be found in the respective Level III Maintenance Manual.

Module Code	Assembly Identified	
A01*	Interface or Encryption PWB Assemblies*	
A03	LPC Vocoder Assembly	
A04	Signal Processor PWB Assembly	
A05	Receiver/Exciter Assembly	
A06	Synthesizer Assembly	
A08	Power Amplifier/Battery Charger Assembly	
A09	Antenna Coupler Assembly	
A10	Front Panel Assembly	

Table 2-1.	RT-1694(P)	Module	Code/Assembly Index
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*NOTE. Module Code A01 can identify either A1A1 Interface PWB Assembly or A1A2 Encryption PWB Assembly (if installed). Refer to Chapter 5, Troubleshooting, for information on how to determine which assembly is causing the A01 fault.



FAULT CODE

1

Figure 2-2. Sample Fault Code Display

2.4.1.1.1 Starting BIT

Table 2-2 provides instructions to execute BIT.

Tahla 2.2	Initial Settings	and Executing BIT
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Step	Control	Action	Observe
1.	FUNCTION knob on receiver-transmitter	Turn clock form OFF position to SSB position.	The receiver-transmitter displays the same display from when it was last used in SSB mode.
2.	FUNCTION knob on	Turn clockwise from SSB position to	The receiver-transmitter displays the following screen:
			* INITIALIZING* * * * *WAIT * * * *
			followed by:
			TEST VERSION VSWR BATTERY
3.	$\leftarrow \text{ or } \rightarrow \text{keys}$	Press and release repeatedly to select TEST (if necessary).	The receiver-transmitter Displays the following screen:
			TEST VERSION VSWR BATTERY
			with TEST flashing.
4.	ENTER key on	Press and release.	The receiver-transmitter displays the following screen:
			* * SELF TEST* * * IN PROGRESS*
			If no errors occur during BIT, the receiver-transmitter displays the following screen:
			SELF TEST DONE ** NO ERRORS**
			If a fault is detected during execution of BIT, a fault code display will be shown. See Figure 2-2. If this occurs, note the fault code and proceed to Chapter 5, Paragraph 5.2.4.
5.	FUNCTION knob on receiver-transmitter	Turn counter-clockwise from TEST position to SSB position.	The receiver-transmitter displays the same display from when it was last used in SSB mode, and is now ready for normal operation.

2.4.1.1.2 Run-Time Faults

Run-time faults may occur during normal operation of the RF-5200 FALCON Series Tactical Communications Manpack System. In these cases, a fault message will be displayed on the receiver-transmitter front panel display. When this occurs, run BIT according to the procedure in Table 2-3. For more information on run-time faults, refer to Chapter 5, Troubleshooting.

Step	Control	Action	Observe
1.	FUNCTION knob on receiver-transmitter	Turn clockwise from SSB position to TEST position.	The receiver-transmitter displays tie following screen.
			* INITIALIZING * * * * * WAIT * * * *
			followed by
			TEST VERSION VSWR BATTERY
2.	$\leftarrow \text{ or } \rightarrow \text{keys}$	Press and release repeatedly to select TEST (if necessary).	The receiver-transmitter displays the following screen.
			TEST VERSION VSWR BATTIERN'
			with TEST flashing
3.	ENTER key on receiver-transmitter	Press and release.	The receiver-transmitter displays the following screen.
			** SELF TEST ** * IN PROGRESS *
4			If no errors occur during BIT, the receiver-transmitter displays the following screen.
			SELF TEST DONE ** NO ERRORS **
5.			If BIT identities a fault, note
			the fault code and proceed to Chapter 5, Paragraph 5.2.4 If no fault code is identified, proceed to Chapter 5, Paragraph 5.2.3

Table 2-3. Ex	ecuting BIT	After Run-	Time Fault
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2.4.2 Normal and Emergency Shutdown

Special emergency shutdown procedures are not required. Table 2-4 gives the procedure used for normal shutdown of the receiver-transmitter and external power amplifier, if one is attached.

Table 2-4. Receiver-transmitter/Power Amplifier Shutdown Procedure

Step	Control	Action	Observe
1.	FUNCTION knob on receiver-transmitter	Turn counter-clockwise to OFF position.	All front panel lamps and displays go out. Settings will be retained in memory while the unit is off.

CHAPTER 3

FUNCTIONAL DESCRIPTION

3.1 INTRODUCTION

3.1.1 General

This chapter covers the functional description of the circuitry in the RT-1694(P) Receiver-Transmitter [RT-1694(P)] Paragraph 3.2 contains the overall functional description. Paragraph 3.3 provides the major level functional description which covers the major circuits on the Shop Replaceable Units (SRUs). Refer to Chapter 5 for Built-In-Test (BIT) and troubleshooting information.

3.2 OVERALL FUNCTIONAL DESCRIPTION

3.2.1 General

The following paragraphs provide an overall description of how the RT-1694(P) functions.

3.2.2 Purpose of the RT-1694(P) Receiver-transmitter

The RT-1694(P) operates from 1.6 MHz to 59.9999 MHz. AU functions are controlled from the front panel (or remote control). A 32-character, alphanumeric display provides system status information and reflects data entry to simplify unit operation and programming. Optional modules are installed in the chassis.

3.2.3 Functional Level Descriptions

A number of RT-1694(P) functional level descriptions are described in the following paragraphs:

- Paragraph 3.2.3.1 Analog Clear Voice Functional Level Descriptions
- Paragraph 3.2.3.2 Digital Voice (Unencrypted) Functional Level Descriptions
- Paragraph 3.2.3.3 Analog Voice Security (AVS) Functional Level Descriptions
- Paragraph 3.2.3.4 Encrypted Digital Data Functional Level Descriptions
- Paragraph 3.2.3.5 Encrypted Digital Voice Functional Level Descriptions
- Paragraph 3.2.3.6- Automatic Link Establishment (ALE) Functional Level Descriptions
- Paragraph 3.2.3.7 Frequency Hopping Functional Level Descriptions
- Paragraph 3.2.3.8 Frequency Modulation (FM) Functional Level Descriptions

For a discussion of RF/IF/audio/digital signal paths and power distribution paths, refer to Paragraph 3.3.

3.2.3.1 Analog Clear Voice Functional Level Descriptions

Paragraph 3.2.3.1.1 provides a functional level description of the RT-1694(P) when transmitting analog clear voice. Paragraph 3.2.3.1.2 provides a functional level description of the RT-1694(P) when receiving analog clear voice. See Figure 3-1.

3.2.3.1.1 Transmitting Analog Clear Voice

Audio enters the radio at the handset when it is keyed and spoken into. The audio signal is routed from A10 Front Panel Assembly to the Analog-to-Digital (A/D) converter on A4 Signal Processor Printed Wiring Board (PWB) Assembly for digitizing. The digitized audio is passed to the Intermediate Frequency Digital Signal Processor (IF DSP), which generates the digital representation of an IF. This signal then passes through a Digital-to-Analog (D/A) converter, where the digitized IF is converted into an analog signal. This signal is pass(d to A5 Receiver/Exciter Assembly for conversion to a Radio Frequency (RF) signal.

Mixing circuitry on A5 Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz, to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to A8 Power Amplifier/Battery Charger Assembly.

A8 Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20(-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics The 20-watt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

3.2.3.1.2 Receiving Analog Clear Voice

RF signals in the frequency range of 1.6 MHz to 59.9999 MHz are received by the RT-1694(P) unit at the whip antenna. These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on AX PA/Battery Charger Assembly. The RF signal then follows the receive (RX) path through the receiver protection circuit on A8 PA/Battery Charger Assembly. These signals are then routed to A5 Receiver/Exciter Assembly. The RF signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an IF signal.

The IF signal is then converted to a digital representation of the IF signal by the A/D converter on A4 Signal Processor PWB Assembly The A/D converter passes this signal to the digital IF DSP, which removes the IF components of the signal. The digital signal is then processed by the D/A converter, which creates an analog audio signal. The analog audio then passes through A10 Front Panel Assembly, where it is routed to the handset

3.2.3.2 Unencrypted Digital Voice Functional Level Descriptions

Paragraph 3.2.3.2.1 provides a functional level description of the RT- 1694(P) when transmitting digital voice Paragraph 3.2.3.2.2 provides a functional level description of the RT-1694(P) when receiving digital voice. See Figure 3-2.

3.2.3.2.1 Transmitting Unencrypted Digital Voice

Transmit audio from the handset passes through A10 Front Panel PWB Assembly to the A/D converter on A3 LPC Vocoder Assembly. The digital data is passed to the LPC processor, which passes the data to the modem processor on A4 Signal Processor PWB Assembly. The modem processor creates a digital representation of a 39-tone waveform. This digital waveform is passed to the digital IF DSP, which generates a digital representation of a 6 kHZ IF. This signal then passes through a D/A converter, where the digitized IF is converted into an analog signal. This signal is passed to AS Receiver/Exciter Assembly) for conversion to an RF signal.

Mixing circuitry on AS Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to AX Power Amplifier/Battery Charger Assembly.

AX Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts The 20-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics. The 20-watt RF signal

then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

3.2.3.2.2 Receiving Unencrypted Digital Voice

RF signals is the frequency range of 1.6 MHz to 59.9999 MHz are received by the RT-1694(P) unit at the whip antenna. These signals, pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on A8 PA/Battery Charger Assembly. The RF signal then follows the RX path through the receiver protection circuit on AS PA/Battery Charger Assembly. These signals are then routed to A5 Receiver/Exciter Assembly. The RF: signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an if signal

The IF signal is then converted to digital representation of the IF signal by the A/D converter on A4 Signal Processor PWB Assembly. The A/D converter passes this signal to he digital IF DSP, which removes the IF components of the signal. The digital signal is then processed by the modem processor, which demodulates the 39-tone signal. The resulting digital signal passes to the LPC processor on A3 LPC Vocoder Assembly. The signal then passes through the D/A converter on A3 LPC Vocoder Assembly, resulting in an analog audio signal. The analog audio then passes through A10 Front Panel Assembly, where it is routed to the handset.

3.2.3.3 Analog Voice Security (AVS) Functional Level Descriptions

Paragraph 3.2.3.3.1 provides a functional level description of the RT-1694(P) when transmitting with AVS enabled. Paragraph 3.2.3.3.2 provides a functional level description on the RT-1694(P) when receiving with AVS enabled. See Figure 3-3.

3.2.3.3.1 Transmitting with AVS Enabled

Audio enters the radio at the handset when it is keyed and spoken into. The audio signal is routed from A10 Front Panel Assembly A3 LPC Vocoder Assembly, where the analog audio signal is converted to encrypted audio by the LPC processor This encrypted audio signal is transferred to the A/D converter on A4 Signal Processor PWB Assembly for digitizing. The digital data is passed to the digital IF DSP, which generates a digital representation of a 6 kHz IF. This signal then passes through a D/A converter, where the digitized IF is converted into an analog signal. This signal is passed to A5 Receiver/Exciter Assembly for conversion to an RF signal.

Mixing circuitry on A5 Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to A8 Power Amplifier/ Battery Charger Assembly.

AX Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics. The 20-watt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

3.2.3.3.2 Receiving with AVS Enabled

RF signals in the frequency range of 1.6 MHz to 59.9999 MHz are received by the RT-1694(P) unit it the whip antenna These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on AX PA/Battery Charger Assembly The RF signal then follows the RX path through the receiver protection circuitry on AR PA/Battery Charger Assembly These signals are then routed to AS Receiver/Exciter Assembly. The RF signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an IF signal.

The IF signal is then converted to a digital representation of the IF signal by the A/D converter on A4 Signal processor PWB Assembly The AID converter passes this signal to the digital IF DSP, which removes the IF components of the signal. The digital signal is then processed by the D/A converter, which creates an encrypted audio signal. The encrypted audio signal is then transferred to A3 LPC Vocoder Assembly, where the audio signal is decrypted. The analog audio then passes through A10 Front Panel Assembly, where it is routed to the handset

3.2.3.4 Encrypted Digital Data Functional Level Descriptions

Paragraph 3.2.3 4.1 provides a functional level description of the RT-1694(P) when transmitting encrypted digital data. Paragraph 3.2.3.4.2 provides a functional level description of the RT-1694(P) when receiving encrypted digital data. See Figure 3-4

3.2.3.4.1 Transmitting Encrypted Digital Data

Digital data from an external computer or terminal enters the radio at A10 Front Panel Assembly The digital data is routed from A10 Front Panel Assembly through A1A1 Interface PWB Assembly to A1A2 Encryption PWB Assembly, where it is encrypted by the encryption processor. Once encrypted, the digital encrypted data passes back through A1A1 Interface PWB Assembly before reaching the modem processor on A4 Signal Processor PWB Assembly, where the signal is modulated. The digital encrypted data is then passed to the digital IF DSP which generates a digital representation of a 6 kHz IF This signal then passes through a D/A converter, where the digitized IF is converted into an analog signal This signal is passed to A5 Receiver/Exciter Assembly for conversion to an RF signal.

Mixing circuitry on A5 Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to A8 Power Amplifier/Battery Charger Assembly.

A8 Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics. The 20-watt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

3.2.3.4.2 Receiving Encrypted Digital Data

RF signals in the frequency range of 1.6 MHz to 59.9999 MHz are received by the RT-1694(P) unit at the whip antenna. These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on A8 PA/Battery Charger Assembly The RF signal then follows the RX path through the receiver protection circuitry on AS PA/Battery' Charger Assembly These signals are then routed to A5 Receiver/Exciter Assembly. The RF signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an IF signal.

The IF signal is then converted to a digital representation of the IF signal by the A/D converter on A4 Signal Processor PWB Assembly The A/D converter passes this signal to the digital IF DSP, which removes the IF components of the signal The digital signal is then processed by the modem processor, creating digital encrypted data. This data is then transferred to through A1A1 Interface PWB Assembly to A1A2 Encryption PWB Assembly, where data is decrypted. This digital data

is then sent back through A1A1 Interface PWB Assembly to A10 Front Panel Assembly, where it is routed to the external computer or terminal.

3.2.3.5 Encrypted Digital Voice Functional Level Descriptions

Paragraph 3.2.3.5.1 provides a functional level description of the RT-1694(P) when transmitting encrypted digitized voice. Paragraph 3.2.3.5.2 provides a functional level description of the RT-1694(P) when receiving encrypted digitized voice. See figure 3-5.

3.2.3.5.1 Transmitting Encrypted Digital Voice

Audio enters the radio at the handset when it is keyed and spoke into. The audio signal is routed from A10 Front Panel Assembly to A3 LPC Vocoder Assembly, where the analog audio signal is converted to digital data by an A/D converter. This digital data passes through A1A1 Interface PWB Assembly to A1A2 Encryption PWB Assembly, where it is encrypted by the encryption by the encryption processor. Once encrypted, the digital encrypted data passes back trough A1A1 Interface PWB Assembly before reaching the modem processor on A4 Signal Processor PWB Assembly, where the signal is modulated. The digital encrypted data is then passed to the digital IF DSP, which generates a digital representation of a 6 kHz IF. This signal then passes through a D/A converter, where the digitized IF is converted into an analog signal. This signal is passed to 5 Receiver/Exciter Assembly for conversion to an RF signal.

Mixing circuitry on A5 Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before output to A8 Power Amplifier/Battery Charge Assembly.

A8 Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics. The 20-watt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

3.2.3.5.2 Receiving Encrypted Digital Voice

Radio frequency signals in the frequency range of 1.6 MHz to 59.9999 MHz are received by the RT-1694(P) until at the whip antenna. These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on A8 PA/Battery Charger Assembly. The RF signal then follows the receive RX path through the receiver protection circuitry on A8 PA/Battery Charger Assembly. These signals are then routed to A5 Receiver/Exciter Assembly. The RF signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an IF signal.

The IF signal is then converted to digital representation of the IF signal by the A/D converter on A4 Signal Processor PWB Assembly. The A/D converter passes this signal to the digital IF DSP, which removes the IF components of the signal. The digital signal is then processed by the modem processor, creating digital encrypted data. This data is then transferred through A1A1 Interface PWB Assembly to A1A2 Encryption PWB Assembly, where the data is decrypted. This digital data then passes through A1A1 Interface PWB Assembly to A3 LPC Vocoder Assembly, where the D/A converter generates an analog audio signal. The analog audio then passes through A10 Front Panel Assembly, where it is routed to the handset.

3.2.3.6 Automatic Link Establishment (ALE) Functional Level Descriptions

Paragraph 3.2.3.6.1 provides a functional-level description of the RT-1694(P) when transmitting an ALE call. Paragraph 3.2.3.6.2 provides a functional-level description of the RT-1694(P) when receiving an ALE call. See Figure 3-6.

3.2.3.6.1 Establishing an ALE Link (Transmit Side)

The operator presses the CALL button on the RT-1694(P) front panel, generating a command that is received by the ALE processor. The ALE processor commands the main control processor to configure the receiver-transmitter to the correct channel transmit frequency. Once this has been accomplished. the ALE processor sends digital data to the digital IF DSP, which generates a digital representation of a 6 kHz IF. This signal then passes through a D/A converter, where the digitized IF is convened into an analog signal. This signal is passed to AS Receiver/Exciter Assembly for conversion to an RF signal.

Mixing circuitry on AS Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to A8 Power Amplifier/Battery Charger Assembly.

A8 Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics. The 20-watt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

3.2.3.6.2 Establishing an ALE Link (Receive Side)

The radio is scanning its channel set. The ALE processor instructs the main control processor to configure the receivertransmitter to a particular channel.

Once this has been accomplished, RF signals at that channel's frequency (1.6 MHz to 59.9999 MHz) are received by the RT-1694(P) unit at the whip antenna. These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on A8 PA/Battery Charger Assembly. The RF signal then follows the receive RX path through the receiver protection circuitry on A8 PA/Battery Charger Assembly. These signals are then routed to AS Receiver/Exciter Assembly. The RF signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an IF signal.

The IF signal is then converted to a digital representation of the IF signal by the A/D converter on A4 Signal Processor PWB Assembly. The A/D converter passes this signal to the digital IF DSP which removes the IF components of the signal. The digital signal is then passed to the ALE processor which checks to see if valid ALE data is present. If valid ALE data is not present, the ALE processor commands the main control processor to configure the receiver-transmitter to the next channel. If valid ALE data is present, the ALE process described in Paragraph 3.2.3.6.1.

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3.2.3.7 Frequency Hopping Functional Level Descriptions

Paragraph 3.2.3.7.1 provides a functional-level description of the RT- 1694(P) when transmitting with frequency hopping enabled. Paragraph 3.2.3.7.2 provides a functional-level description of the RT-1694(P) when receiving with frequency hopping enabled. See Figure 3-7.

3.2.3.7.1 Transmitting with Frequency Hopping Enabled

Transmit audio from the handset passes through A10 Front Panel PWB Assembly to the A/D converter on A3 LPC Vocoder Assembly. The digital data is passed to the LPC processor, which passes the data through the interface processor on A1A1 Interface PWB Assembly to the modem processor on A4 Signal Processor PWB Assembly. The modem processor creates a digital representation of a 39-tone waveform. This digital waveform is passed to the digital IF DSP, which generates a digital representation of a 6 kHz IF. This signal then passes through a D/A converter, where the digitized IF is converted into an analog signal. This signal is passed to A5 Receiver/Exciter Assembly for conversion to an RF signal.

Mixing circuitry on A5 Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to A8 Power Amplifier/Battery Charger Assembly.

A8 Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics. The 20-watt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

The main control processor on A4 Signal Processor PWB Assembly communicates with the modem processor and changes the frequency of one local oscillator on A6 Synthesizer Assembly. Together, these processors and the local oscillator perform the frequency hopping function.

3.2.3.7.2 Receiving with Frequency Hopping Enabled

RF signals in the frequency range of 1.6 MHz to 59.9999 MHz are received by the RT-1694(P) unit at the whip antenna. These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on A8 PA/Battery Charger Assembly. The RF signal then follows the RX path through the receiver protection circuit on A8 PA/Battery Charger Assembly. These signals are then routed to A5 Receiver/Exciter Assembly. The RF signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an IF signal.

The IF signal is then convened to a digital representation of the IF signal by the A/D converter on A4 Signal Processor PWB Assembly. The A/D converter passes this signal to the digital IF DSP, which removes the IF components of the signal. The digital signal is then processed by the modem processor, which demodulates the 39-tone signal. The resulting digital signal passes through the interface processor on A1A1 Interface PWB Assembly and the LPC processor on A3 LPC Vocoder Assembly. The signal then passes through the D/A converter on A3 LPC Vocoder Assembly, resulting in an analog audio signal. The analog audio then passes through AIO Front Panel Assembly, where it is routed to the handset.

The main control processor on A4 Signal Processor PWB Assembly communicates with the the modem processor and changes the frequency of one local oscillator on A6 Synthesizer Assembly. Together, these processors and the local oscillator perform the frequency hopping function.

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3.2.3.8 Frequency Modulation (FM) Functional Level Descriptions

Paragraph 3.2.3.8.1 provides a functional level description of the RT-1694(P) when transmitting FM signals. Paragraph 3.2.3.8.2 provides a functional level description of the RT-1694(P) when receiving FM signals. See Figure 3-8.

3.2.3.8.1 Transmitting FM Signals

Audio enters the radio at the handset when it is keyed and spoken into. The audio signal is routed from A10 Front Panel Assembly to the A/D converter on A4 Signal Processor PWB Assembly for digitizing. The digital data is passed to a clipper circuit, and then a 150 Hz tone is added to the signal for use in receiver Tone Squelch. This signal then passes through a D/A converter, where the data is converted into FM transmit audio. This audio modulates one of the local oscillators on A6 Synthesizer Assembly. A4 Signal Processor PWB Assembly also digitally generates the FM TX IF, which is passed to A5 Receiver/Exciter Assembly.

Mixing circuitry on AS Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to A8 Power Amplifier/Battery Charger Assembly.

A8 Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20-watt signal then passes through one of eight harmonic filters to reduce the level of unwanted harmonics. The 2awatt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

3.2.3.8.2 Receiving FM Signals

RF signals in the frequency range of 1.6 MHz to 59.9999 MHz are received by the RT-1694(P) unit at the whip antenna. These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on A8 PA/Battery Charger Assembly. The RF signal then follows the RF path through the receiver protection circuitry on A8 PA/Battery Charger Assembly. These signals are then routed to A5 Receiver/Exciter Assembly. The RF signal is demodulated on A5 Assembly. This audio signal is passed directly to the A/D converter on A4 Signal Processor PWB Assembly.

The A/D converter passes the digital signal to an AGC circuit for leveling, and the squelch circuit determines if there is any squelch information on the signal. The digital signal is then processed by the D/A converter, which creates an analog audio signal. The analog audio then passes through A10 Front Panel Assembly, where it is routed to the handset.

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3.3 MAJOR FUNCTION LEVEL DESCRIPTION

3.3.1 General

For detailed interconnections, refer to Chapter 5 for the following.

- Figure 5-4, RF/IF/Audio/Digital Signal Path Diagram
- Figure 5-5, Power Distribution Diagram
- Figure 5-6, RT-1694(P) Interconnect Schematic Diagram

The major function level description is divided into the following signal paths:

- RF/IF/Audio/Digital Signal Path
- Control Path
- Power Distribution

The descriptions of these signal types are further divided as each assembly relates to the major signal path Each signal type is not present on every assembly. Refer to Chapter 5, Paragraph 5.6, for the BIT description.

Paragraph 3.3.2 discusses the RF/IF/audio/digital signal path for an RT-1694(P) in analog clear voice mode Paragraph 3.3.3 discusses the control signal path for an RT-1694(P) in analog clear voice mode. Paragraph 3.3.4 adds a detailed discussion of ALE. Paragraph 3.3.5 adds a detailed discussion of AVS. Paragraph 3.3.6 adds a detailed discussion of encrypted digital data. Paragraph 3.3.7 adds a discussion of encrypted digital voice. Paragraph 3.3.9 adds a discussion of frequency hopping Paragraph 3.3.1(adds a discussion of FM. Finally, Paragraph 3.3.11 discusses power distribution within the RT-1694(P) Receiver-Transmitter

3.3.2 RF/IF/Audio/Digital Signal Path (Analog Clear Voice)

See Chapter 5, Figure 5-4. The following paragraphs describe the functions of each SRU as they relate to the transmit and receive signal paths for the RT-1694(P). Paragraph 3.3.2.1 describes the RF/IF/Audio/Digital signal path for the unit when it is transmitting. Paragraph 3.3.2.2 describes the RF/IF/Audio/Digital signal path for the unit when it is receiving

3.3.2.1 Transmit RF/IF/Audio/Digital Signal Path

To transmit using the RT-1694(P), the radio operator keys, and speaks into, a handset connected to the front panel This produces an audio signal which enters A10 Front Panel Assembly

3.3.2.1.1 A10 Front Panel Assembly

Audio enters A10Front Panel Assembly from the handset. The audio signal is filtered by a filter circuit and amplified by a microphone preamplifier (mic preamp) The audio switch then passes the audio signal to the A/D converter on A4 Signal Processor PWB Assembly.

3.3.2.1.2 A4 Signal Processor PWB Assembly

Analog audio signals from A10 Front Panel Assembly are digitized by the A/D converter The digital data signal is then passed to the digital IF Digital Signal Processor (DSP). The digitized audio is then product modulated by a mixer and the Upper Sideband (LSB)/Lower Sideband (LSB) Beat Frequency Oscillator (BFO). The undesired sideband is then digitally removed by a Finite Impulse Response (FIR) digital filter The resulting signal is a digital representation of a 6 kHz IF: This digital signal passes through a D/A converter, resulting in a 6 kHz IF. This IF is then passed to A5 Receiver/Exciter Assembly.

3.3.2.1.3 A5 Receiver/Exciter Assembly

The 6 kHz IF signal from A4 Signal Processor PWB Assembly is passes to the RX Second Mixer, which mixes the signal with the 9.5 MHz Local Oscillator (LO3). The resulting signal passes through a +15 dB amplifier, AGC2 circuit for leveling, a +8 dB amplifier, and an 8 kHz Bandpass Filter (BPF) with a center frequency of 9.5 MHz. The output of the bandpass filter enters the TX Second Mixer, which mixes the signal with the 71 MHz LO2. The resulting signal passes through at +15 dB amplifier, a +12 dB amplifier, and a 22 kHz BPF with a center frequency of 80.5 MHz. The resulting signal then enters the First Mixer, which mixes the signal with LO1. The signal from LO1 varies with transmit frequency. The resulting signal passes through a 60 MHz Low Pass Filter (LPF). The signal then passes through three exciter amplifiers, for a total gain of +43 dB.

The resulting signal is in the 1.6 MHz to 59.9999 MHz range, with an output level of 100 milliwatts. This RF signal is output to A8 Power Amplifier/Battery Charger Assembly.

3.3.2.1.4 A8 Power Amplifier/Battery Charger Assembly

RF signals from A5 Receiver/Exciter Assembly pass through a +15 dB amplifier and a +12 dB amplifier. This increases the RF power level from 100 mW to 20 watts. The RF signal then passes through an AM High Pass Filter (Band 1 AM HPF) and one of seven harmonic filters (Bands 2 through 8), reducing the levels of unwanted harmonics. The filtered RF signal then passes through a directional coupler, which passes VSWR data to the main control processor on A4 Signal Processor PWB Assembly. Finally, the 20-watt RF signal is passed to A9 Antenna Coupler Assembly.

When the receiver-transmitter is attached to an external power amplifier, transmit RF from the exciter follows the receive path (RX) through A8 PA/Battery Charger Assembly. This path bypasses the amplifiers, leaving the transmit signal at 100 mW.

3.3.2.1.5 A9 Antenna Coupler Assembly

Transmit RF signals from A8 PA/Battery Charger Assembly pass through a discriminator circuit and an L-C tuning circuit, making the antenna appear as a 50-ohm, purely resistive load to the power amplifier. This maximizes power transmitted through the whip antenna and minimizes power reflected back to the power amplifier.

When the receiver-transmitter is attached to an external power amplifier and antenna coupler, transmit RF from A8 PA/Battery Charger Assembly follows the coupler bypass path through A9 Antenna Coupler Assembly. This path bypasses the tuning circuit and the discriminator circuit. In this situation, 100 mW exciter RF passes directly out of the receiver-transmitter antenna port to the external power amplifier.

3.3.2.2 Receive RF/IF/Audio/Digital Signal Path

A modulated RF signal in the frequency range of 1.6 MHz to 59.9999 MHz is received at whip antenna. The signal is then routed to A9 Antenna Coupler Assembly.

3.3.2.2.1 A9 Antenna Coupler Assembly

Receive RF signals from A8 Power Amplifier/Battery Charger Assembly pass through the L-C tuning circuit and the discriminator circuit. The receive RF signal is then passed to A8 PA/Battery Charger Assembly.

When the receiver-transmitter is attached to an external power amplifier and antenna coupler, receive RF from the whip antenna follows the coupler bypass path through A9 Antenna Coupler Assembly. This path bypasses the tuning circuit and the discriminator circuit.

3.3.2.2.2 A8 Power Amplifier/Battery Charger Assembly

RF signals from A9 Antenna Coupler Assembly pass through the directional coupler, one of seven harmonic filters (Bands 2 through 8), and the AM high pass filter (Band 1 AM HPF). The RF signal then follows the RX path through the receiver protection circuit, limiting the strength of receive signals to no more than +7 dBm A user-selectable RF preamplifier with +13 dB gain is the final function performed on the receive signal before leaving AS Assembly and going to AS Receiver/Exciter Assembly.

3.3.2.2.3 A5 Receiver/Exciter Assembly

The receive RF signal from AS PA/Battery Charger Assembly follows the receive path around the exciter amplifiers before being low pass filtered and mixed by the first mixer with the 80.5 MHz LO1. The resulting IF signal passes through a 22 kHz bandpass filter with a center frequency of 80.5 MHz. The IF is then amplified + 14.3 dB, leveled by AGC I circuit. and amplified another +7 dB.

The IF signal is then mixed by RX second mixer with the 71 MHz L02. The resulting signal is then amplified + 15 dB and leveled by AGC 2 circuit The IF signal is then amplified +8 dB before passing through an 8 kHz bandpass filter with a center frequency of 9.5 MHz. The signal is then amplified +6 dB before being split into two paths. with one path attenuated 36 dB with respect to the other path. Both IF signals are independently mixed by the third mixer to a 30 kHz (analog signals) or 36 kHz (digital signals) third IF signal. Both IF signals are then amplified +23.5 dB before being passed to A4 Signal Processor PWB Assembly.

3.3.2.2.4 A4 Signal Processor PWB Assembly

The IF signals from AS Receiver/Exciter Assembly is digitized on A4 Signal Processor PWB Assembly b) a D/A converter. resulting in a digital representation of the IF. This digital IF signal is then processed by the digital IF DSP, resulting in digital data that represents an analog audio signal. This digital data is processed by the D/A converter. The resulting analog audio signal is then passed to A10 Front Panel Assembly.

3.3.2.2.5 A10 Front Panel Assembly

The audio signal from A4 Signal Processor PWB Assembly enters A10 Front Panel Assembly, where it is filtered before being output to the handset.

3.3.3 Control Paths (Analog Clear Voice)

See Figure 5A in Chapter 5. The following paragraphs describe the functions of each SRU as they relate to the control paths The control paths are where the A10 Front Panel Assembly, A6 Synthesizer Assembly. and the main control processor on A4 Signal Processor PWB Assembly interact with the rest of the assemblies in the receiver-transmitter

3.3.3.1 A10 Front Panel Assembly

This assembly is the interface between the operator and the RT-1694(P) It is the point of entry for operating instructions, such as frequency. bandwidth, mode, etc., and is where operating parameters and fault codes are displayed Operator entries are made via the front panel keypad. These instructions are then routed to the interface control processor on A1A1 Interface PWB Assembly.

3.3.3.2 A1A1Interface PWB Assembly

Instructions and control information entered by the operator at A10 Front Panel Assembly are routed directly to A1A1Interface PWB Assembly

A second source of instructions and control information is an external computer terminal. Control information and instructions enter the RT-1694(P) via the DATA connector on the receiver-transmitter front panel This control information is also routed directly to A1A1 Interface PWB Assembly Remote control data usually comes from an RS-232 or MIL-188

terminal, or from a personal computer running terminal emulation software This data is translated to digital levels. The serial data is then formatted into a data packet and passed to the interface control processor. The interface control processor then passes this data packet to the main control processor on A4 Signal Processor PBW Assembly via the internal light Speed Serial Bus (HSSB).

3.3.3.3 A1A2 Encryption PWB Assembly

Digital data requiring encryption is passed directly from the interface control processor on A1A1 Interface PWB Assembly to the encryption processor on A1A2 Encryption PWB Assembly via the dual port RAM. Encrypted digital data then returns to the interface control processor via the dual port RAM.

3.3.3.4 A4 Signal Processor PWB Assembly

When the main control processor receives a data packet from the interface control processor (via the HSSB), it immediately examines the data packet. Any control commands for the ALE processor, modem control processor. AGC processor, or LPC/AVS processor are immediately output to the HSSB for use by the appropriate processor.

The main control processor then examines the remaining information from the data packet It determines the nature of the information and converts the remaining data into a series of digital commands It then outputs these commands to either AS PA/Battery Charger Assembly or to an external power amplifier (if one is connected) and to the HSSB for transmission to the appropriate processors.

The local oscillators on A6 Synthesizer Assembly (LO1, LO2, and LO3) are controlled via control lines to the main control processor on A4 Signal Processor PWB Assembly.

3.3.3.5 A5 Receiver/Exciter Assembly

The mixers on A5 Receiver/Exciter Assembly are controlled via control lines to the local oscillators

3.3.3.6 A6 Synthesizer Assembly

The local oscillator on A6 Synthesizer Assembly (LO1, LO2, and LO3) are controlled via control lines to the main control processor on A4 Signal Processor PWB Assembly

3.3.4 Digital Voice Signal Paths

The following paragraphs explain the difference between analog clear voice signal paths and Automatic Link Establishment (ALE) signal paths.

3.3.4.1 RF/IF/Audio/Digital Signal Paths (Digital Voice)

During transmit, analog audio enters A10 Front Panel Assembly. The audio switch on A10 Assembly routes the audio signal to the A/D converter on A3 LPC Vocoder Assembly. The resulting digital signal is sent to the LPC/AVS. Processor. The signal then passes to the modem processor via the HSSB. Forward Error Correction (FEC) data is then added to the data stream before being passed to the Quaternary Phase Shift Keying (QPSK) circuit on the FFT DSP, where the 39-tone information is added to the digital signal. The resulting signal is a digital representation of a 39-tone modem waveform. This signal is input to the digital IF DSP The rest of the transmit signal path is the same as with analog clear voice

During receive, the digital signal from the digital IF DSP on A4 Signal Processor PWB Assembly is passed to the FFT DSP mixer. The mixer and the FFT reference eliminates any error introduced to the signal during transmission. The data is then decoded by the FEC circuit before being passed to the modem control processor. The rest of the receive audio path is the reverse of the digital voice transmit path.

3.3.4.2 Control Signal Paths (Digital Voice)

During digital voice operation, the LPC/AVS processor works with the modem processor, the main control processor, the AGC processor, and the interface control processor. Data is passed among these processors via the HSSB.

3.3.5 Analog Voice Security (AVS) Signal Paths

The following paragraphs explain the differences between analog clear voice signal paths and AV.S signal paths

3.3.5.1 RF/IF/Audio/Digital Signal Paths (AVS)

During transmit, analog audio enters A10 Front Panel Assembly The audio switch on A10 Assembly routes the audio signal to the A/D converter on A3 LPC Vocoder Assembly. The resulting digital signal is sent to the LPC/AVS processor The L.PC/AVS processor uses digital signal processing to scramble both the frequency and timing of the speech signal. The LPC/AVS processor then passes the encrypted audio signal directly to the A/D converter on A4 Signal Processor PWB Assembly. The rest of the transmit signal path is the same as with analog clear voice.

During receive, encrypted audio from the D/A converter on A4 Signal Processor PWB Assembly is decrypted by the LPC/AVS processor on A3 LPC Vocoder Assembly The decrypted digital data is passed to to the D/A converter on A3 LPC Vocoder Assembly Analog audio is then passed to A10 Front Panel Assembly, where it is routed to the handset.

3.3.6 Encrypted Digital Data Signal Paths

The following paragraphs explain the differences between analog clear voice signal paths and encrypted digital data signal paths

3.3.6.1 RF/IF/Audio/Digital Signal Paths (Encrypted Digital Data)

Digital data from an external computer terminal passes through A10 Front Panel Assembly to the interlace control processor on A1A1 Interface PWB Assembly. The interface control processor passes the digital data to the encryption processor on A1A2 Encryption PWB Assembly via the dual port RAM. The encryption processor passes the encrypted digital data back through the interface control processor to the modem control processor on A4 Signal Processor PWB Assembly via the dual port RAM. FEC data is then added to the data stream before being passed to the QPSK circuit on the FFT DSP, where the 39-tone information is added to the digital signal The resulting signal is a digital representation of a 39-tone modem waveform This signal is input to the digital IF DSP The rest of the transmit signal path is the same as with analog clear voice

During receive, the digital signal from the digital IF DSP on A4 Signal Processor PWB Assembly is passed to the FFT DSP mixer The mixer and the FFT reference eliminate any errors introduced to the signal during transmission. The data is then decoded by the FFC circuit before being passed to the modem control processor The rest of the receive audio path is the reverse of the encrypted digital data transmit path.

3.3.7 Encrypted Digital Voice Signal Paths

The following paragraphs explain the differences between analog clear voice signal paths and encrypted digital voice signal paths.

3.3.7.1 RF/IF/Audio/Digital Signal Paths (Encrypted Digital Voice)

During transmit, the audio switch on A10 Front Panel Assembly diverts transmit audio to A3 LPC Vocoder Assembly. Audio is then sampled and converted to a digitized audio signal by the A/D converter. This digital data is then processed by the LPC/AVS processor, digitally reducing the effective data rate of voice communications from 96,000 Bits Per Second (bps) to 2,400 bps.

The digital data received from A3 LPC Vocoder Assembly is routed through A1A1 Interface PWB Assembly to A1A2 Encryption PWB Assembly via the HSSB. This data is encrypted by the encryption processor using the encryption key stored in memory. Once the digitized audio has been encrypted, it passes hack through A1A1 Interface PWB Assemble to the modem control processor on A4 Signal Processor PWB Assembly via the HSSB FEC data is then added to the data stream before being passed to the QPSK circuit on the FFT DSP, where the 39-tone information is added to the

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digital signal The resulting signal is a digital representation of a 39-tone modem waveform. The signal is then input to the digital IF DSP. The rest of the transmit signal path is the same as with analog clear voice.

During receive, the digital signal from the digital IF DSP on A4 Signal Processor PWB Assembly is passed to the FFT DSP mixer. The mixer and the FFT reference eliminate any errors introduced to the signal during transmission. The data is then decoded by the FEC circuit before being passed to the modem control processor. The rest of the receive audio path is the reverse of the encrypted digital voice transmit path.

3.3.8 Automatic Link Establishment (ALE) Signal Paths

The following paragraph explains the between analog clear voice signal paths and ALE signal paths.

3.3.8.1 RF/IF/Audio/Digital Signal Paths (ALE) During Link Establishment

The operator presses the CALL button on the RT-1694(P) front panel The display/keypad processor generates a command that is received by the interlace control processor The interface control processor relays this command to the ALE processor on A4 Signal Processor PWB Assembly via the HSSB The ALE processor commands the main control processor, via the HSSB, to configure the receiver-transmitter to the correct channel transmit frequency. Once this has been accomplished. The ALE processor sends digital data to the digital IF DSP, which generates a digital representation of a 6 kHz IF. This signal then passes through a D/A converter, where the digitized IF is converted into an analog signal This signal is passed to A5 Receiver/Exciter Assembly for conversion to an RF signal.

Mixing circuitry on A5 Receiver/Exciter Assembly mixes the IF signal with signals from the local oscillators on A6 Synthesizer Assembly. The resulting RF-signal is in the frequency range of 1.6 MHz to 59.9999 MHz. This RF signal is amplified to approximately 100 mW before being output to AS Power Amplifier/Battery Charger Assembly.

A8 Amplifier/Battery Charger Assembly amplifies the 100 mW RF signal to 20 watts. The 20-watt signal then passes through one to eight harmonic filters to reduce the level of unwanted harmonics. The 20-watt RF signal then passes through a tuning circuit on A9 Antenna Coupler Assembly before being transmitted through the whip antenna.

During receive, the radio is scanning its channel set. The ALE processor commands the main control processor, via the HSSB. to configure the receiver-transmitter to a particular channel.

Once this has been accomplished, RF signals at that channel's frequency (1.6 MHz to 59.9999 MHz) are received by the RT-1694(P) unit at the whip antenna These signals pass through the tuning circuit on A9 Antenna Coupler Assembly and one of the harmonic filters on AS PA/Battery Charger Assembly. The RF signal then follows the receive RX path through the receiver protection circuitry on A8 PA/Battery Charger Assembly These signals are then routed to A5 Receiver/Exciter Assembly The RF signal is mixed with signals from the local oscillators on A6 Synthesizer Assembly. The result is an IF signal.

The IF signal is then converted to a digital representation of the IF signal by the A/D converter on A4 Signal Processor PWB Assembly. The A/D converter passes this signal to the digital IF DSP which removes the IF components of the signal. The digital signal is then passed to the ALE processor which checks to see if valid ALE data is present. If valid ALE data is not present, the ALE processor commands the main control processor to configure the receiver-transmitter to the next channel. If valid ALE data is present, the ALE processor, the ALE processor commands the receiver-transmitter to transmit a line response.

3.3.9 Frequency Hopping Signal Paths

The following paragraphs explain the differences between analog clear voice signal paths and frequency hopping signal paths.

3.3.9.1 RF/IF/Audio/Digital Signal Paths (Frequency Hopping)

During transmit, analog audio enters A10 Front Panel Assembly. The audio switch on A10 Assembly routes the audio signal to the A/D converter on A3 LPC Vocoder Assembly. The resulting digital signal is sent to the LPC/AVS processor. The signal then passes through A1A1 Interface PWB Assembly via the HSSB before reaching the modem processor on A4 Signal Processor PWB Assembly. FFC data is then added to the data stream before being passed to the QPSK circuit on the FFT DSP, where the 39-tone information is added to the digital signal. The resulting signal is a digital representation of a 39-tone modem waveform. This signal is input to the digital IF DSP The rest of the transmit signal path is the same as with analog clear voice.

During receive, the digital signal from the digital IF DSP on A4 Signal Processor PWB Assembly is passed to the FFT DSP mixer. The mixer and the FFT reference eliminate any errors introduced to the signal during transmission. The data is then decoded by the FEC circuit before being passed to the modem control processor The rest of the receive audio path is the reverse of the frequency hopping transmit path.

3.3.9.2 Control Signal Paths (Frequency Hopping)

During frequency hopping operation, the LPC/AVS processor works with the modem processor, the main control processor, and the interface control processor. Data is passed among these processors via the HSSB. The main control processor also varies the frequency of local oscillator LO1 during frequency hopping operation

3.3.10 Frequency Modulation (FM) Signal Paths

The following paragraphs explain the differences between analog clear voice signal paths and frequency hopping signal paths.

3.3.10.1 RF/IF/Audio/Digital Signal Paths (FM)

During transmit, analog audio signals from A10 Front Panel Assembly are digitized by the A/D converter on A4 Signal Processor PWB Assembly. The digital signal from the A/D converter passes through a clipper circuit. A 150-Hz tone used by the receiving station during Tone Squelch operation is then mixed with the clipper output. The digital signal then passes through the D/A converter on A4 Signal Processor PWB Assembly. The resulting FM TX audio is used to modulate the 71 MHz L02 on A6 Synthesizer Assembly.

During receive, the received signal is mixed down to audio on A5 Receiver/Exciter Assembly. After passing through the RX second mixer and the +15 dB amplifier, the IF signal is mixed with the 9.5-MHz L03. The signal is then amplified, passed through an FM discriminator circuit, and low-pass filtered by a 5-kHz LPF. The FM audio signal is then digitized by the A/D converter on A4 Signal Processor PWB Assembly. The signal is then attenuated 24 dB by an attenuator, and AGC is applied. The signal is then checked for squelch activity by the squelch circuit. The digital signal is then converted back to analog by the D/A converter. Receive analog audio is then sent through A10 Front Panel Assembly, where it is routed to the handset.

3.3.11 Power Distribution Paths

Power distribution consist, , of converting a +26 Vdc input (or +20 Vdc to +32 Vdc battery input) to +5 Vdc, +6.8 Vdc, +16.5 1 Vdc, and -12 Vdc, and distributing these voltages to the other RT-1694(P) assemblies, as discussed in the following paragraphs.

3.3.11.1 AC Line Voltage Path

AC line voltage is not directly applied to the RT-1694(P).

3.3.11.2 +26 Vdc Path

A power supply or external power amplifier provides a +26 Vdc to the RT-1694(P) via the front panel PA connector. When used in manpack configuration, +20 Vdc to +32 Vdc from the attached batteries enters the receiver-transmitter via the battery connectors on the rear panel. The input voltage is applied directly to A7 Power Supply Assembly. The A10 Front Panel, AS PA, and AS Receiver/Exciter also use this voltage directly

3.3.11.3 Power Supply Assembly A7

The A7 Power Supply Assembly filters and converts the input voltage into the following voltages.

- +5 Vdc
- +6.8 Vdc
- +16.5 Vdc (unregulated)
- -12 Vdc

From here, the voltages are distributed to the RT-1694(P) assemblies as described in the following paragraphs.

3.3.11.4 Voltages and Assemblies

The following paragraphs discuss the assemblies that use the four power supply voltages.

3.3.11.4.1 Regulated +5 Vdc Line

The regulated +5 Vdc line is used by the following assemblies:

- A1A1 Interface PWB Assembly
- A1A2 Encryption PWB Assembly
- A3.LPC Vocoder Assembly
- A4 Signal Processor PWB Assembly
- A5 Receiver/Exciter Assembly
- A6 Synthesizer Assembly
- A8 PA/Battery Charger Assembly
- A9 Antenna Coupler Assembly
- A11 Motherboard Assembly



3.3.11.4.2 Regulated +6.8 Vdc Line

The regulated +6.8 Vdc line is used by the following assemblies:

- A6 Synthesizer Assembly
- A1 Motherboard Assembly

3.3.11.4.3 Unregulated +16.5 Vdc Line

The unregulated +16.5 Vdc line is used by the following assemblies:

- A1A1 Interface PWB Assembly
- A1A2 Encryption PWB Assembly
- A3 LPC Vocoder Assembly
- A4 Signal Processor PWB Assembly
- A5 Receiver/Exciter Assembly
- A6 Synthesizer Assembly
- A8 PA/Battery Charger Assembly
- A9 Antenna Coupler Assembly
- A10 Front Panel Assembly
- A11 Motherboard Assembly

3.3.11.4.4 Regulated -12 Vdc Line

The regulated -12 Vdc line is used by the following assemblies:

- A1A1 Interface PWB Assembly
- A3 LPC Vocoder Assembly
- A4 Signal Processor PWB Assembly
- A5 Receiver/Exciter Assembly
- A6 Synthesizer Assembly
- A8 PA/Battery Charger Assembly
- A9 Antenna Coupler Assembly
- A10 Front Panel Assembly
- A11 Motherboard Assembly

CHAPTER 4

SCHEDULED MAINTENANCE

4.1 INTRODUCTION

This chapter provides information required to perform scheduled maintenance procedures on the RT-1694(P) Receiver-Transmitter [RT-1694(P)J.

4.1.1 Scheduled Maintenance Procedure List

Table 4-1 lists the scheduled maintenance procedures for the RT-1694(P). The table is divided into the following columns:

- a. Column 1 Paragraph Number, where the procedure begins
- b. Column 2 Scheduled Maintenance Procedure, describes the test to be performed
- c. Column 3 Periodicity, interval in which the procedure must be performed (that is, daily, weekly, monthly, etc.)

Paragraph Number	Scheduled Maintenance Procedure	Periodicity
4.2.1	Receive Sensitivity	12 months
4.2.2	Power Output	12 months
4.2.3	Frequency Accuracy	12 months
4.2.4	Lithium Battery Check	6 months

Table 4-1. Scheduled Maintenance Procedures

4.2 SCHEDULED MAINTENANCE PROCEDURES

The following paragraphs contain information about tests to be performed on an RT-1694(P) as pan of scheduled maintenance.

4.2.1 Receive Sensitivity Test

The following paragraphs provide instructions for performing the receive sensitivity test as part of scheduled maintenance. The receive sensitivity test confirms the proper operation and alignment of the A5 Receiver/Exciter Assembly.

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4.2.1.1 Required Equipment

Table 4-2 list the equipment required to perform the receive sensitivity test.

Table 4-2. Receive Sensitivity Test Required Equipmen	Table 4-2.	Receive	Sensitivity	Test Red	quired E	quipment
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Reference	Item Name	Part Number	Cage Code	Quantity
1	Signal Generator, RF	8657A	28480	1
2	Adapter. N-type (m) to BNC (f)	M55339/20-01	81349	1
3	Cable Assembly, RF, BNC (m)	10503A	28480	2
4	Cable Assembly. DC Power	10394-9010	14304	1
5	Breakout Box	1008-1100	14304	1
6	Audio Analyzer	8903B	28480	1
7	Cable Assembly Auxiliary	10372-9850	14304	1
8	Power Supply	6268B	28480	1

4.2.1.2 Test Procedure

Perform the following procedure to test the sensitivity of the RT-1694(P):

- a Set up the test bed radio system as shown in Figure 4-1.
- b. Sit the signal generator to a frequency of 1.601 MHz.

CAUTION

It a power amplifier is installed in the test circuit, provide adequate RF protection to the input of the signal generator.

- c Set the signal generator to an output level of -110 dBm.
- d. Set the input section of the audio analyzer to measure dB SINAD.
- e Program the RT-1694(P) to 1 6 MHz and IJSB modulation.
- f With the signal generator set to 1.6010 MHz, the SINAD (signal + noise + distortion/noise + distortion) should be greater than 10 dB SINAD at -110 dB of signal, with internal preamplifier OFF. If SINAD measures out of specification, proceed to Noon-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3
- g Repeat this measurement with the following frequency settings:

Signal Generator	R/T Frequency
15.001 MHz 29.001 MHz 30.101 MHz 46.601 MHz 59.701 MHz	15.0000 MHz 29.0000 MHz 10.1000 MHz 46.6000 MHz 59.7000 MHz

If SINAD measures out of specification, proceed to Non-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3.

- h. Program the RT-1694(P) to 2.1 MHz and USB modulation.
- i. With the signal generator set to 2.1010 MHz, the SINAD (signal + noise + distortion/noise + distortion) should be greater than 10 dB SINAD at -115 dB of signal, with internal preamplifier ON. If SINAD measures out of specification, proceed to Non-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3.
- j. Repeat this measurement with the following frequency settings.

Signal Generator	R/T Frequency
15.001 MHz	15.0000 MHz
29.001 MHz	29.0000 MHz
30.101 MHz	30.1000 MHz
46.601 MHz	46.6000MHz
59.701 MHz	59.7000 MHz

If SINAD measures out of specification, proceed to Non-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3.

- k. Program the RT-1694(P) to 31.05 MHz and Frequency Modulation (FM).
- I. With the signal generator set to 31.05 MHz, FM modulate the generator with a 1 kHz tone at 8 kHz deviation. The SINAD (signal + noise + distortion/noise + distortion) should be greater than 10 dB SINAD at -113 dB of signal, with internal preamplifier ON. If SINAD measures out of specification. proceed to Non-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3.
- m. Repeat this measurement with the following frequency settings:

Signal Generator and R/T

46.250 MHz 53.100 MHz

If SINAD measures out of specification, proceed to Non-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3.

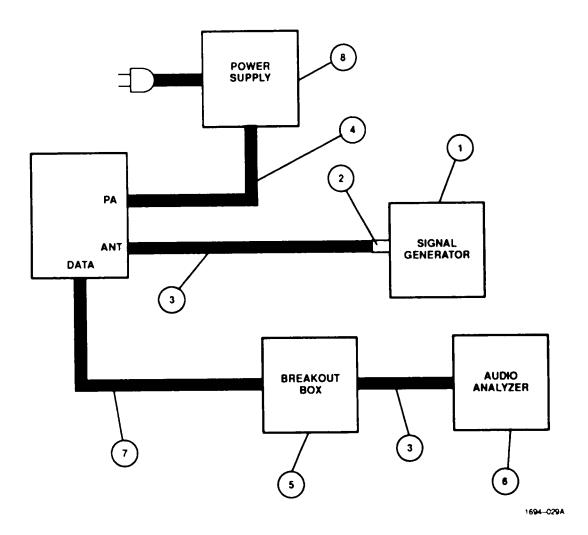


Figure 4-1. Receive Sensitivity Test Set Up

4.2.2 Power Output Measurement

The following paragraphs provide instructions to measure the power output of the receiver-transmitter as part of scheduled maintenance. The power output test verifies that the receiver-transmitter is transmitting with the proper power level.

4.2.2.1 Required Equipment

Table 4-3 lists the equipment required to perform the power output measurement.

Reference	Item Name	Part Number	Cage Code	Quantity
1	Handset (H-250/U)	10075-1344-01	14304	1
2	Battery Eliminator	10372-9330	14304	1
3	Power Supply	6268B	28480	1
4	Cable Assembly, RF, BNC (m)	10503A	28480	1
5	Adapter, N-type (m) to BNC (f)	M55339/20-00201	81349	1
6	Power Meter, RF	437B	28480	1
7	Power Sensor	8482B	28480	1
8	Attenuator	77B6-30	70998	1

Table 4-3. Power Output Measurement Required Equipment
--

4.2.2.2 Test Procedure

Perform the following procedure to measure the output power of the RT-1694(P):

- a. Set up the test bed radio system as shown in Figure 4-2.
- b. Configure the receiver-transmitter as listed in Table 4-4.
- c. Using the handset, key the receiver-transmitter and verify that the output level is +43 dBm +2.0/-1.0 dB as measured on the RF power meter (+13 dBm with 30 dB of attenuation). If the output power measures out of specification, proceed to Non-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3.
- d. Repeat this measurement with the receiver-transmitter set to the following transmit frequencies:

15.0000 MHz 29.0000 MHz 31.1000 MHz 46.6000 MHz 59.7000 MHz

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Control	Setting
Function Switch	SSB
Mode	CW
Power	High
Digital Voice	OFF
Internal Coupler	BYPASS
Receiver Preamplifier	BYPASS
Modem	OFF
Squelch	OFF
Encryption	OFF
RX Frequency	1.6 MHz
FX Frequency	1.6 MHz
RF Gain	100%
AGC	Fast
IF BW	0.35 kHz



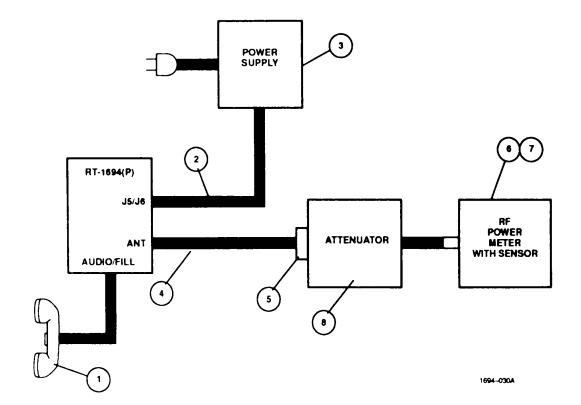


Figure 4-2. Power Output Measurement Test Set Up

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4.2.3 Frequency Accuracy Measurement

The following paragraphs provide instructions to measure the frequency accuracy of the receiver-transmitter as part of scheduled maintenance. The frequency accuracy test verifies that A6 Synthesizer Assembly is producing accurate signals.

4.2.3.1 Required Equipment

Refer to Table 4-5 for a list of the equipment required to perform the transmit frequency measurement.

Reference	Item Name	Part Number	Cage Code	Quantity
1	Handset (H-250U)	10075-1344-01	14304	1
2	Cable Assembly, DC Power	10394-9010	14304	1
3	Power Supply	6268B	28480	1
4	Cable Assembly, RF, BNC (m)	10503A	28480	2
5	Adapter, N-type (m) to BNC (f)	M55339/2O-00201	81349	2
6	Attenuator	77B6-30	70998	1
7	Frequency Counter	5385A	28480	1

Table 4-5. Transmit Frequency Measurement Required Equipment

4.2.3.2 Test Procedure

Perform the following procedure to measure the transmit frequency of the RF-5022R/T(E) Receiver-Transmitter:

- a. Set up the test bed radio system as shown in Figure 4-3.
- b. Configure the receiver-transmitter as listed in Table 4-6.
- c. Using the handset, key the receiver-transmitter. The output frequency should be 29.900000 MHz <u>+</u>12 Hz as measured on the frequency counter. If the frequency is not within specification, proceed to Non-BIT Troubleshooting Procedures, Chapter 5, Paragraph 5.2.3.

Control	Setting			
Function Switch	SSB			
Mode	CW			
Power	High			
RX Frequency	29.9000 MHz			
TX Frequency	29.9000 MHz			
BFO	0000 Hz			

Table 4-6. RT-1 694(P) Settings for Power Output Test

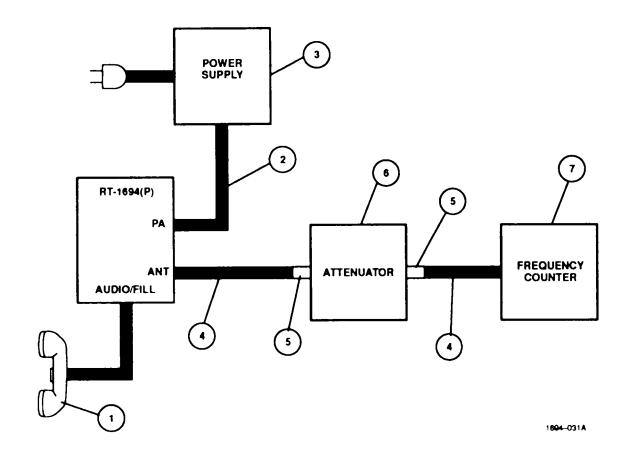


Figure 4-3. Transmit Frequency Measurement Test Set Up

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4.2.4 Lithium Battery Check

The following paragraphs provide instructions to check the strength of BT1 Lithium Battery, soldered on A1A1 Interface PWB Assembly, as pan of scheduled maintenance.

4.2.4.1 Required Equipment

Refer to Table 4-7 for a list of the equipment required to perform the lithium battery check.

Table 4-7.	Lithium Batte	erv Check Rea	uired Equipment
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Reference	Item Name	Part Number	Cage Code	Quantity
1	Digital Multimeter	AN/PSM45A	89536	1

4.2.4.2 Test Procedure

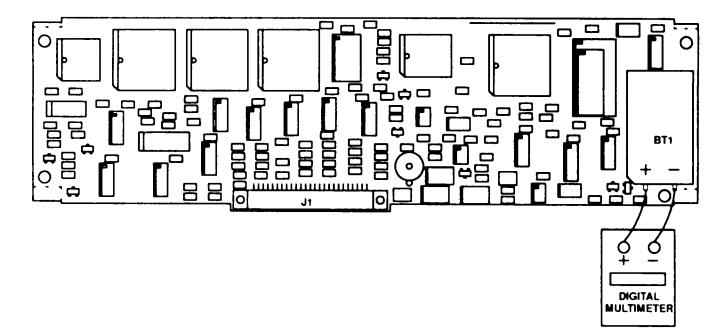
Perform the following procedure to check BTI Lithium Battery:

- a. Remove A1A1 Interface PWB Assembly from the receiver-transmitter. Refer to Chapter 6, Paragraph 6.5.3.1.
- b. Use the digital multimeter to check the voltage of BT1 Lithium Battery. See Figure 4-4.
- c. If the voltage reading on the digital multimeter is less than +3.00 Vdc, replace the original A1A1 Interface PWB Assembly with a new A1A1 assembly. Send the original A1A1 assembly to the Level IV maintenance facility to have BT1 Lithium Battery replaced.

NOTE

Replacing BT1 Lithium Battery is not an authorized Level III maintenance procedure.

d. Assemble the receiver-transmitter. Refer to Chapter 6, Paragraph 6.5.3.2.



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CHAPTER 5

TROUBLESHOOTING

5.1 INTRODUCTION

5.1.1 General

This chapter provides troubleshooting data necessary for fault isolation to the Shop Replaceable Unit (SRU) level

5.1.2 Scope of this Chapter

The procedures presented in this chapter assume that the RT-1694(P) Receiver-Transmitter [RT-1694(P)] is faulty. The maintenance turn-on procedure is used to find a fault indication with the unit. If there is a non-Built-In-Test (non-BIT) fault, the maintainer will use the non-BIT troubleshooting procedures. If there is a BIT fault, the maintainer will use the BIT troubleshooting procedure. If the problem is not corrected using these procedures, the troubleshooting index is to be used based on the functional area of the fault. The unit is beyond Level III repair if the faulty circuit cannot be determined by either of these methods. If the problem is found and corrected, the unit is returned to operational readiness. See Figure 5-1.

NOTE

If the execution of BIT results in an A28 or A29 fault code, refer to the appropriate pre/postselector Level III maintenance manual for the system.

If the execution of BIT results in an A30 fault code. refer to the appropriate power amplifier Level III maintenance manual for the system.

If the execution of BIT results in an A40 fault code, refer to the appropriate antenna coupler Level III maintenance manual for the system.

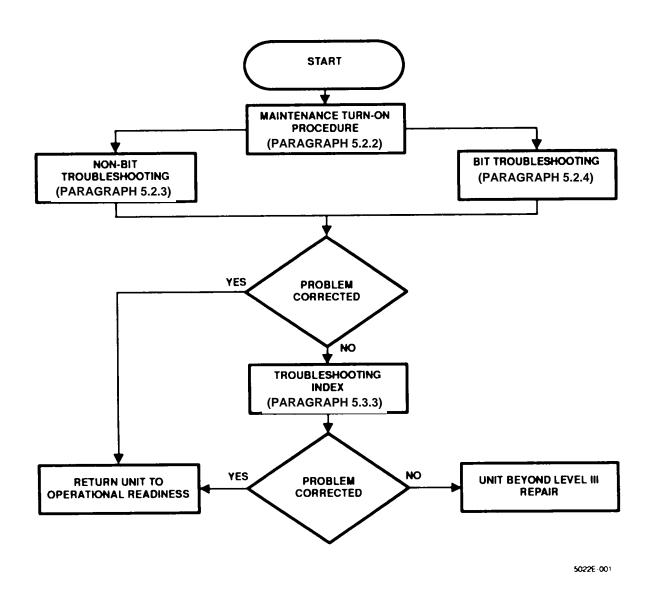


Figure 5-1. Troubleshooting Process Used in this Chapter

5.2 TROUBLESHOOTING PROCEDURES

5.2.1 General

Prior to beginning any troubleshooting procedure, the receiver-transmitter Unit Under Test (UUT) must be installed in a Hot Test Bed setup. Table 5-1 lists the required equipment for the hot test bed. See Figure 5-2 for the equipment interconnect diagram.

Troubleshooting begins with performing the maintenance turn-on procedure. The maintenance turn-on procedure references the non-BIT and BIT troubleshooting procedures. Refer to Paragraph 5.2.2.

Reference	Item Name	Part Number	Cage Code	Quantity
1	Power Supply	6268B	28480	1
2	Battery Eliminator	10372-9330	14304	1

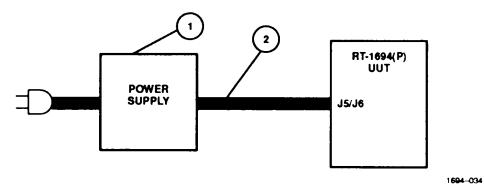


Figure 5-2. Hot Test Bed Equipment Interconnect Diagram

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5.2.2 Maintenance Turn-On Procedure

Table 5-2 provides the maintenance turn-on procedure for the RT-1694(P). The maintenance turn-on procedure is used to guide the maintainer through the proper front panel settings to power up the unit from a de-energized state to a fully operational state. In each step, the maintainer is to observe the unit for normal operating conditions. Faults may be observed by BIT or a visual observation. The first column in Table 5-2 contains the procedure. The second column gives the expected normal observation, and the third column references the procedure to follow if the expected normal observation is not found. These references include BIT troubleshooting and non-BIT troubleshooting procedures.

	Step	Observe	Reference
a.	Turn the FUNCTION knob on the receiver-transmitter clockwise to the SSB position.	The receiver-transmitter displays the same display from when it was last used in Single Sideband (SSB) mode.	Refer to the non-BIT troubleshooting procedures in Paragraph 5.2.3.
b.	Rotate the FUNCTION knob clockwise to the TEST position	The receiver-transmitter displays an initialization screen, followed by this screen:	Refer to the non-BIT troubleshooting procedures in Paragraph 5.2.3.
c.	Press and release the ENTER key.	TEST VERSION VSWR BATTERY The receiver-transmitter displays the following screen:	
d	Observe that all tests passed or a fault code is displayed. following screen:	** SELF TEST ** * IN PROGRESS * If no errors occur during BIT, the receiver-transmitter displays the	
		SELF TEST DONE ** NO ERRORS **	
		If a fault code is displayed, note the faulty module or fault group.	Refer to the BIT troubleshooting procedures in Paragraph 5.2.4.
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Table 5-2	Maintenance	Turn-On	Procedure
	mannenanoe		1 100000000

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5.2.3 Troubleshooting with Non-Bit Fault Isolation

Table 5-3 is a listing of the non-BIT fault symptoms and a reference to the figure and sheet where the troubleshooting now begins. On the referenced sheet, follow the top of the diagram from left to right to locate the symptom being experienced. For the applicable symptom, follow from top to bottom for the checks and corrective action. If the actions do not correct the problem, proceed to the troubleshooting index in Paragraph 5.3.3.

Symptom Observed	Figure/Sheet Reference
Faults that Generate a Message on RT-1 694(P) Front Panel LCD	
ALE NOT INSTALLED	5-3/1
CHANNEL DATA STORAGE FAILURE	5-3/1
INTERNAL COMM FAULT	5-3/1
OUT OF LOCK	5-3/2
PA COMM FAULT	5-3/2
TUNE FAULT	5-3/2
Miscellaneous Fault Symptoms	
Receiver-transmitter will not tune antenna/high VSWR	5-3/2
Intermittent/no receive signal; receiver-transmitter still transmits	5-3/3
Degraded receive audio quality	5-3/4
Degraded transmit signal quality	5-3/5
No transmit or receive	5-3/5
Intermittent transmit output; receiver-transmitter still receives	5-3/6
No transmit output; receiver-transmitter still receives	5-3/6
Erroneous transmit or receive data	5-3/7
Receiver-transmitter will not unkey	5-3/7
Channel selected does not match channel displayed	5-3/7
Mode selected does not match mode displayed	5-3/7
Pressing keypad buttons results in data entry errors	5-3/'7
Display does not change when receiver-transmitter is keyed	5-3/'7
No display on front panel LCD	5-3/8
No keypad backlight. or backlight wrong brightness	5-3/8
ALE powers up but does not scan	5-3/8
ALE scans but does not transmit	5-3/8
Receiver-transmitter does not synchronize when frequency hopping	5-3/8

Table 5-3. N	lon-BIT Fault Symptoms
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Symptom Observed	Figure/Sheet Reference
External device does not communicate with receiver-transmitter	5-3/9
External device does not power up	5-3/9
Receiver-transmitter does not accept fill data	5-3/9
Loss of encryption mode	5-3/9
Total loss of radio operation	5-3/10
Loss of programmed information	5-3/10
Receiver-transmitter does not conic out of standby mode	5-3/10
Receiver-transmitter does not accept new programming	5-3/11
Receiver-transmitter displays incorrect battery voltage	5-3/11
Suspected receive sensitivity problem	5-3/11
Receiver-transmitter failed Receive Sensitivity Test in Chapter 4	5-3/11
Suspected power output problem	5-3/12
Receiver-transmitter failed Power Output Test in Chapter 4	5-3/12
Suspected frequency accuracy problem	5-3/12
Receiver-transmitter failed Transmit Frequency Test in Chapter 4	5-3/12

Table 5-3. Non-BIT Fault Symptoms - Continued

5.2.4 Troubleshooting with BIT Fault Isolation

Table 5-4 is a list of BIT fault codes with their suspected faulty assemblies When a fault code is displayed on the receivertransmitter front panel, locate fault code in column one of Table 5-4. Starting with the first assembly listed in column three, remote the assembly and replace it with a spare assembly (refer to Chapter 6 for removal and replacement procedures). Execute BIT It the unit passes BIT, the faulty module has been isolated. If the unit fails BIT with the same fault code, replace the original module into the receiver-transmitter, and proceed to the next module listed in column two

Continue in this manner until the fault is eliminated, or all suspected assemblies have been replaced on a trial basis. If all assemblies have been replaced and the unit continues to exhibit the same fault code, refer to Paragraph 5.3.3. and Table 5-5. the Troubleshooting Index, for additional troubleshooting recommendations.

Fault Code	Description	Suspected Assemblies
A1A1F01	Communications fault	A4,A1A1
A1A1F02	Non-destructive internal RAM fault	A1A1
A1A1F03	ROM checksum fault	A1A1
A1A1F04	Non-destructive external RAM fault	A1A1
A1A1F05	Asynchronous data channel fault	A1A1

Table 5-4. RT-1 694(P) Fault Codes and Suspected Assemblies

Fault Code	Description	Suspected Assemblies		
A1A1 F06	Synchronous data channel fault	A1A1, A10		
A1A1 F09	Remote data channel fault	A1A1, A10, A1A2		
A1A1 F0A	Dual port RAM semaphore register fault	A1A2 A6, A1A1		
A1A1 F0B	Dual port RAM fault	A1A1, A10		
A1A1 F0F	Frame clock not detected	A4, A1A1		
A1A1 F10	PA DUART internA1 counter fault	A1A2, A1A1		
A1A1 F11	ExternA1 PA communications channel fault	A1A2, A1A1		
A1A1 F51	Real time clock not installed or not working	A1A1		
A1A1 F52	Internal real time clock RAM fault	A1A1		
A1A1 F55	Real time clock rollover registers not operational	A1A1		
A1A1 F56	RTC crystal oscillator failed	A1A1		
A1A1 F81	No communication with encryption board	A1A2, A1A1		
A1A2 F81	No communication with interface board	A1A2, A1A1		
A1A2 F81	ROM checksum fault	A1A2, A1A1 A1A2, A1A1		
A1A2 F83	Non-destructive internal RAM fault	A1A2, A1A1		
A1A2 F84	Non-destructive external RAM fault	A1A2, A1A1		
A1A2 F85	Dual port RAM fault	A1A2, A1A1 A1A2, A1A1		
A1A2 F85	Dual port RAM semaphore register fault	A1A2, A1A1 A1, A2		
A1A2 F87	Decryption (ACE) chip fault	A1, A2 A1A21, A1A1		
A1A2 F88	HSS internA1 register fault	A1A2, A1A1		
A1A2 F89	Encryption/Decryption loop back fault	A1A2, A1A1		
A03 F01	8751 communications fault	A1A2, A1A1 A3, A1		
A03 F02	8751 ROM fault	A3, A1 A3		
A03 F02 A03 F03	8751 microprocessor internA1 RAM fault	A3 A3		
A03 F05	8751 dual port RAM fault	A3		
A03 F05 A03 F06	8751 dual port RAM busy fault	A3 A3		
A03 F07	8751 dual port RAM busy fault	A3 A3		
A03 F07 A03 F14	Hop clock fault	A3 A4, A3		
A03 F14 A03 F15	Frame clock fault	A4, A3 A4, A3		
A03 F81	TMS320 internal RAM fault	A4, A3 A3, A4		
A03 F82	TMS320 internal RAM raute	A3, A4 A3, A4		
A03 F83	TMS320 external data RAM fault	A3, A4 A3, A4		
		A3, A4		

Tabla 5-1	$DT_1 601(D)$	Fault Codes and	Sucnactad	Accompliac -	Continued
1 abie 5-4.	$K_{1} = 1034(F)$	i auii Coues anu	Suspecieu	733611101163 -	Continueu

RT-1694(P) RECEIVER-TRANSMITTER TROUBLESHOOTING

A03 F84 A03 F85 A03 F86 A03 F87 A03 F88 A03 F5 A03 FA	TMS320 ROM fault TMS120 dual port RAM fault Sample clock fault TMS320 AIC fault	A3, A4 A3, A4 A3, A4
A03 F86 A03 F87 A03 F88 A03 F5	Sample clock fault	
A03 F87 A03 F88 A03 F5	Sample clock fault	
A03 F88 A03 F5		
A03 F88 A03 F5		A3, A4
	TMS320 DAC fault	A3, A4
	8751 not finished fault	A3, A4
	TMS320 not finished fault	A3, A4
A04 F01	Communication fault (Modem Processors)	Á4
A04 F14	hop clock error (Modem Processors)	A4, A3, A11
A04 F15	Frame clock error (Modem Processors) A1A1	Á4, Á3,
A04 F1F	FEC ROM checksum fault (Modem Processors)	A4
A04 F20	FEC external RAM fault (Modem Processors)	A4
A04 F21	FEC dual port RAM fault (Modem Processors)	A4
A04 F22	MDM not running (Modem Processors)	A4
A04 F23	FI-T handshake fault (Modem Processors)	A4
A04 F24	FFT to MDM dual port RAM fault (Modem Processors)	A4
A04 F25	MDM to FFT dual port RAM fault (Modem Processors)	A4
A04 F26	MDM to FEC dual port RAM fault (Modem Processors)	A4
A04 F27	MDM ROM checksum fault (Modem Processors)	A4
A04 F28	MDM RAM fault (Modem Processors)	A4
A04 F29	Sample clock error (Modem Processors)	A4
A04 F2A	FFT ROM checksum fault (Modem Processors)	A4
A04 F2B	FFF internal RAM fault (Modem Processors)	A4
A04 F2C	FFT external RAM fault (Modem Processors)	A4
A04 F2D	FFF to DIF dual p)or RAM fault (Modem Processors)	A4
A04 F2E	Hop clock error (Modem Processors)	A4,A3,A11
A04 F2F	FFT self test not complete (Modem Processors)	A4
A04 F30	FFT self test not complete (Modem Processors)	A4
A04 F31	Reserved (Modem Processors)	A4
A04 F32	Time sample transfer (Modem Processors	A4
A04 F33	MDM self test not complete (Modem Processors)	A4
A04 F34	FEC sell test not complete (Modem Processors)	A4
A04 F41	No communications (Main Control Processor)	A4

Table 5-4. R	T-1 694(P) Fault Codes and Suspe	cted Assemblies - Continued

	Fault Code	Description	Suspected Assemblies
A04 F43ROM checksum fault (Main Control Processor)A4A04 F44Non-destructive external RAM faultA4(Main Control Processor)A4A04 F61Communication fault (AGC Processor)A4A04 F62Internal RAM fault (AGC Processor)A4A04 F63ROM checksum fault (AGC Processor)A4A04 F64External RAM fault (AGC Processor)A4A04 F67Digital IF handshake fault - dual port RAMA6, A4(AGC Processor)A4A04 F6BDigital IF not finished with BITE (AGC Processor)A4A04 F6CAnti-alias filter fault (AGC Processor)A4A04 F6E28.8 kHz sampler clock fault (AGC Processor)A4A04 F74Frame clock not detected (AGC Processor)A4A04 F75Hop clock not detected (AGC Processor)A4A04 F80ROM checksum fault (Digital IF Processor)A4A04 F81Internal RAM fault (Digital IF Processor)A4A04 F82External RAM fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A05 F01Receiver in-band digital attenuation too lowA5, A4A05 F03<	A04 F42	Non-destructive internal RAM fault	A4, A5
A04 F44Non-destructive external RAM faultA4(Main Control Processor)A4A04 F61Communication fault (AGC Processor)A4A04 F62Internal RAM fault (AGC Processor)A4A04 F63ROM checksum fault (AGC Processor)A4A04 F64External RAM fault (AGC Processor)A4A04 F67Digital IF handshake fault - dual port RAMA6, A4(AGC Processor)A4A04 F68Digital IF not finished with BITE (AGC Processor)A4A04 F6028.8 kHz sampler clock fault (AGC Processor)A4A04 F6E24.0 kHz sampler clock fault (AGC Processor)A4A04 F75Hop clock not detected (AGC Processor)A4A04 F75Hop clock not detected (AGC Processor)A4A04 F80ROM checksum fault (Digital IF Processor)A4A04 F81Internal RAM fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A05 F01Receiver in-band analog attenuation too lowA5, A4A05 F02Receiver out-of-band digital attenuation too highA5, A4A05 F03Receiver out-of-band digital attenuation too highA5, A4A05 F04Exciter gain too lowA5, A4A05 F10 </td <td></td> <td>(Main Control Processor)</td> <td></td>		(Main Control Processor)	
A04 F44Non-destructive external RAM faultA4(Main Control Processor)A4A04 F61Communication fault (AGC Processor)A4A04 F62Internal RAM fault (AGC Processor)A4A04 F63ROM checksum fault (AGC Processor)A4A04 F64External RAM fault (AGC Processor)A4A04 F67Digital IF handshake fault - dual port RAMA6, A4(AGC Processor)A4A04 F68Digital IF not finished with BITE (AGC Processor)A4A04 F6028.8 kHz sampler clock fault (AGC Processor)A4A04 F6128.8 kHz sampler clock fault (AGC Processor)A4A04 F6224.0 kHz sampler clock fault (AGC Processor)A4A04 F75Hop clock not detected (AGC Processor)A4A04 F75Hop clock not detected (AGC Processor)A4A04 F81Internal RAM fault (Digital IF Processor)A4A04 F82External RAM fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to AGC fault (Digital IF Processor)A4A05 F01Receiver in-band analog attenuation too lowA5, A4<	A04 F43	ROM checksum fault (Main Control Processor)	A4
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A04 F83Dual port RAM to AGC fault (Digital IF Processor)A4A04 F84Dual port RAM to FFT fault (Digital IF Processor)A4A05 F01Receiver in-band analog attenuation too lowA5, A4A05 F02Receiver in-band digital attenuation too lowA5, A4A05 F03Receiver out-of-band analog attenuation too highA5, A4A05 F04Receiver out-of-band digital attenuation too highA5, A4A05 F0FExciter gain too lowAS, A4A05 F10Exciter gain too lowAS, A4A05 F11Exciter output too lowAS, A4A05 F12Combined lock detect faultAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8			
A04 F84Dual port RAM to FFT fault (Digital IF Processor)A4A05 F01Receiver in-band analog attenuation too lowA5, A4A05 F02Receiver in-band digital attenuation too lowA5, A4A05 F03Receiver out-of-band analog attenuation too highA5, A4A05 F04Receiver out-of-band digital attenuation too highA5, A4A05 F0FExciter gain too lowAS, A4A05 F10Exciter gain too highAS, A4A05 F11Exciter output too lowAS, A4A05 F12Exciter output too lowAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8			A4
A05 F01Receiver in-band analog attenuation too lowA5, A4A05 F02Receiver in-band digital attenuation too lowA5, A4A05 F03Receiver out-of-band analog attenuation too highA5, A4A05 F04Receiver out-of-band digital attenuation too highA5, A4A05 F0FExciter gain too lowAS, A4A05 F10Exciter gain too highAS, A4A05 F11Exciter output too lowAS, A4A05 F12Exciter output too lowAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8A08 FFFAll harmonic filter bands failed faultA8			A4
A05 F02Receiver in-band digital attenuation too lowA5, A4A05 F03Receiver out-of-band analog attenuation too highA5, A4A05 F04Receiver out-of-band digital attenuation too highAS, A4A05 F0FExciter gain too lowAS, A4A05 F10Exciter gain too highAS, A4A05 F11Exciter output too lowAS, A4A05 F12Exciter output too lowAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8			
A05 F03Receiver out-of-band analog attenuation too highA5, A4A05 F04Receiver out-of-band digital attenuation too highAS, A4A05 F0FExciter gain too lowAS, A4A05 F10Exciter gain too highAS, A4A05 F11Exciter output too lowAS, A4A05 F12Exciter output too highAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A05 F02		
A05 F04Receiver out-of-band digital attenuation too highAS, A4A05 F0FExciter gain too lowAS, A4A05 F10Exciter gain too highAS, A4A05 F11Exciter output too lowAS, A4A05 F12Exciter output too lowAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A05 F03		
A05 F0FExciter gain too lowAS, A4A05 F10Exciter gain too highAS, A4A05 F11Exciter output too lowAS, A8A05 F12Exciter output too highAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A05 F04		AS, A4
A05 F10Exciter gain too highAS, A4A05 F11Exciter output too lowAS, A8A05 F12Exciter output too highAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A05 F0F		AS, A4
A05 F12Exciter output too highAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A05 F10		
A05 F12Exciter output too highAS, A4A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A05 F11		AS, A8
A06 F12Combined lock detect faultA6, A4, A1A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A05 F12		
A06 F20Serial EEPROM data read faultA6, A4, A1A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A06 F12		A6, A4, A11
A08 FaultsHarmonic filter band faultA8, A9A08 FFFAll harmonic filter bands failed faultA8	A06 F20		A6, A4, A11
	A08 Faults	Harmonic filter band fault	
A09 F01 Coupler - PA path broken A9, AI, WI	A08 FFF	All harmonic filter bands failed fault	A8
	A09 F01	Coupler - PA path broken A9, AI, WI	

Fault Code	Description	Suspected Assemblies
A10 F02	Non-destructive internal RAM fault	A10
A10 F03	ROM checksum fault	A10
A10 F04	Non-destructive external RAM fault	A10
A10 F05	Display driver's busy flag is not functional	A10

Table 5-4. RT-1 694(P) Fault Codes and Suspected Assemblies - Continued

5.3 TROUBLESHOOTING SUPPORT DATA

5.3.1 Protective Device Index

The RT-1694(P) contains no maintainer-replaceable protective devices. Therefore, there is no protective device index.

5.3.2 Relay and Lamp Indexes

Since there are no maintainer-replaceable relays or lamps in the RT-1694(P), relay and lamp indexes are not provided.

5.3.3 Troubleshooting Index

Table 5-5 is the troubleshooting index for the RT-1694(P). Use the troubleshooting index if the actions called out in the BIT (Paragraph 5.2.4) or non-BIT troubleshooting (Paragraph 5.2.3) procedures do not correct a problem. The functional areas are listed in the left column of the index in Table 5-5. The second column references the functional block diagrams for each functional area A reference for the text description for each functional area is provided in column three. Column four is not applicable to the RT-1694(P). Analyze the information for each functional area and the interconnect schematic diagram (see Figure 5-6), and determine which circuits affect each functional area in an attempt to isolate the problem to an SRU.

The information contained in this manual complies with the requirements specified for Level III maintenance. If the unit or component is still non-functional after using the procedures, functional descriptions, and block diagrams in this manual, refer to local directives for disposition of the unit.

Functional Area	Signal Path Diagram	Functional Description Paragraph	Alignment/ Adjustment Paragraph
BIT Signal Path RF/EF/Audio/Digital/Control Signal Path Power Distribution	N/A S4 5-5	5.6 3.3.2 3.3.3 3.3.11	N/A N/A N/A

Table 5-5.	Troubleshooting	Index
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5-37
5-51

5.4 TROUBLESHOOTING DIAGRAMS

5.4.1 General

Troubleshooting diagrams are described in their respective paragraphs, and include the following:

- RF/IF/Audio/Data/Control Signal Path Diagram
- Power Distribution Diagram

5.4.2 BIT Signal Path Diagram

Because much of the BIT detection occurs over the High Speed Serial Bus (HSSB), there is no BIT signal path diagram. Refer to Paragraph 5.2.4 for BIT troubleshooting recommendations. Refer to Paragraph 5.6 for BIT test descriptions.

5.4.3 RF/IF/Audio/Digital/Control Signal Path Diagram

See Figure 5-4 for the RF/IF/Audio./Digital/Control signal path diagram. This diagram show circuits that are used for the RF, IF, audio, digital, and control signals.

5.4.4 Power Distribution Diagram

See Figure 5-5 for the power distribution diagram. This diagram shows the paths of the power supply DC voltages.

5.5 INTERCONNECT SCHEMATIC DIAGRAM

5.5.1 General

Figure 5-6 is the interconnect schematic diagram for the RT-1694(P).

5.6 BIT DESCRIPTION

5.6.1 General

The RT-1694(P) has the ability to perform extensive self testing in the event of a failure. The receiver-transmitter also controls BIT for an external Pre/Postselector (if connected), external power amplifier (if connected), and external antenna coupler (if connected). The general types of tests and the assemblies affected are described in the following paragraphs.

5.6.2 BIT Routine

These tests can be automatically performed by rotating the Function switch to the TEST position, followed by pressing the [ENTER] key. During execution of the self test, the front panel message SELF TEST IN PROGRESS is displayed. If it is determined that a fault exists on a particular assembly, that assembly number and corresponding fault code number defining the type of failure will be displayed on the RT-1694(P) front panel alphanumeric display. All fault codes are listed in Table 5-4.

If initiating the self test function results in no faults, the front panel message SELF TEST DONE NO ERRORS will be displayed.

5.6.3 BIT Test Description

The self-diagnostic routine used to verify the proper operation of the RT- 1694(P) is described in the following paragraphs. It may be necessary to consult the specific functional block diagram for the circuit under discussion.

5.6.3.1 A1A1 Interface PWB Assembly BIT Sequence Description

The following paragraphs describe the sequence of tests performed on A1A1 Interface PWB Assembly during execution of an RT-1694(P) self test routine.

5.6.3.1.1 Fault 01 - Communications Fault Test

The communications fault indicates that the Main Controller processor on A4 Signal Processor PWB Assembly cannot communicate with the A1A1 Interface Assembly. It implies a fault that prevents the 87C51 microprocessor from running. In reality, this fault should not be able to occur because the Interface Assembly must be communicating in order for the operator to start the BITE test. A failure might indicate a problem with the BITE test internal timing.

5.6.3.1.2 Fault 02 - Microprocessor Internal RAM Fault Test

The microprocessor (internal RAM) fault indicates that the RAM internal to the interface microprocessor is faulty.

5.6.3.1.3 Fault 03 - ROM Fault Test

The ROM fault test verifies the proper operation of the program memory by performing an additive checksum test on the PROM. Every memory location in the PROM is added together and compared with a value stored in the PROM. Failing this test indicates either a faulty PROM or some other failure that prevents the microprocessor from correctly accessing program memory.

5.6.3.1.4 Fault 04 - RAM Fault Test

The RAM fault verifies the proper operation of the CMOS RAM. It performs a nondestructive test of all memory locations, first saving the data, then writing and reading a pattern from each address location.

5.6.3.1.5 Fault 05 - Asynchronous Data Channel Fault Test

This test verifies the internal operation of a Dual Universal Synchronous/Asynchronous Receiver-Transmitter (DUSART) on A1A1 Interface PWB Assembly. It performs an internal loop-back test. This DUSART provides communication between the data port serial lines and the microprocessor.

5.6.3.1.6 Fault 06 - Synchronous Data Channel Fault Test

This test verifies the internal operation of a DUSART on A1A1 Interface PWB Assembly. It performs an internal loop-back test. This DUSART provides communication between the data port serial lines and the microprocessor.

5.6.3.1.7 Fault 09 - Remote Communications Channel Fault Test

This test verifies the operation of a DUSART on AIAI Interface PWB Assembly. It performs an internal loop-back test. This DUSART is used to communicate with the front panel and the auxiliary remote port.

5.6.3.1.8 Fault 0A - External PA DUART Counter Fault Test

Perform the following Dual Universal Asynchronous Receiver-Transmitter (DUART) counter fault test to verify the operation of the baud rate generator internal to the DUART.

5.6.3.1.9 Fault 0B - External PA Communications Channel Fault Test

The DUART serial data fault test verifies operation of the DUART. It performs internal testing of the integrated circuit as well as a loop-back test on board. The DUART is used to communicate with the power amplifiers and antenna couplers in the system. This communication is performed via high-speed serial data using a proprietary Harris protocol. The data is sent using a bidirectional link; therefore, any data sent is also received.

5.6.3.1.10 Faults 0F - Frame Clock Fault Test

The frame clock fault test verifies the ability of the Interface PWB Assembly microprocessor to detect activity on the frame clock line. The frame clock is used to synchronize data transfers between AIAI Interface PWB Assembly and the modem portion of A4 Signal Processor PWB Assembly. This line pulses at a regular rate whenever the modem is enabled.

5.6.3.1.11 Fault 10 - Semaphore Register Fault Test

This test verifies the Interface PWB Assembly's half of the AIA2 Encryption PWB Assembly's dual port RAM semaphore registers.

5.6.3.1.12 Fault 11 - Dual Port RAM Fault Test

This test performs a non-destructive RAM test of the dual port RAM on A1A2 Encryption PWB Assembly.

5.6.3.1.13 Fault 51 - Real-Time Clock (RTC) Fault Test

This failure indicates that the real-time clock on AIAI Interface PWB Assembly does not respond to any signals that are sent to it.

5.6.3.1.14 Fault 52 - RTC Internal RAM Fault Test

A non-destructive RAM test is done during BITE on two blocks of RAM within the real-time clock.

5.6.3.1.15 Fault 55 - RTC Rollover Registers Fault Test

This fault indicates that the internal time of the real-time clock is not functioning correctly.

5.6.3.1.16 Fault 56 - RTC Crystal Oscillator Fault Test

Check for the presence of a specific square wave at the real-time clock.

5.6.3.1.17 Fault 81 - Encryption No Communication Fault Test

This test verifies that A1A1 Interface PWB Assembly can communicate with A1A2 Encryption PWB Assembly during sell-test.

5.6.3.2 A1A2 Encryption PWB Assembly BIT Sequence Description

The following paragraphs describe the sequence of tests performed on A1A2 Encryption PWB Assembly during execution of an RT-1694(P) self-test routine.

5.6.3.2.1 Fault 81 - Communications Fault Test

This fault indicates the interface microprocessor cannot communicate with the Encryption microprocessor via the dual-port RAM.

5.6.3.2.2 Fault 82 - ROM Fault Test

This fault indicates that the internal additive checksum test for the ROM has failed.

5.6.3.2.3 Fault 83 - Internal RAM Fault Test

This fault indicates a problem within the encryption microprocessor.

5.6.3.2.4 Fault 84 - External RAM Fault Test

This fault indicates a problem with the external RAM.

5.6.3.2.5 Fault 85 - Dual-Port RAM Fault (Encryption Side) Test

This fault indicates a problem with dual-port RAM.

5.6.3.2.6 Fault 86 - Semaphore Register Fault (Encryption Side) Test

The semaphore registers are also part of the dual-port RAM. If this test fails, however. it means that the test for Fault 85 passed, limiting the possible causes of this fault.

5.6.3.2.7 Fault 87 - ACE Fault Test

This fault indicates that the microprocessor is unable to communicate with the Advanced Crypto Engine (ACE), or that the ACE is defective.

5.6.3.2.8 Fault 88 - HSS Register Fault Test

This fault indicates that the microprocessor is unable to communicate with the HSS, or that the HSS is defective.

5.6.3.2.9 Fault 89 - Encryption Loop Back Fault Test

This test encrypts and then decrypts an internally generated bit stream. A fault indicates a possible problem with several ICs on AIA2 Encryption PWB Assembly.

5.6.3.3 A3 LPC Vocoder Assembly BIT Sequence Description

The following paragraphs describe the sequence of tests performed on LPC Vocoder Assembly during execution of an RT-1694(P) self-test routine.

5.6.3.3.1 Fault 01 - 8751 Communications Fault Test

This fault indicates that the LPC microprocessor has lost communications with the HSSB.

5.6.3.3.2 Fault 02 - 8751 ROM Fault Test

This fault indicates that the ROM test has failed.

5.6.3.3.3 Fault 03 - 8751 Microprocessor Internal RAM Fault Test

This fault indicates a problem with the internal RAM.

5.6.3.3.4 Fault 05 - 8751 Dual-Port RAM Fault Test

This test indicates a problem with the 8751 dual-port RAM on A3 LPC Vocoder Assembly.

5.6.3.3.5 Fault 06 - 8751 Dual-Port RAM Busy Fault Test

This test indicates a problem with the 8751 dual-port RAM on A3 LPC Vocoder Assembly.

5.6.3.3.6 Fault 07 - 8751 Dual-Port RAM Interrupt Fault Test

This test indicates a problem with the 8751 dual-port RAM on A3 LPC Vocoder Assembly.

5.6.3.3.7 Fault 14 - Hop Clock Fault Test

This test verifies that there is a hop clock signal at A3 LPC Vocoder Assembly during BITE.

5.6.3.3.8 Fault 15 - Frame Clock Fault Test

This test verifies that there is a frame clock signal at A3 LPC Vocoder Assembly during BITE.

5.6.3.3.9 Fault 81 - TMS320 Internal RAM Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude.

5.6.3.3.10 Fault 82 - TMS320 External Program RAM Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude.

5.6.3.3.11 Fault 83 - TMS320 External Data RAM Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude

5.6.3.3.12 Fault 84 - TMS320 ROM Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude.

5.6.3.3.13 Fault 85 - TMS320 Dual-Port RAM Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude.

5.6.3.3.14 Fault 86 - Sample Clock Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude.

5.6.3.3.15 Fault 87 - TMS320 AIC Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude

5.6.3.3.16 Fault 88 - TMS320 DAC Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude

5.6.3.3.17 Fault F5 - 8751 Not Finished Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude.

5.6.3.3.18 Fault FA - TMS32O Not Finished Fault Test

This test indicates that A4 Signal Processor PWB Assembly is not waiting long enough for the LPC BITE test to conclude.

5.6.3.4 A4 Signal Processor PWB Assembly BIT Sequence Description

The following paragraph describe the sequence of tests performed on A4 Signal Processor PWB Assembly during execution of an RT- 1694(P) self-test routine.

5.6.3.4.1 Fault 01 - Communications Fault Test

This fault occurs when the FEC processor does not respond to the main controller via the internal High-Speed Serial Bus (HSSB).

5.6.3.4.2 Fault 14 - Hop Clock Error Test

The main controller is unable to detect a hop clock signal.

NOTE

It is possible that the A3 LPC Vocoder Assembly or the A11 Motherboard Assembly could be holding the Hop Clock Signal.

5.6.3.4.3 Fault 15 - Frame Clock Fault Test

This fault occurs when the main controller microprocessor is unable to detect a pulse on the FRAM_CLK line.

NOTE

It is possible that the A1A1 Interface PWB Assembly or the A3 LPC Vocoder Assembly is holding this line, causing this fault.

5.6.3.4.4 Fault 1F - FEC ROM Checksum Fault Test

'This fault indicates that the FEC microprocessor has detected a checksum error in its FLASH PROM.

5.6.3.4.5 Fault 20 - FEC External RAM Fault Test

The FEC microprocessor cannot write to and read back from all locations in its external RAM.

5.6.3.4.6 Fault 21 - FEC Dual-Port RAM Fault Test

The modem microprocessor cannot read to and read back from all locations of the dual-port RAM.

5.6.3.4.7 Fault 22 - 80C186 (U75) MDM Not Running Test

The modem microprocessor is unable to respond to commands from the main control microprocessor through the dualport RAM.

5.6.3.4.8 Fault 23 - FFT Handshake Fault Test

This fault indicates that one of the modem microprocessors cannot communicate with another modem microprocessor via the dual-port RAM.

5.6.3.4.9 Fault 24 - FFT to MDM Dual-Port RAM Fault Test

This fault indicates that one of the modem microprocessors cannot write to and read back from dual-port RAM.

5.6.3.4.10 Fault 25- MDM to FFT Dual-Port RAM Fault Test

This fault indicates that one of the modem microprocessors cannot write to and read back from dual-port RAM.

5.6.3.4.11 Fault 26 - MDM to FEC Dual-Port RAM Fault Test

This fault indicates that one of the modem microprocessors cannot write to and read from its side of dual-port RAM.

5.6.3.4.12 Fault 27 - MDM ROM Checksum Fault Test

This fault indicates that one of the modem microprocessors has detected a checksum fault in its EPROM.

5.6.3.4.13 Fault 28- MDM RAM Fault Test

This fault indicates that one of the modem microprocessors cannot read and write to every location in its RAM.

5.6.3.4.14 Fault 29 - Sample Clock Fault Test

This fault indicates that one of the modem microprocessors detected an incorrect sample clock rate.

5.6.3.4.15 Fault 2A - FFT ROM Checksum Test

This failure indicates that the one of the modem microprocessors has detected a checksum error in its EPROM.

5.6.3.4.16 Fault 2B - FFT Internal RAM Fault Test

This test indicates that one of the modem microprocessors is unable to read and write to all its internal RAM locations.

5.6.3.4.17 Fault 2C - FFT External RAM Fault Test

This fault indicates that one of the modem microprocessors is unable to write and read to every location in its external RAM space.

5.6.3.4.18 Fault 2D - FFT to DIF Dual-Port RAM Fault Test

This fault indicates that one of the modem microprocessors cannot write to and read from its side of the dual-port RAM.

5.6.3.4.19 Fault 2E - Hop Clock Error Test

The main controller is unable to detect a hop clock signal.

NOTE

It is possible that the A3 LPC Vocoder Assembly or the A11 Motherboard Assembly could be holding the Hop Clock Signal.

5.6.3.4.20 Fault 2F - FFT Self Test (Not Complete) Test

This fault indicates that one of the modem microprocessors did not reply after it was commanded to test its side of the dual-port RAM.

5.6.3.4.21 Fault 30 - FFT Self Test (Not Complete) Test

This fault indicates that one of the modem microprocessors did not reply after it was commanded to test its internal and external RAMS and its ROM.

5.6.3.4.22 Fault 32 - Digital IF Time Sample Transfer Test

This test transfers known data to the digital IF processor via two modem microprocessors and dual-port RAM.

5.6.3.4.23 Fault 33 - MDM Self Test (Not Complete) Test

This fault indicates that one of the modem microprocessors did not return from performing its self test after being commanded to perform its test.

5.6.3.4.24 Fault 34 - FEC Self Test (Not Complete) Test

This fault indicates that one of the modem microprocessors had not finished its self test when the main controller polled it for its test results.

5.6.3.4.25 Fault 42 - Non-Destructive Internal RAM Fault Test

This fault indicates that the internal RAM for the main controller is faulty.

5.6.3.4.26 Fault 43 - ROM Checksum Fault Test

The main controller detects a checksum error in its flash EPROM.

5.6.3.4.27 Fault 44 - Nondestructive External RAM Fault Test

This test indicates a faulty main controller RAM.

5.6.3.4.28 Fault 61 - AGC Communication Fault Test

This indicates that the main controller cannot communicate with the AGC processor over the HSSB.

5.6.3.4.29 Fault 62 - AGC Processor Internal RAM Test

This is a non-destructive test of the on-chip RAM of the microcontroller.

5.6.3.4.30 Fault 63 - AGC Checksum Fault Test

This test performs an additive checksum test on all bytes in the program storage ROM. If any locations are bad or incorrectly programmed, this fault will occur.

5.6.3.4.31 Fault 64 - AGC External RAM Fault Test

This is a nondestructive test that tests all of the external RAM on the microcontroller bus. If this fault code occurs, it is likely that the external RAM device being tested is bad. A faulty address or data line to the part may also be the problem.

5.6.3.4.32 Fault 67 - Digital IF Handshake Fault (Dual Port RAM) Test

This tests the interrupt generation of the AGC and IF processors. If this test fails, the IF processor is probably not running.

5.6.3.4.33 Fault 6B - Digital IF Did Not Complete BITE Test

The digital IF is a much faster processor than the 8OC5 I FA, and should have completed its test well before the AGC processor.

5.6.3.4.34 Fault 6C - Anti-alias Filter Test

This test checks the response of the active low pass filter. The IF processor generates a series of tones starting at 100 Hz and finishing at 16 kHz. The A/D converters perform a peak detect on the signal at the output of the filter, and this is compared to a table of acceptable limits. During a self test, this sweep generator can be heard in the handset. Failures in this test are most likely incorrect passive elements in the active filter circuit.

5.6.3.4.35 Fault 6D - 28.8-kHz Sample Clock Fault and Fault 6E - 24.0-kHz Sample Clock Fault Test

During this test. the IF processor simply measures the duty cycle and period of the sample clock using the 36-MHz processor clock as a reference. This is a crude test, but it functions as desired. It will not, however, detect a noisy sample clock that is the correct frequency. Both 24-kHz and 28.8-kHz clocks are checked.

5.6.3.4.36 Fault 74 - Frame Clock Not Detected Test

The main controller generates a frame clock pulse. and the AGC processor reports if the clock pulse was detected or not.

5.6.3.4.37 Fault 75 - Hop Clock Not Detected Test

This test is identical to the frame clock test, but a different hardware line is tested.

5.6.3.4.38 Fault 80 - Digital IF ROM Checksum Fault Test

This test checks the integrity of the digital IF ROM integrated circuit.

5.6.3.4.39 Fault 81 - Digital IF Internal RAM Fault Test

This test checks the integrity of the digital IF ROM integrated circuit.

5.6.3.4.40 Fault 82 - Digital IF External RAM Fault Test

This test is identical to the one the main controller performs, but it is performed on the digital IF's dedicated external RAM.

5.6.3.4.41 Fault 83 - Dual-Port RAM to AGC Fault Test

These tests are the same tests that are performed on external RAMs. Dual port RAMs are also external and are accessed in the same manner. Faults here may occur because the part is bad or a faulty address or data line to the pan may exist Also. any glue logic that is used to address or enable the part may be at fault.

5.6.3.4.42 Fault 84 - Dual-Port RAM to FF- Fault Test

This test is identical to the dual port RAM to AGC processor test, but it is performed on the 16-bit wide part that interfaces the IF processor to the FFT processor.

5.6.3.5 A5 Receiver/Exciter Assembly BIT Sequence Description

The following paragraphs describe the sequence of tests performed on A5 Receiver/Exciter Assembly during execution of an RT-1694(P) self-test routine.

5.6.3.5.1 Receiver Faults 01 through 04

Receiver BITE faults are determined by the digital and analog AGC control outputs.

5.6.3.5.2 Exciter Faults 0F through 12

Exciter gain faults are determined by the ATTEN CTRL line value measured by the software. Exciter output faults are determined by the level detectors placed on the Power Amplifier Assembly, after the A5 Receiver/Exciter Assembly output.

5.6.3.6 A6 Synthesizer Assembly BIT Sequence Description

The following paragraphs describe the sequence of tests performed on A6 Synthesizer Assembly during execution of an RT-1694(P) self-test routine.

5.6.3.6.1 Fault 12 - Combined Lock Detect Fault Test

This test verifies that the three Phase-Locked Loops (PLLs) on A6 Synthesizer Assembly are functioning properly. This test is performed after the serial data fault test.

5.6.3.6.2 Fault 20 - Serial EEPROM Data Read Fault Test

This test verifies that the main controller on A4 Signal Processor PWB Assembly was able to verify the checksum of the EEPROM on A6 Reference Generator Assembly.

5.6.3.7 A8 Power Amplifier/Battery Charger Assembly BIT Sequence Description

This assembly has a single BITE test, which is to attempt to transmit 5 watts of RF power into the BITE test load on the harmonic filter subassembly. If the RF is able to pass through each of the eight possible filter bands, the test passes.

5.6.3.8 A9 Antenna Coupler Assembly BIT Sequence Description

The following paragraphs describe the sequence of tests performed on A9 Antenna Coupler Assembly during execution of an RT-1694(P) self-test routine.

5.6.3.8.1 Fault 01 - Coupler Operational Fault Test

This fault occurs when the receiver-transmitter attempts to transmit 100 mW CW and fails to detect the presence of any modulated RF at the antenna coupler discriminator.

5.6.3.9 A10 Front Panel Assembly BIT Sequence Description

The following paragraphs describe the sequence of tests performed on A10 Front Panel Assembly during execution of an RT-1694(P) self-test routine.

5.6.3.9.1 Fault 02 - Microprocessor Internal RAM Fault Test

This fault occurs if the front panel microprocessor determines that its internal RAM is defective.

5.6.3.9.2 Fault 03 - ROM Fault Test

This fault occurs if the checksum calculated and recorded in the program ROM during factory programming does not match the checksum calculated by the microprocessor during self-test.

5.6.3.9.3 Fault 04 - External RAM Fault Test

During a check of external RAM, one or more bits are detected as being stuck as logic Os or logic Is. This may also be the result of open or shorted address, data, or control lines.

5.6.3.9.4 Fault 05 - LCD Fault Test

An LCD fault indicates that the microprocessor cannot communicate with the Liquid Crystal Display (LCD) board.

5.6.3.10 Self-Diagnostics Sequence Summary

The order of testing from the first to last test is shown in Table 5-6.

	Table 5-6.	Self-Diagnostics Sequence Summary
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Sequence	Fault Code
Communications Fault Test	A1 F01
Communications Fault Test	A4 F01
8751 Communications Fault Test	A3 F01
ROM Checksum Fault Test	A4 F43
Non-Destructive Internal RAM Fault Test	A4 F42
Non-Destructive External RAM Fault Test	A4 F44
Hop Clock Error Test	A4 F14
Combined Lock Detect Fault Test	A6 F12
Serial EEPROM Data Read Fault Test	A6 F20
ROM Fault Test	A1.F03
Microprocessor Internal RAM Fault Test	A1 F02
Semaphore Register Fault Test	A1 F10
Dual Port RAM Fault Test	A1 F11
RAM Fault Test	A1 F04
Asynchronous Data Channel Fault Test	A1 F05
Synchronous Data Channel Fault Test	A1 F06
Remote Communications Channel Fault Test	A1 F09
External PA DUART Counter Fault Test	A1 F0A
External PA Communications Channel Fault Test	A1 F0B
Real-Time Clock Fault Test	A1 F51
Real-Time Clock Internal RAM Fault Test	A1 F52
Real-Time Clock Rollover Registers Fault Test	A1 F55
Real-Time Clock Crystal Oscillator Fault Test	A1 F56
Encryption No Communication Fault Test	A1 F81
ROM Fault Test	A1 F82
Internal RAM Fault Test	A1 F83
External RAM Fault Test	A1 F84
Semaphore Register Fault Test (Encryption Side)	A1 F86
Dual-Port RAM Fault Test (Encryption Side)	A1 F85

Sequence	Fault Code
Advanced Crypto Engine (ACE) Fault Test	A1 F87
HSS Register Fault Test	A1 F88
Encryption loop Back Fault Test	A1F89
FEC Dual-Port RAM Fault Test	A4 F21
FEC ROM Checksum Fault Test	A4 F1F
FEC External RAM Fault Test	A4 F20
80C 186 Modem Not Running Test	A4 F22
FFT Handshake Fault Test	A4 F23
FFT to Modem Dual-Port RAM Fault Test	A4 F24
Modem to FFT Dual-Port RAM Fault Test	A4 F25
Modern to FEC Dual-Port RAM Fault Test	A4 F26
Modem ROM Checksum Fault Test	A4 F27
Modem RAM Fault Test	A4 F28
Sample Clock Fault Test	A4 F29
FFT ROM Checksum Test	A4 F2A
FFT Internal RAM Fault Test	A4 F2B
FFT External RAM Fault Test	A4 F2C
FFT to DIF Dual-Port RAM Fault Test	A4 F2D
FFT Self Test Not Complete Fault Test	A4 F2F
FFT Self Test Not Complete Fault Test	A4 F30
Modem Self Test Not Complete Test	A4 F33
FEC Self Test Not Complete Test	A4 F34
8751 ROM Fault Test	A3 F02
8751 Microprocessor Internal RAM Fault Test	A3 F03
8751 Dual-Port RAM Fault Test	A3 F05
8751 Dual-Port RAM Busy Fault Test	A3 F06
8751 Dual-Port RAM Interrupt Fault Test	A3 F07
TMS320 Not Finished Fault Test	A3 FA
TMS320 Internal RAM Fault Test	A3 F81
TMS320 ROM Fault Test	A3 F84
TMS320 External Program RAM Fault Test	A3 F82

Table 5-6. Self-Diagnostics Sequence Summary - Continued	Table 5-6.	Self-Diagnostics Sequence Summary - Continued
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Sequence	Fault Code	
TMS320 External Data RAM Fault Test	A3 F83	
TMS320 Dual-Port RAM Fault Test	A3 F85	
Sample Clock Fault Test	A3 F86	
TMS320 AIC Fault Test	A3 F87	
TMS320 DAC Fault Test	A3 F88	
8751 Not Finished Fault Test	A3 F5	
AGC Communication Fault Test	A4 F61	
AGC Checksum Fault Test	A4 F63	
AGC Processor Internal RAM Test	A4 F62	
AGC External RAM Fault Test	A4 F64	
Digital IF ROM Checksum Fault Test	A4 F80	
Digital IF Internal RAM Fault Test	A4 F81	
Digital IF External RAM Fault Test	A4 F82	
Dual-Port RAM to AGC Fault Test	A4 F83	
Dual-Port RAM to FFT Fault Test	A4 F84	
Digital IF Did Not Complete BITE Test	A4 F6B	
Digital IF Handshake Fault Test	A4 F67	
29.8 kHz Sample Clock Fault Test	A4 F6D	
24.0 kHz Sample Clock Fault Test	A4 F6E	
Anti-Alias Filter Test	A4 F6C	
Digital IF Time Sample Transfer Test	A4 F32	
Hop Clock Not Detected Test	A4 F75	
Hop Clock Error Test	A4 F2E	
Hop Clock Fault Test	A3 F14	
Frame Clock Fault Test	A4 F15	
Frame Clock Fault Test	A01 F0F	
Frame Clock Not Detected Test	A4 F74	
Frame Clock Fault Test	A3 F15	
LCD Fault Test	A10 F05	
ROM Fault Test	A10 F03	
External RAM Fault Test	A10 F04	

Table 5-6	Self-Diagnostics	Sequence	Summary -	Continued
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Table 5-6. Self-Diagnostics Sequence Summary - Continued

Sequence	Fault Code	
Microprocessor Internal RAM Fault Test	A10F02	
Digital and Analog AGC Control Output Fault Tests	A5 F01 - F04	
Exciter Gain Faults and Exciter Output Fault Tests	AS F0F - F12	
Filter Band Fault Tests	A8 F00 - FFF	
Coupler Operational Fault Test	A9 F01	

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CHAPTER 6

CORRECTIVE MAINTENANCE

6.1 INTRODUCTION

Paragraph 6.2 provides the alignment and adjustment procedures for each Shop Replaceable Unit (SRU) in the RT-1694(P) Receiver-Transmitter [RT-1694(P)]. Paragraph 6.3 provides the procedures for removing and replacing the SRUs. The procedures in both paragraphs arm arranged in order of the SRU reference designators. These SRUs are listed in Table 6-1, with a reference to the corresponding removal and replacement procedure paragraph.

6.1.1 Master Tools and Materials List

Table 6-2 lists the tools, test equipment, and materials required for the procedures in this chapter. Column 1, Item, gives the item number which is referenced in parentheses next to the tool name in each procedure.

Table 6-1. SRU. and Removal and Replacement Paragraph References

SRU Name	Paragraph Reference
A1A1 Interface PWB Assembly	6.5.3
A1A2 Encryption PWB Assembly	6.5.3
A3 LPC .Vocoder Assembly	6.5.4
A4 Signal Processor PWB Assembly	6.5.5
A5 Receiver/Exciter Assembly	6.5.6
A6 Synthesizer Assembly	6.5.7
A7 Power Supply Assembly	6.5.8
A8 Power Amplifier/Battery Charger Assembly	6.5.9
A9 Antenna Coupler Assembly	6.5.10
A10 Front Panel Assembly	6.5.11
A11 Motherboard Assembly	6.5.12
W1 Coaxial Cable Assembly	6.5.13
W2 Coaxial Cable Assembly	6.5.14

Item	Description	Part Number	Cage Code
1	Screwdriver, No.0 cross-tip	X-100	96508
2	Screwdriver, No.1 cross-tip	X-101	96508
3	Screwdriver, No. 2 cross-tip	X-102	96508
4	Hex Screwdriver Bit, 5, 32 inch	9925	96508
5	Jewelers Pliers, 4 inch	LN54	19915
6	Socket Wrench, 3/16 inch	996	96508
7	Screwdriver Handle	99-1	96508
8	Ground Strap	3M-2064	20999
9	ESD Mat	1872	20999

Table 6-2. Master Tools and Materials List

6.2 ADJUSTMENTS AND ALIGNMENTS

6.2.1 General

The RT- 1694(P) requires no Level III adjustments or alignments.

6.3 REMOVAL AND REPLACEMENT PROCEDURES

The following paragraphs contain the repair procedures which consist of removing and replacing all SRUs authorized for Level III maintenance. SRUs consist of assemblies, PWBs, and cables.

6.3.1 Safety

Remove power from the radio system before starting any repairs.

WARNING

Voltages hazardous to human life are present if power is not removed from the unit. Failure to remove power from the unit can cause injury or death to personnel.

6.3.2 Level III Repair

Repairs are made by removing and replacing the assemblies listed in Table 6-1. Repairs are also made by removing and replacing damaged cables, listed in Table 6-3.

CAUTION



Some of the assemblies in the receiver-transmitter can be damaged by static discharge. Failure to take the proper precautions may damage these assemblies. Use a ground strap (Item 8) and an ESD Mat (Item 9) whenever removing or replacing these assemblies. For more information, refer to the Safety Summary at the beginning of this manual.

6.3.3 Attaching Hardware

Table 7-3 lists the attaching hardware that is removed and replaced while performing the procedures in this chapter. Column 1, Letter Code, gives the letter which is referenced in parentheses next to the attaching hardware in each procedure.

6.3.4 Repair Tips

When an assembly is removed from the unit, non-captive hardware should be stored at the time of disassembly. Re-use this hardware when installing the assembly into the unit.

Also label all cable assemblies that are removed from the unit. This will aid in identifying the correct cables during assembly of the unit.

6.3.5 Tools

Use only the proper tools when performing maintenance tasks on the unit. Refer to Table 6-2. An incorrect size screwdriver or wrench can damage hardware.

CAUTIONS

Failure to use the correct tool can damage hardware.

6.3.6 Wires, Cables, and Connectors

Use the unit replacement illustrations to locate the cable connections if necessary. Table 6-3 describes the cables by reference designation, part number, description, cable connectors, and unit connection points.

CAUTION'

When removing or replacing wires, cables, or connectors, avoid sharp bends in any cable. Do not allow the cable to be pinched when reinstalling an assembly. When removing a ribbon connector, pull straight up to avoid bending the pins. Do not remove a connection by grabbing the cable; grab the connector instead. Do not force the cable when reinstalling it; this could damage the connector pins.

Table 6-3. Receiver-Transmitter Cable Information

Ref. Desig.	Part Number	Description	Cable Connector	Connection
P/O A5	10303-2600	Coaxial Cable Subassembly	A5A2P8	W2P2
P/O A6	10303-2700	Coaxial Cable Subassembly	A6A2W1J1	A5A2J2
W1	10372-1037-01 (PA-Coupler)	RF Coaxial Cable Assembly P2	P1 A9A1J2	A8A2J3
W2	10372-1053-01 (PA-Receiver/Exciter)	RF Coaxial Cable Assembly P2	P1 A5A2P8	A8A1J2

6.4 UNIT REMOVAL AND REPLACEMENT PROCEDURES

6.4.1 General

This section contains information needed to remove and replace the receiver-transmitter from a radio system.

6.4.2 Removing and Applying AC Input Power

AC input power must be removed before performing any unit replacement procedure.

6.4.2.1 Removing AC Input Power

If the receiver-transmitter is installed in a base station configuration, perform the following procedure to remove AC input power:

WARNING

Voltages hazardous to human life are present if power is not removed from the radio system. Failure to remove power from the radio system can cause injury or death to personnel.

- a. Turn the power switches on the individual units making up the RF-500 Falcons Manpack Radio System to the OFF position.
- b. If AC power comes from a panel with circuit breaker switches, turn the circuit breaker powering the radio system to the OFF position.

6.4.2.2 Applying AC Input Power

This procedure assumes that AC power was removed per Paragraph 6.4.2.1. Perform the following procedure to apply AC input power

WARNING

Voltages hazardous to human life are present when power is applied to the radio system. This power can cause injury or death to personnel.

- a. At the circuit breaker panel, turn the circuit breaker powering the radio system to the ON position.
- b. Turn the power switches on the individual units making up the radio system to the ON position.

6.4.3 Receiver-Transmitter Removal and Replacement

Procedures for removal and replacement of the receiver-transmitter vary, depending on the installation configuration. For information on how to remove and replace the RT-1694(P) from the rest of the radio system, refer to Chapter 8, Installation. Also refer to the RF-5200 Falcon T Series Manpack System manual (10515 00064200).

6.5 SHOP REPLACEABLE UNIT (SRU) REMOVAL AND REPLACEMENT PROCEDURES

The following procedures contain information needed to remove and replace shop replaceable units (SRUs) in the receiver-transmitter. See Figure 6-1.

6-5/6-6

6.5.1 Radio Case and Gasket Assembly Removal and Replacement

The following paragraphs provide instructions to remove and install MP2 Radio Case and Gasket Assembly. See Figure 6-2.

WARNING

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

6.5.1.1 MP2 Radio Case and Gasket Assembly Removal

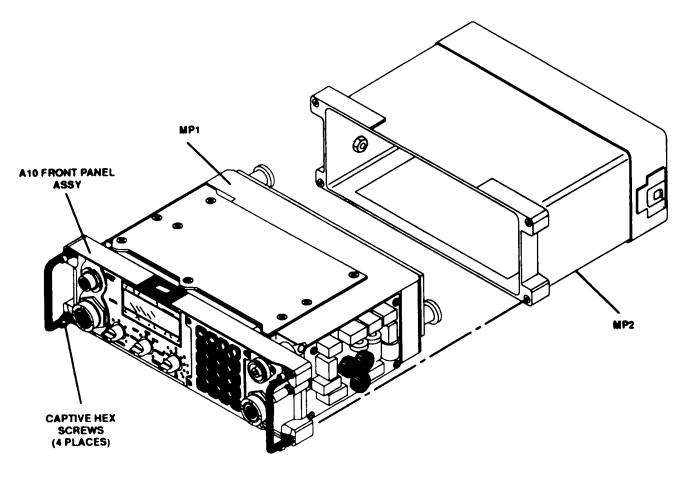
Perform the following procedure to remove MP2 Radio Case and Gasket Assembly from receiver-transmitter chassis:

- a Use a hex screwdriver (Items 4 and 7) to loosen four (4) captive hex screws that secure MP2 Radio Case and Gasket Assembly to AI0 Front Panel Assembly.
- b. Slide MP2 Radio Case and Gasket Assembly away from A10 Front Panel Assembly and off of MPI chassis.

6.5.1.2 MP2 Radio Case and Gasket Assembly Replacement

Perform the following procedure to install MP2 Radio Case and Gasket Assembly onto the receiver-transmitter chassis:

- a. Position the MP1 chassis up and orient the case with the word "TOP" facing up.
- b. Side MP2 Radio Case and Gasket Assembly onto MP1 chassis.
- c. Use a hex screwdriver (items 4 and 7) to tighten four (4) captive hex screws that secure MP2 Radio Case and Gasket Assembly to A10 Front Panel Assembly.



1694-008A

Figure 6-2. MP2 Radio Case and Gasket Assembly Removal and Replacement

6.5.2 MP3 PWB Compartment Cover Assembly Removal and Replacement

The following paragraphs provide instructions to remove and install MP3 PWB Compartment Cover Assembly. See Figure 6-3.

WARNING

To prevent electrical shock and RF bums, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

6.5.2.1 MP3 PWB Compartment Cover Assembly Removal

Perform the following procedure to remove MP3 PWB Compartment Cover Assembly from the receiver-transmitter chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Use a cross-tip screwdriver (Item 2) to loosen eight (8) captive screws that secure MP3 PWB Compartment Cover Assembly to MP1 chassis.
- c. Remove MP3 PWB Compartment Cover Assembly from MPI chassis.

6.5.2.2 MP3 PWB Compartment Cover Assembly Replacement

Perform the following procedure to install MN PWB Compartment Cover Assembly onto the receiver-transmitter chassis:

- a. Position MP3 PWB Compartment Cover Assembly onto MP1 chassis.
- b. Use a cross-tip screwdriver (Item 2) to tighten eight (8) captive screws that secure MP3 PWB Compartment Cover Assembly to MP1 chassis.
- c. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

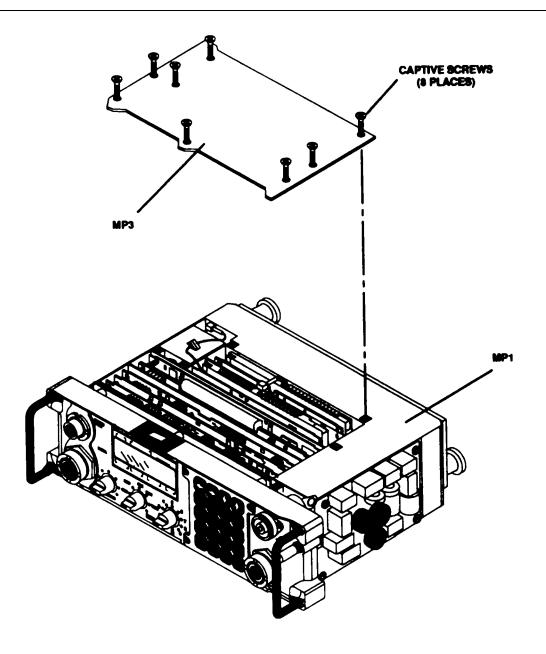


Figure 6-3. MP3 PWB Compartment Cover Removal and Replacement

6.5.3 A1A1 Interface and A1A2 Encryption PWB Assembly Removal and Replacement

Flee following paragraphs provide instructions for the removal and installation of A1A1 Interface PWB Assembly and A1A2 Encryption PWB Assembly (if installed) from the RT-1694(P). See Figure 6-4.

WARNING

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and placing assemblies.

CAUTIONS



Some components on A1A1 Interface PWB Assembly and A1A2 Encryption PWB Assembly can be damaged by static discharge. Failure to take the proper precautions may damage these assemblies. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.3.1 A1A1 Interlace and A1A2 Encryption PWB Assembly Removal

Perform the following procedure to remove A1A1 Interface PWB Assembly and A1A2 Encryption PWB Assembly (if installed) from the RT-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2. 1.
- c. Remove A1A1 and A1A2 assemblies from MPI chassis by grasping the green cord between the assemblies and pulling upward.

NOTE

There is no green cord in units that do not have an A1A2 Encryption PWB Assembly installed. For these units, grasp A1A1 assembly and pull upward.

- d. If A1A2 assembly is installed, use a cross-tip screwdriver (Item 1) to remove four (4) screws (D), lock washers (E), and flat washers (H) securing A1A2 assembly to A1A1 assembly.
- e. If A1A2 assembly is installed, separate AIAI assembly from A1A2 assembly by pulling the two PWBs apart.

6.5.3.2 A1A1 Interface and A1A2 Encryption PWB Assembly Replacement

Perform the following procedure to install A1A1 Interface PWB Assembly and A1A2 Encryption PWB Assembly (if pan of this radio's configuration) into the RT-1694(P) chassis:

a. If A1A2 assembly is part of this radio's configuration, connect A1A1 assembly to A1A2 assembly by aligning A1A1J2 with A1A2P2 and pushing the assemblies together.

NOTE

Ensure that the green cord is positioned on the A1A2 standoffs before pushing the assemblies together.

- b. If A1A2 assembly is part of this radio's configuration, use a cross-tip screwdriver (Item 1) to install four (4) screws (D). lock washers (E), and flat washers (H) securing A1A2 assembly to A1A1 assembly.
- c. Slide A1A1 and A1A2 assemblies into the empty slot in MP1 chassis and push downward.
- d. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- c. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

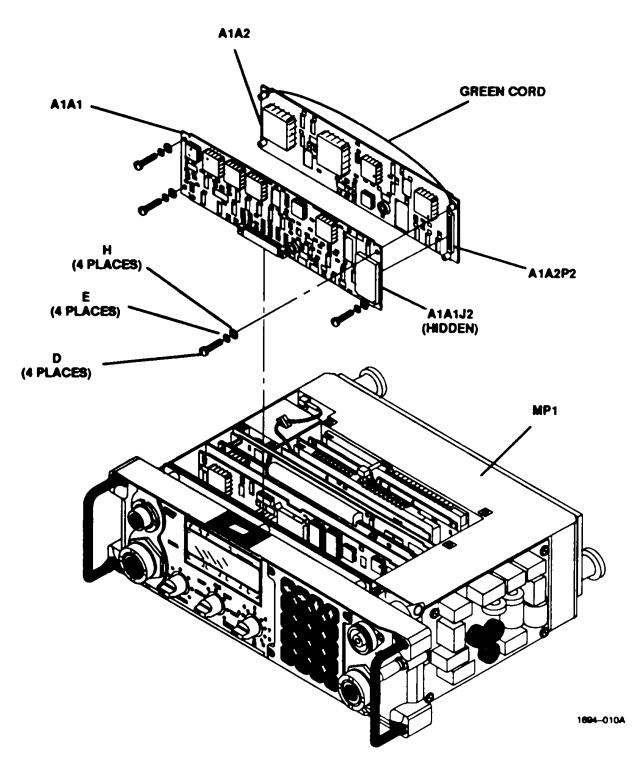


Figure 6-4. A1A1 Interface PWB Assembly and A1A2 Encryption PWB Assembly Connector and Hardware Locations

6.5.4 A3 LPC Vocoder Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of A3 LPC Vocoder Assembly from the RT-1694(P). See Figure 6-5.

WARNING

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A3 LPC Vocoder Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.4.1 A3 LPC Vocoder Assembly Removal

Perform the following procedure to remove A3 LPC Vocoder Assembly from the RT-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Remove A3 LPC Vocoder Assembly from MP1 chassis by grasping the green cord and pulling upward.

6.5.4.2 A3 LPC Vocoder Assembly Replacement

Perform the following procedure to install A3 LPC Vocoder Assembly into the RT-1694(P) chassis:

- a. Slide A3 LPC Vocoder Assembly into the empty slot in MP1 chassis and push downward.
- b. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- c. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

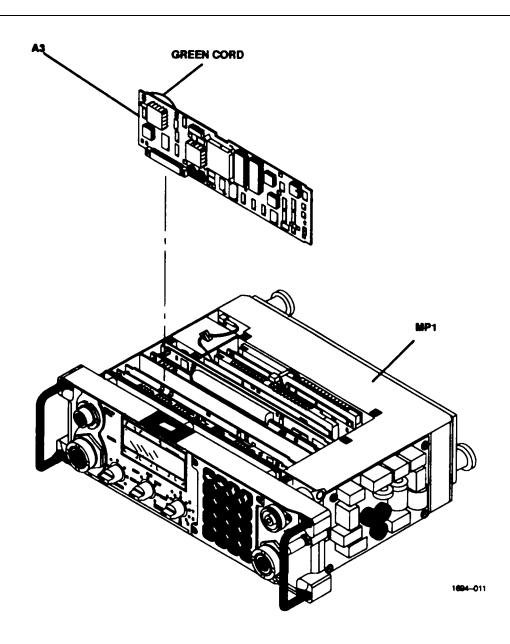


Figure 6-5. A3 LPC Vocoder Assembly Connector and Hardware Locations

6.5.5 A4 Signal Processor PWB Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of the A4 Signal Processor PWB Assembly from the RT-1694(P). See Figure 6-6.

WARNING

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A4 Signal Processor PWB Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.5.1 A4 Signal Processor PWB Assembly Removal

Perform the following procedure to remove the A4 Signal Processor PWB Assembly from the RT-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Remove A4 Signal Processor PWB Assembly from MPI chassis by grasping the green cord and pulling upward.

6.5.5.2 A4 Signal Processor PWB Assembly Replacement

Perform the following procedure to install the A4 Signal Processor PWB Assembly into the RT-1694(P) chassis.

- a. Slide A4 Signal Processor PWB Assembly into the empty slot in MPI chassis and push downward.
- b. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- c. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

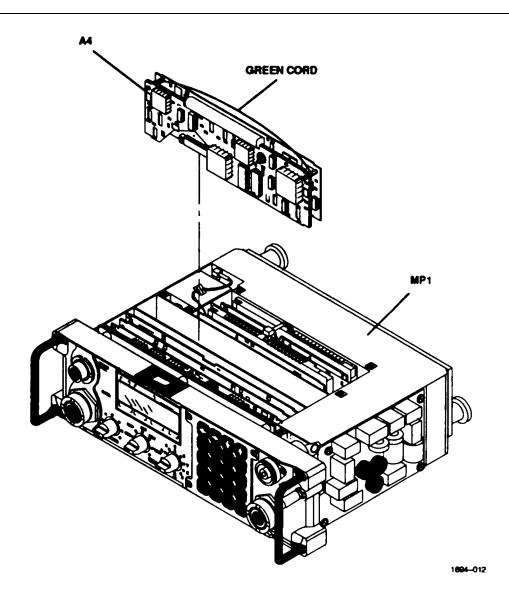


Figure 6-6. A4 Signal Processor PWB Assembly Connector and Hardware Locations

6.5.6 A5 Receiver/Exciter Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of A5 Receiver/Exciter Assembly from the RT-1694(P). Sec Figure 6-7.

WARNINGS

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A5 Receiver/Exciter Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For mom information, refer to the Safety Summary at the beginning of this manual.

6.5.6.1 AS Receiver/Exciter Assembly Removal

Perform the following procedure to remove AS Receiver/Exciter Assembly from the RT- 1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5. 1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Remove ASA2P8 coaxial cable from under MP30 spring finger strip.
- d. Use needle-nose pliers (Item 5) to disconnect A5A2P8 coaxial cable from W2P2 connector.
- e. Use needle-nose pliers (Item 5) to disconnect A6A2W1J1 coaxial cable from A5A2J2 connector.
- f. Remove A5 Receiver/Exciter Assembly from MP1 chassis by grasping the green cord and pulling upward.

6.5.6.2 A5 Receiver/Exciter Assembly Replacement

Perform the following procedure to install A5 Receiver/Exciter Assembly into the RT-1694(P) chassis:

- a. Slide AS Receiver/Exciter Assembly into the empty slot in MPI chassis and push downward.
- b. Connect ASA2P8 coaxial cable to W2P2 connector.
- c. Position ASA2Pg coaxial cable under MP30 spring finger strip.
- d Connect A6A2W1J1 coaxial cable to A5A2J2 connector.
- e Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- f Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

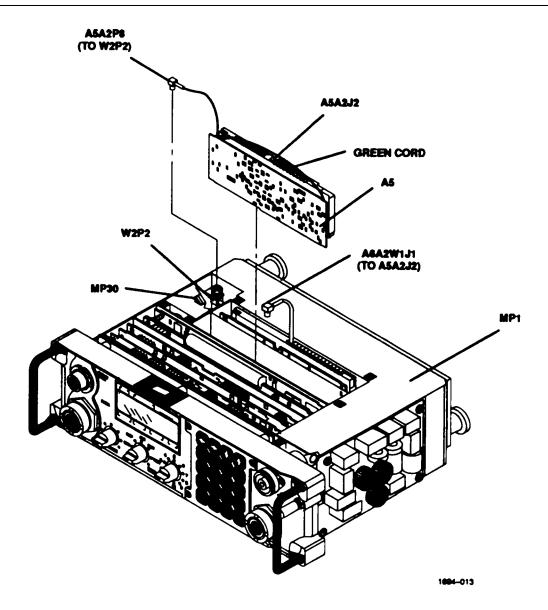


Figure 6-7. As Receiver/Exciter Assembly Connector and Hardware Locations

6.5.7 A6 Synthesizer Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of the A6 Synthesizer Assembly from the RT-1694(P). Sec Figure 6-8.

WARNING

To prevent electrical shock and RF bums, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION'



Some components on A6 Synthesizer Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.7.1 A6 Synthesizer Assembly Removal

Perform the following procedure to remove A6 Synthesizer Assembly from the RT-1694(P) chassis:

- a. Remove MF2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Use needle-nose pliers (Item 5) to disconnect A6A2W1J1 coaxial cable from A5A2J2 connector.
- d. Remove A6 Synthesizer Assembly from MPI chassis by grasping the green cord and pulling upward.
- e. Remove MP26 Rubber Pad from MP1 chassis.

6.5.7.2 A6 Synthesizer Assembly Replacement

Perform the following procedure to install A6 Synthesizer Assembly into the RT-1694(P) chassis:

- a. Slide A6 Synthesizer Assembly into the empty slot in MPI chassis and push downward.
- b. Slide MP26 Rubber Pad between MPI chassis and A6 assembly.
- c. Connect A6A2W1J1 coaxial cable to A5A2J2 connector.
- d Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- c Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

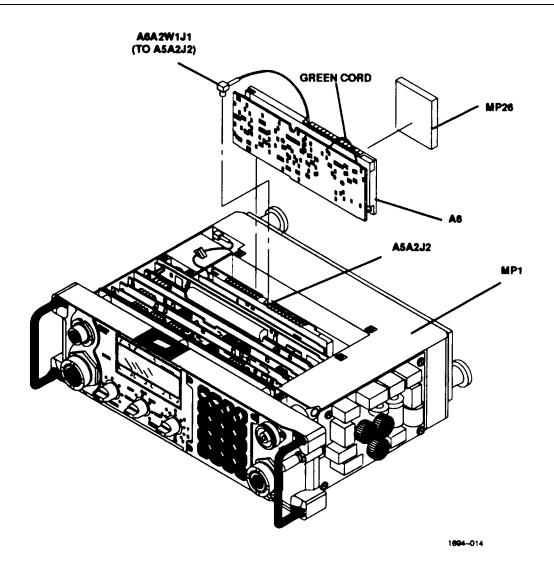


Figure 6-8. A6 Synthesizer Assembly Connector and Hardware Locations

6.5.8 A7 Power Supply Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of the A7 Power Supply Assembly from the RT-1694(P). See Figure 6-9.

WARNINGS

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A7 Power Supply Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.8.1 A7 Power Supply Assembly Removal

Perform the following procedure to remove the A7 Power Supply Assembly from the RT-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Remove ASA2P8 coaxial cable from under MP30 spring finger strip. Position A5A2P8 cable so that it is not blocking A7 Power Supply Assembly.
- d. From bottom of MPI chassis, use a cross-tip screwdriver (Item 1) to remove three (3) screws (D), lock washers (E), and flat washers (H) that secure A7 Power Supply Assembly to the All PWB Assembly.
- c. Remove A7 Power Supply Assembly from MPI chassis by grasping the assembly and pulling upward.

6.5.8.2 A7 Power Supply Assembly Replacement

Perform the following procedure to install the A7 Power Supply Assembly into the RT-1694(P) chassis:

- a. Slide A7 Power Supply Assembly into the empty slot in MP1 chassis and push downward to seat the connector to the A 11 PWB Assembly.
- b. From bottom of MPI chassis, use a cross-tip screwdriver (Item 1) to replace three (3) screws (D), lock washers (E), and flat washers (H) that secure A7 Power Supply Assembly to MP1 chassis.
- c. Replace A5A2Pg coaxial cable under MP30 spring finger strip.
- d. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- c. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

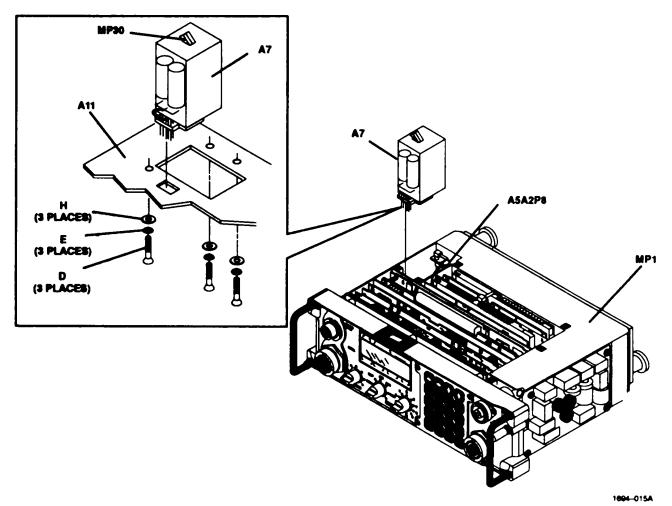


Figure 6-9. A7 Power Supply Assembly Connector and Hardware Locations

6.5.9 A8 Power Amplifier/Battery Charger Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of A8 Power Amplifier/Battery Charger Assembly from the RT-1694(P). Sec Figure 6-10.

WARNING

To prevent electrical shock and RF bums, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A8 Power Amplifier/Battery Charger Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.9.1 A8 Power Amplifier/Battery Charger Assembly Removal

Perform the following procedure to remove A8 Power Amplifier/Battery Charger Assembly from the 1a-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Disconnect ribbon cable A11P1 from A8A1P1.
- d. Disconnect coaxial cable W1P1 from A8A2J3.
- e. Use a cross-tip screwdriver (Item 2) to loosen four (4) captive screws that secure A8 Power Amplifier/Battery Charger Assembly to MP1 chassis.
- f. Pull AX assembly away from MP1 chassis.

CAUTION

Do not overextend W2 Coaxial Cable Assembly.

- g. Disconnect coaxial cable W2P1 from A8A1J2.
- h. Remove A8 assembly from MP1 chassis.

6.5.9.2 A8 Power Amplifier/Battery Charger Assembly Replacement

Perform the following procedure to install the A8 Power Amplifier/Battery Charger Assembly into the RT-1694(P) chassis:

- a. Position A8 assembly near MP1 chassis.
- b. Connect coaxial cable W2P1 to A8A1J2.
- c. Use a cross-tip screwdriver (Item 2) to tighten four (4) captive screws that secure A8 Power Amplifier/Battery Charger Assembly to MP1 chassis.
- d. Connect ribbon cable A11P1 to A8A1P1.
- e. Connect coaxial cable W1P1 to A8A2J3.
- f. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- g. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

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6.5.10 A9 Antenna Coupler Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of A9 Antenna Coupler Assembly from the RT-1694(P). See Figure 6-11.

WARNING

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A9 Antenna Coupler Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.10.1 A9 Antenna Coupler Assembly Removal

Perform the following procedure to remove A9 Antenna Coupler Assembly from the RT-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Disconnect ribbon cable A11P2 from A9A1P1.
- d. Disconnect coaxial cable W1P2 from A9A1J2.
- e. Use a cross-tip screwdriver (Item 2) to loosen and remove the screw (P), lock washer (Q) and flat washer (R) that secures the antenna connecting lug from the antenna connector to the A9 Antenna Coupler Assembly.
- f. Use a cross-tip screwdriver (Item 3) to loosen and remove the two screws (A) used to secure the right side of the Front Panel Assembly A10 to chassis MP1.
- g. Use a cross-tip screwdriver (Item 2) to loosen four (4) captive screws that secure A9 assembly to MPI chassis.
- h. Pull the right side of the front panel away from the chassis, so the antenna connecting lug clears the A9 assembly and remove A9 assembly from MP1 chassis.

6.5.10.2 A9 Antenna Coupler Assembly Replacement

Perform the following procedure to install A9 Antenna Coupler Assembly into the RT-1694(P) chassis:

a. Position A9 assembly into position against MPI chassis.

NOTE

Make sure the A9 assembly is positioned behind the antenna connecting lug from the front panel antenna connector.

- b. Use a cross-tip screwdriver (Item 2) to tighten four (4) captive screws that secure A9 assembly to MP1 chassis.
- c. Use a cross-tip screwdriver (Item 2) to install and tighten the screw (P), lock washer (Q) and flat washer (R) that secures the antenna connecting lug from the antenna connector to the A9 Antenna Coupler Assembly.
- d. Connect ribbon cable A11P2 to A9A1P1.
- e. Connect coaxial cable W1P2 to A9A1J2.
- f. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- g. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

6.5.11 A10 Front Panel Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of A 10 Front Panel Assembly from the RT-1694(P). See Figure 6-12.

WARNING

To prevent electrical shock and RF bums, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A10 Front Panel Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.11.1 A10 Front Panel Assembly Removal

Perform the following procedure to remove A10 Front Panel Assembly from the RT-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Disconnect ribbon cable A11P5 from A10A1J5.
- c. Disconnect ribbon cable A11P7 from A10A1J7.
- d. Use a cross-tip screwdriver (Item 2) to loosen and remove the screw (P), lock washer (Q) and flat washer (R) that secures the antenna connecting lug from the antenna connector to the A9 Antenna Coupler Assembly.
- e. Use a cross-tip screwdriver (Item 3) to remove four (4) screws (A) that secure A10 assembly to MP1 chassis.
- f. Remove A10 assembly from MP1 chassis.

6.5.11.2 A10 Front Panel Assembly Replacement

Perform the following procedure to install A10 Front Panel Assembly onto the RT-1694(P) chassis:

a. Position A10 assembly against MP1 chassis.

NOTE

Make sure the antenna connecting lug from the front panel antenna connector is positioned over the related hardware mounting hole in the A9 assembly.

- b. Use a cross-tip screwdriver (Item 3) to install four (4) screws (A) that secure A10 assembly to MPI chassis.
- c. Use a cross-tip screwdriver (Item 2) to install and tighten the screw (P), lock washer (Q) and flat washer (R) that secures the antenna connecting lug from the antenna connector to the A9 Antenna Coupler Assembly.
- d. Connect ribbon cable A11PS to A10A1J5.
- e. Connect ribbon cable A11P7 to A10A1J7.
- f. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

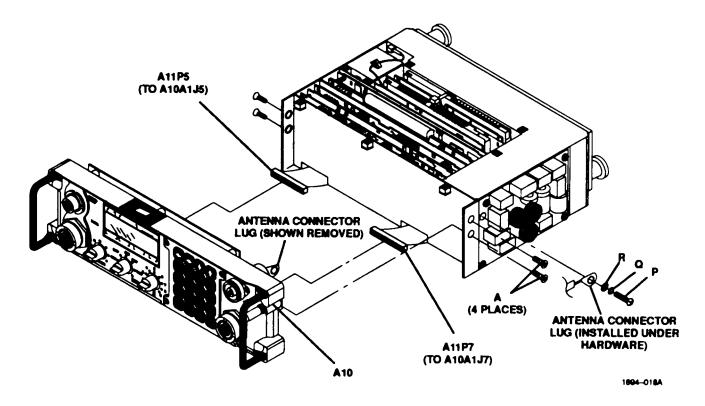


Figure 6-12. A10 Front Panel Assembly Connector and Hardware Locations

6.5.12 All Motherboard Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of A11 Motherboard Assembly from the RT-1694(P). See Figure 6-13.

WARNING

To prevent electrical shock and RF burns, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

CAUTION



Some components on A11 Motherboard Assembly can be damaged by static discharge. Failure to take the proper precautions may damage the assembly. For more information, refer to the Safety Summary at the beginning of this manual.

6.5.12.1 All Motherboard Assembly Removal

Perform the following procedure to remove A11 Motherboard Assembly from the RT-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MF3 PWB Compartment Cover Assembly. Refer to Paragraph 6.52.1.
- c. Remove A1A1 Interface PWB Assembly and A1A2 Interface PWB Assembly (if installed) from MP1 chassis. Refer to Paragraph 6.5.3.1.
- d. Remove A3 LPC Vocoder Assembly (if installed) from MP1 chassis. Refer to Paragraph 6.5.4.1.
- e. Remove A4 Signal Processor PWB Assembly from MP1 chassis. Refer to Paragraph 6.5.5.1.
- f. Remove A5 Receiver/Exciter Assembly from MP1 chassis. Refer to Paragraph 6.5.6.1.
- g. Remove A6 Synthesizer Assembly from MP1 chassis. Refer to Paragraph 6.5.7.1.
- h. Remove A7 Power Supply Assembly from MP1 chassis. Refer to Paragraph 6.5.8.1.
- i. Remove W1 Coaxial Cable Assembly. Refer to Paragraph 6.5.13.1.
- j. Disconnect ribbon cable A11P1 from A8A1P1.
- k. Disconnect ribbon cable A11P2 from A9A1P1.
- I. Disconnect ribbon cable A 11P7 from A10A1J7.
- m. Disconnect ribbon cable A11P5 from A10A1J5.

- n. Use a socket wrench and handle (Items 6 and 7) to remove five (5) hex spacers (C) and flat washers (F) that secure A11 assembly to MP1 chassis.
- o. Remove All assembly from MP1 chassis.

6.5.12.2 A11 Motherboard Assembly Replacement

Perform the following procedure to install A11 Motherboard Assembly into the RT-1694(P) chassis:

- a. Position A11 assembly into MP1 chassis.
- b. Use a socket wrench and handle (Items 6 and 7) to install five (5) hex spacers (C) and flat washers (F) that secure A11 assembly to MP1 chassis.
- c. Connect ribbon cable A11P1 to MP1 A8A1P1.
- d. Connect ribbon cable A11P2 to A9A1P1.
- e. Connect ribbon cable A11P7 to A10A1J7.
- f. Connect ribbon cable A11P5 to A10A1J5.
- g. Install W1 Coaxial Cable Assembly. Refer to Paragraph 6.5.13.2.
- h. Install A1A1 Interface PWB Assembly and A1A2 Interface PWB Assembly (if part of the receiver-transmitter configuration) into MP1 chassis. Refer to Paragraph 6.5.3.2.
- i. Install A3 LPC Vocoder Assembly (if part of the receiver-transmitter configuration) into MP1 chassis. Refer to Paragraph 6.5.4.2.
- j. Install A4 Signal Processor PWB Assembly into MP1 chassis. Refer to Paragraph 6.5.5.2.
- k. Install A5 Receiver/Exciter Assembly into MP1 chassis. Refer to Paragraph 6.5.6.2.
- I. Install A6 Synthesizer Assembly into MP1 chassis. Refer to Paragraph 6.5.7.2.
- m. Install A7 Power Supply Assembly into MP1 chassis. Refer to Paragraph 6.5.8.2.
- n. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- o. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

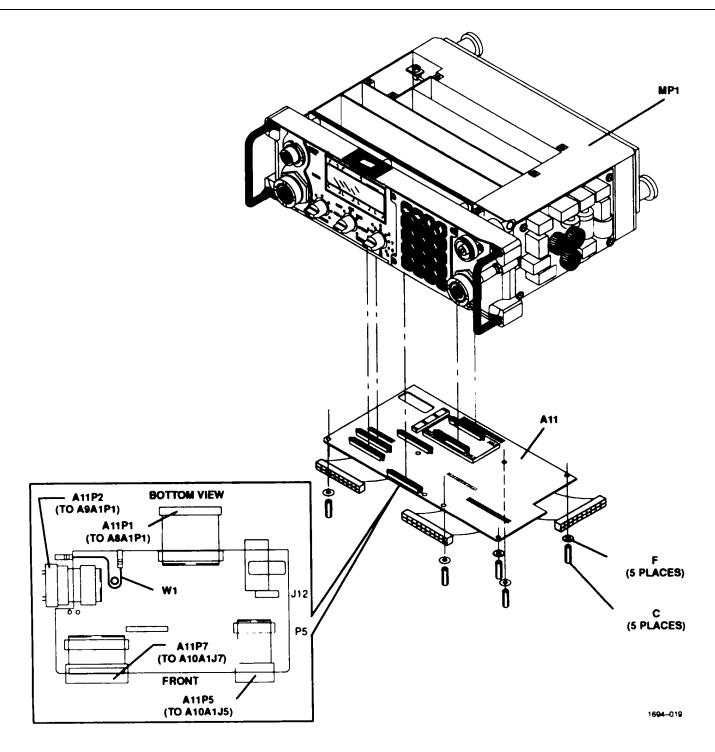


Figure 6-13. A11 Motherboard Assembly Hardware and Connector Locations

6.5.13 W1 Coaxial Cable Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of WI Coaxial Cable Assembly from the RT-1694(P) chassis. See Figure 6-14.

WARNING

To prevent electrical shock and RF bums, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

6.5.13.1 W1 Coaxial Cable Assembly Removal

Perform the following procedure to remove WI Coaxial Cable Assembly from the Kr-1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Disconnect W1P1 from A8A2J3.
- c. Disconnect W1P2 from A9A1J2.
- d. Remove W1 assembly from MP1 chassis.

6.5.13.2 W1 Coaxial Cable Assembly Replacement

Perform the following procedure to install W1 Coaxial Cable Assembly into the RT-1694(P) chassis:

- a. Position W1 assembly into MP1 chassis, dressing cable around standoff.
- b. Connect W1P1 to A8A2J3.
- c. Connect W1P2 to A9A1J2.
- d. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

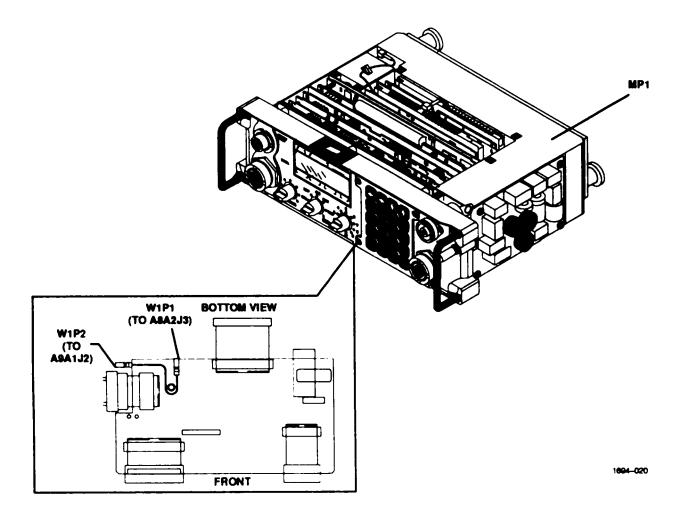


Figure 6-14. W1 Coaxial Cable Assembly Removal and Replacement

1

6.5.14 W2 Coaxial Cable Assembly Removal and Replacement

The following paragraphs provide instructions for the removal and installation of W2 Coaxial Cable Assembly from the RT-1694(P). See Figure 6-15.

WARNING

To prevent electrical shock and RF bums, remove all electrical connections to the receiver-transmitter before removing and replacing assemblies.

6.5.14.1 W2 Coaxial Cable Assembly Removal

Perform the following procedure to remove W2 Coaxial Cable Assembly from the RT- 1694(P) chassis:

- a. Remove MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.1.
- b. Remove MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.1.
- c. Remove A8 Power Amplifier/Battery Charger Assembly. Refer to Paragraph 6.5.9.1.
- d. Use needle-nose pliers (Item 5) to disconnect A5A2P8 coaxial cable from W2P2 connector.
- e. Use a socket wrench and handle (Items 6 and 7) to remove the nut and washer that secure W2P2 to MP1 chassis.
- f. Pull W2P2 connector through hole in MP1 chassis and remove from chassis.

6.5.14.2 W2 Coaxial Cable Assembly Replacement

Perform the following procedure to install W2 Coaxial Cable Assembly into the RT-1694(P) chassis:

- a. Feed W2P2 connector through hole in MPI chassis.
- b. Use a socket wrench and handle (Items 6 and 7) to tighten the nut and washer that secure W2P2 connector to MP1 chassis.
- c. Connect A5A2P8 coaxial cable to W2P2 connector.
- d. Install A8 Power Amplifier/Battery Charger Assembly. Refer to Paragraph 6.5.9.2.
- e. Install MP3 PWB Compartment Cover Assembly. Refer to Paragraph 6.5.2.2.
- f. Install MP2 Radio Case and Gasket Assembly. Refer to Paragraph 6.5.1.2.

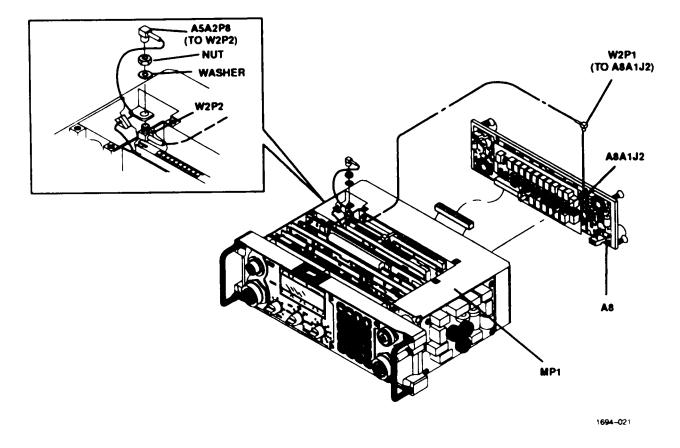


Figure 6-15. W2 Coaxial Cable Assembly Removal and Replacement

CHAPTER 7

PARTS LIST

7.1 INTRODUCTION

This chapter contains receiver-transmitter parts list information. This information can be used to identify parts within the receiver-transmitter and to place orders for those parts. This chapter is organized as follows:

- Paragraph 7.2 Shop Replaceable Units
- Paragraph 7.3 Parts Lists
- Paragraph 7.4 Component Location and Assembly Diagrams

7.2 SHOP REPLACEABLE UNITS

Figure 7-1 shows the locations of the Shop Replaceable Units (SRUs). Table 7-1 lists the SRUs that make up the receiver-transmitter. The quantity, part number, manufacturer of the SRU, and component location figure numbers are provided. Items that do not have a component location diagram are cross-referenced to an illustration that shows the relative position of the SRU within the receiver-transmitter.

Reference Designation	Item Name	Quantity Per Unit	Part Number	Cage Code	Figure Number
	Interface D\A/D Accombly	4	40202 2200	1 4 2 0 4	7.0
A1A1	Interface PWB Assembly	1	10303-2280	14304	7-2
A1A2	Encryption PWB Assembly	1	10303-2240	14304	7-3
A3	LPC Vocoder Assembly	1	10372-34401	14304	74
A4	Signal Processor PWB Assembly	1	10303-2500	14304	7-5
A5	Receiver/Exciter Assembly	1	10303-2600	14304	7-6, 7-7
A6	Synthesizer Assembly	1	10303-2700	14304	7-8, 7-9
A7	Power Supply Assembly	1	10303-2200	14304	7-10
A8	Power Amplifier/Battery Charger Assembly	1	10372-1400-01	14304	7-11, 7-12
A9	Antenna Coupler Assembly	1	10372-1450-01	14304	7-13
A10	Front Panel Assembly	1	10372-1500-01 10372-1500-02	14304	7-14
A11	Motherboard Assembly	1	10303-2170	14304	7-15
W1	PA-Coupler RF Cable Assembly	1	10372-1037-01	14304	7-16
W2	PA-Receiver/Exciter RF Cable Assembly	1	10372-1053-01	14304	7-17

Table 7-1.	List of Shop	Replaceable Units
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7-1/7-2

7.3 PARTS LISTS

Table 7-2 provides a list of miscellaneous receiver-transmitter items. These are items called out in a Chapter 6 procedure, removed and replaced during maintenance, or that can be damaged or lost. Reference designators, part numbers, and manufacturer of the items are listed. These miscellaneous items are also identified in Figure 7-1.

Table 7-3 lists the receiver-transmitter attaching hardware. The letter codes provided are referenced by the procedures found in Chapter 6. Item names, characteristics, part numbers, and manufacturers are also provided. These attaching hardware items are also identified in Figure 7-1.

Ref. Des.	Item Name	Part Number	Cage Code
A10MP2	Handle	10372-1041-01	14304
A10MP6	Dust Cap	10372-1525-01	14304
A10MP7	Dust Cap	10372-1525-02	14304
A10MP9	Control Knob	10012-2021	14304
A10MP10	Control Knob	10243-2021	14304
MP1	Chassis	10372-1005-01	14304
MP2	Radio Case and Gasket Assembly	10372-1014-01	14304
MP2A1MP6	Strike, Black	Z04 0002-102	14304
MP3	PWB Compartment Cover Assembly	10372-101001	14304
MP21	ID/Serial Number Label Plate	10372-1077-01	14304
MP23	Conductive O-Ring	10372-1206-01	14304
MF26	Rubber Pad	10372-1061-01	14304
MP30	Spring Finger Strip	10372-1209-01	14304
MP31	3145 Clear RTV Sealer	P15-3145-001	14304
MP33	Dust Cap	MS90376-12R	96906

Table 7-2. Miscellaneous Items Parts List

Letter Code	Item Name	Description	Part Number	Cage Code
А	Rat Head Screw	6-32 x 1/4 inch	MS24693-C24	96906
В	Pan Head Screw	Black, 6-32 x 1/4	MS51957-26B	96906
С	Hex Spacer	440 x 1/4 inch	H50-1006A40	14304
D	Pan Head Screw	2-56 x 1/4 inch	MS51957-3	96906
E	Lock Washer	#2	MS35338-134	96906
F	Flat Washer	.125 x .250 x .022	MS15795-803	96906
G	Pan Head Screw	Black, 2-56 x 3/16	MS51957-2B	96906
н	Flat Washer	#2	10303-3024	14304
I	Self-Sealing Screw	Pan head screw w/ O-ring	10372-1081-01	14304
J	Lock Washer	Black	MS35338-136B	96906
К	Hex Head Screw	Black, #10	10372-1076-01	14304
L	Flat Washer	Black, #10	MS15795-846B	96906
М	Hex Head Screw	Black, 440 x 1/4	MS16995-9B	96906
N	Lock Washer	Black, #4	MS35338-135B	96906
0	Flat Washer	Black, .125 x .250	MS15795-803B	96906
Р	Pan Head Screw	Brass	H12-0002-103	14304
Q	Lock Washer	PLN BVGZ#4 x .025	H41-0002-002	14304
R	Flat Washer	Brass, .119 x .28 x .025	H40 0003-002	14304

7.4 COMPONENT LOCATION AND ASSEMBLY DIAGRAMS

Component location diagrams (Figures 7-2 through 7-17) are supplied for verification of assembly connectors and test points.

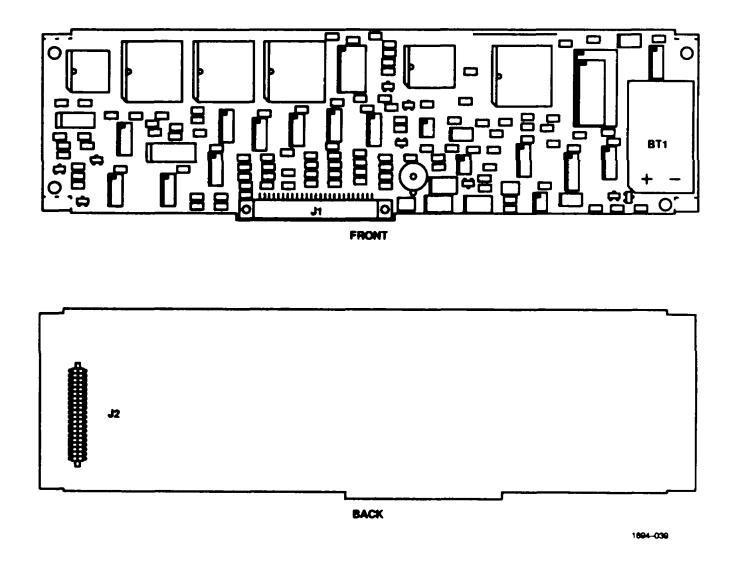


Figure 7-2. A1A1 Interface PWB Assembly Component Location Diagram (10303-2280 Rev. A)

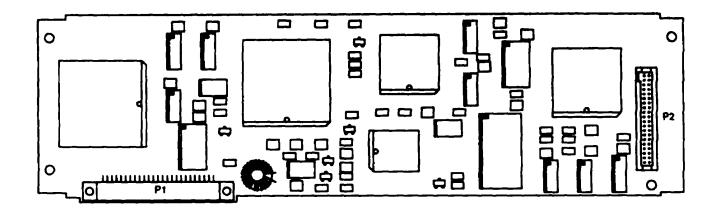


Figure 7-3. A1A2 Encryption PWB Assembly Component Location Diagram (10303-2240 Rev. A)

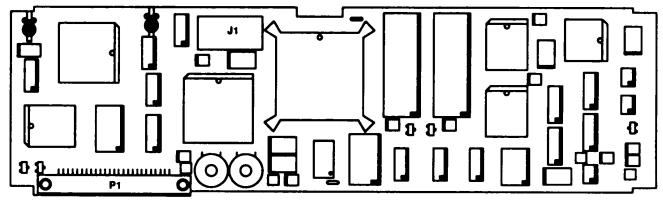


Figure 7-4. A3 LPC Vocoder Assembly Component Location Diagram (10372-3440 Rev. A)

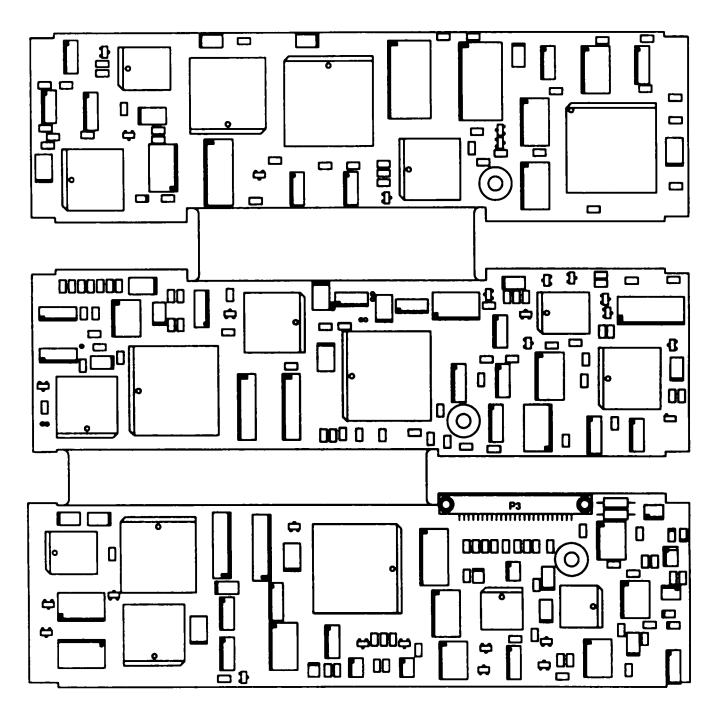


Figure 7-5. A4 Signal Processor PWB Assembly Component Location Diagram (10303-2500 Rev. C)

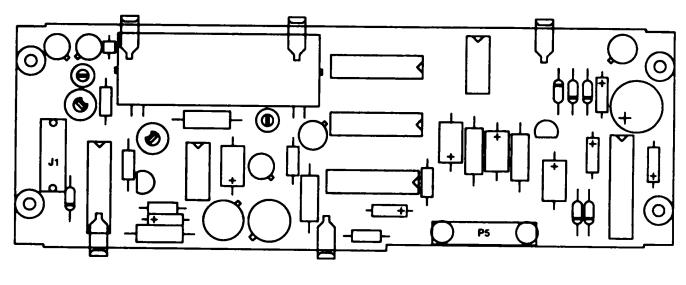


Figure 7-6. A5A1 Second and Third Converter PWB Assembly Component Location Diagram (10303-2610 Rev. B)

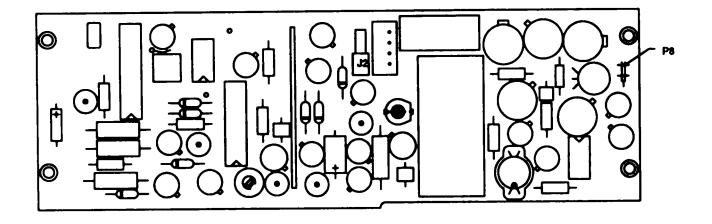


Figure 7-7. ASA2 First Converter PWB Assembly Component Location Diagram (10303-2270 Rev. E)

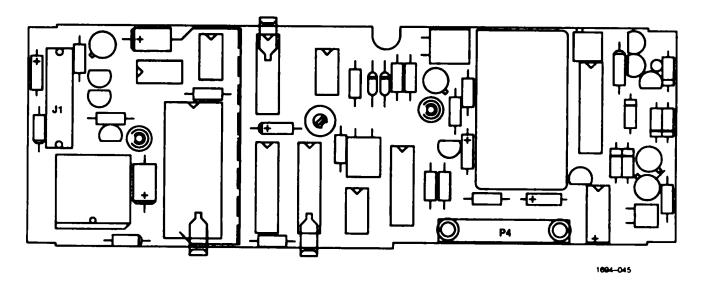


Figure 7-8. A6A1 Reference Generator PWB Assembly Component Location Diagram (10303-2710 Rev. C)



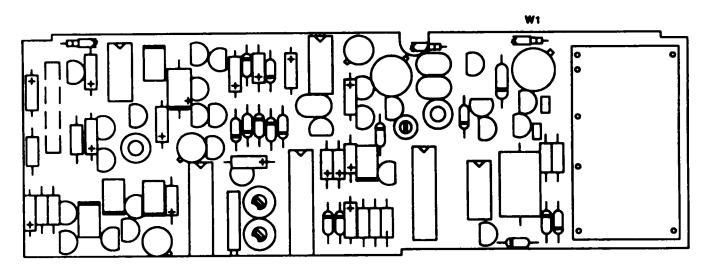


Figure 7-9. A6A2 Synthesizer PWB Assembly Component Location Diagram (10303-2720 Rev. A)

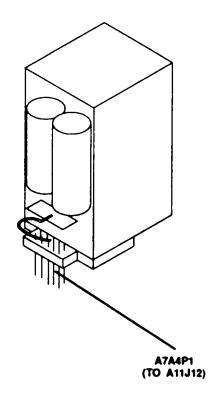


Figure 7-10. A7 Power Supply Assembly Component Location Diagram (10303-2200)

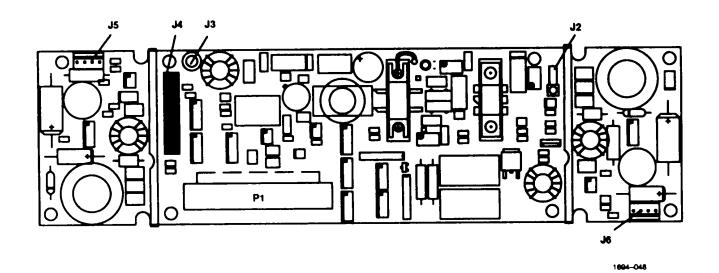


Figure 7-11. A8A1 Power Amplifier /Battery Charger PWB Assembly Component Location Drawing (10303-2130 Rev. C)

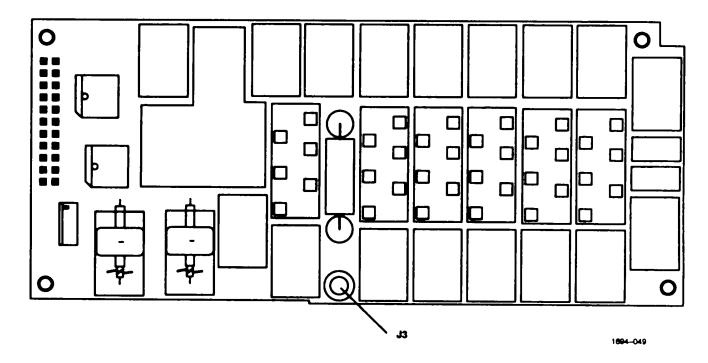


Figure 7-12. A8A2 Harmonic Filter PWB Assembly Components Location Diagram (10303-2140 Rev. C)

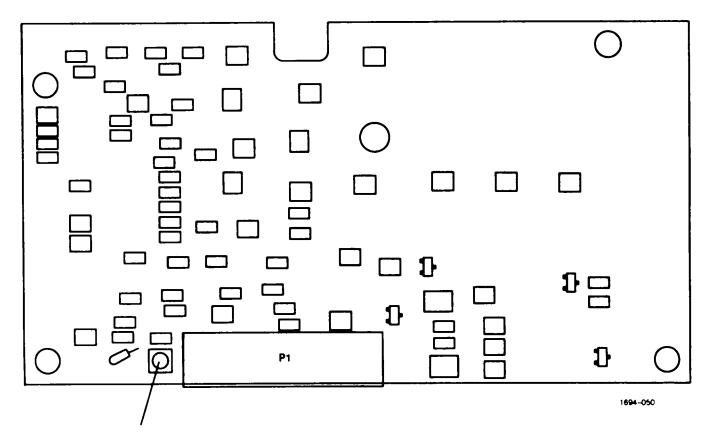
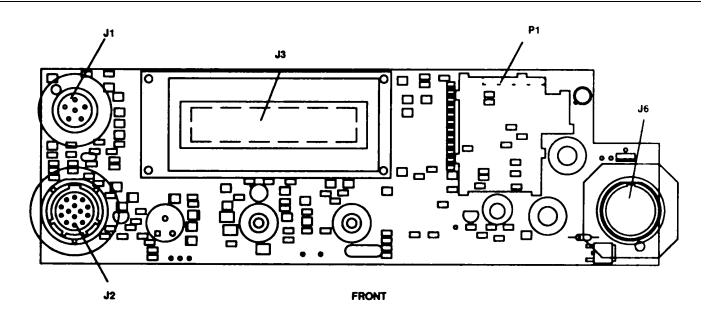


Figure 7-13. A9A1 Coupler Input PWB Assembly Component Location Diagram (10303-2150 Rev. D)



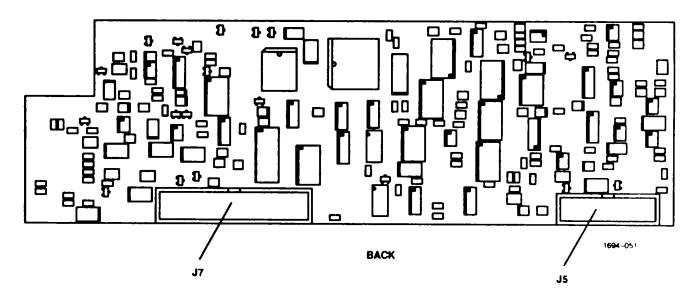


Figure 7-14. A10A1 Audio/Control PWB Assembly Component Location Diagram (1030-2100 Rev. D)

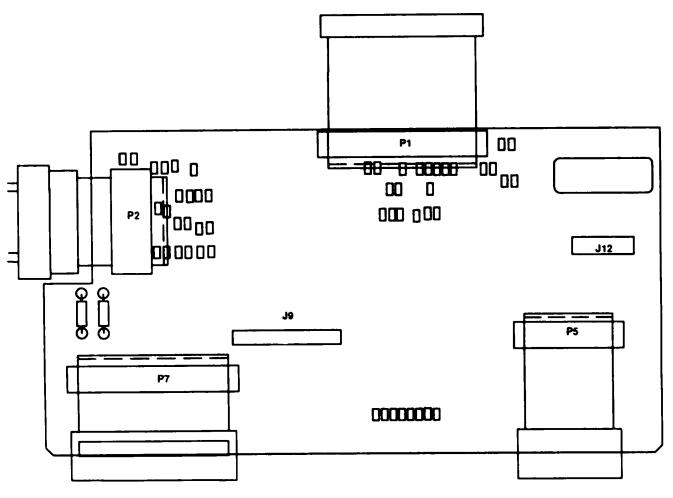


Figure 7-15. A11 Motherboard Assembly Component Location Diagram (10303-2170 Rev. E)

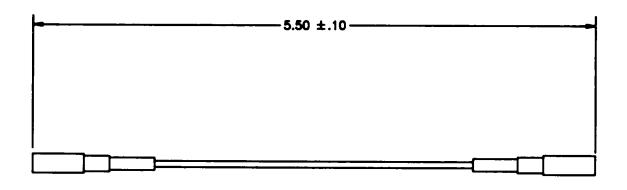


Figure 7-16. W1 RF Cable Assembly (PA-Coupler) Component Location Diagram (10372-1037 Rev. B)

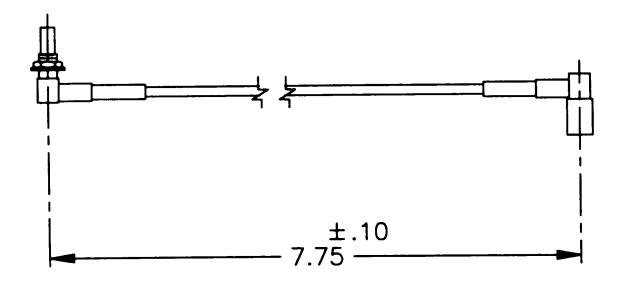


Figure 7-17. W2 RF Cable Assembly (PA-Receiver/Exciter) Component Location Diagram (10372-1053 Rev. A)

CHAPTER 8

INSTALLATION

8.1 INTRODUCTION

This chapter describes the following:

- Site information refer to Paragraph 8.2
- Tools and material required refer to Paragraph 8.3
- Unpacking and repacking refer to Paragraph 8.4
- Site installation refer to Paragraph 8.5
- Installation checkout refer to Paragraph 8.6

8.2 SITE INFORMATION

8.2.1 General

The information in the following paragraphs provides general guidelines for setting up the hot test bed radio system. Select a ventilated, well-lighted location. Avoid placing the system in a busy or congested area, or where there is excessive noise. The following are general site considerations:

- Availability of power source, earth ground, antenna, and other items as required
- · Ease of operation, maintenance, or removal and replacement
- Ventilation
- Clearance of connection cables to the back of the radio, antenna coupler, and other applicable equipment

8.2.2 General Guidelines

The information contained in the following paragraphs provides general site guidelines. Before choosing a site, become familiar with the dimensions shown in Figure 8-1. Ensure there is plenty of room for maintenance when the unit is installed.

8.2.3 Grounding

Follow these guidelines when grounding the hot test bed radio system.

WARNING

Do not daisy-chain ground connections, as voltage differentials develop over long distances. Any artificial ground system must also be connected to the primary power source ground to prevent generation of RFI and high voltage electromagnetic fields around the equipment.

The receiver-transmitter ground terminal must be connected to a grounded pipe (such as a cold water pipe), preferably where the pope enter the ground, or a steel or copper rod driven six to ten feet into the soil. In situations where the water table is far below the surface (such as desert or mountainous terrain), it may be necessary to create an artificial ground system by burying steel or copper plates six to ten inches below the surface, and connecting them together directly below the receiver-transmitter location. In all cases, such grounds must be connected to the receiver-transmitter using at least No. 8 copper cable directly from the ground point.

8.2.4 Dimension and Weight Information

Figure 8-1 and Table 8-1 list the overall dimensions of the RT-1694 (P) Receiver-Transmitter [RT-1694(P)] (with no batteries attached). The receiver-transmitter weighs 8.5 pounds (3.86 kilograms).

Parameter	Dimension
Height	3.1 inches (7.8 centimeters)
Width	10.4 inches (26.4 centimeters)
Depth	8.5 inches (21.6 centimeters)

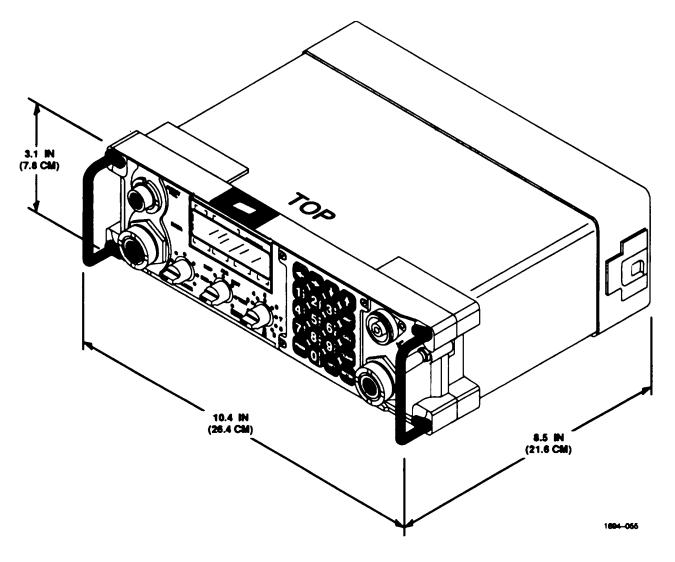


Figure 8-1. RT-1694(P) Receiver-Transmitter Dimensions

8.2.5 Environmental

The RT-1694(P) will perform in the environment specified in Chapter 1, Table 1-1.

8.3 TOOLS AND MATERIALS REQUIRED

Installation of the RT- I 694(P) requires no special tools or materials.

8.4 UNPACKING AND REPACKING

Equipment is packed in corrugated boxes. A two-piece foam enclosure protects the equipment against corrosion and rough handling. The boxes and packing materials should be retained in case the equipment is reshipped.

8.4.1 Unpacking

Perform the following procedure to unpack the equipment:

- a. Inspect the exterior of the box for signs of damage during shipment Note any problems and report them to the proper authority. An external sticker on the shipping box provides additional instructions concerning inspection of the package.
- b. Move the boxed equipment to the general location where it is to be installed.
- c. After removing the equipment, check the contents against the pacing slip to see that the shipment is complete. Report discrepancies to Harris/RF Communications' Customer Service Department (telephone: 716-244-5830).

8.4.2 Repacking

Perform the following procedure to unpack the receiver-transmitter.

- a. Use the original box, if it was retained. If not, use a box that allows three inches of clearance on all sides of the receiver-transmitter.
- b. Use the original packing material, if it was retailed. If not, use foam packing material to fill the space between the receiver-transmitter and the box. Surround the entire unit with three inches of foam packing material.
- c. Use a good quality packing tape (or straps) to seal the box after closing.

8.5 SITE INSTALLATION

The following paragraphs describe the power requirements and ancillary items kit required for properly installing the receiver-transmitter. Cabling, jumper and DIP switch settings, unit removal and installation procedures, clearance and ventilation requirements. and mounting information are also included.

8.5.1 **Power Requirements**

Power requirements are +24 Vdc at 8 A, maximum.

8.5.2 Ancillary Items Kit

The receiver-transmitter is not supplied with an ancillary items kit.

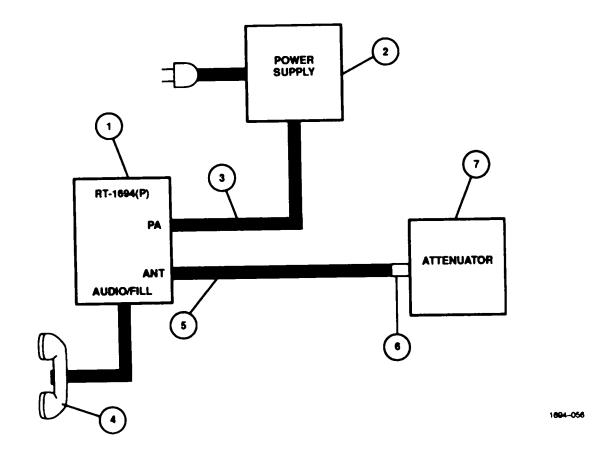


Figure 8-2. Typical Hot Test Bed Interconnect Diagram

8.6 INSTALLATION CHECKOUT

Hot test bed installation checkout has three phases. Phase 1 is a pre-energizing check to make sure that the unit is installed correctly and that all support items are nearby. Phase 2 covers the unit's power up and preliminary tests. Phase 3 tests all the functions of the receiver-transmitter.

8.6.1 Phase 1 - Hot Test Bed Installation Inspection and Pre-Power Up Procedures

When the receiver-transmitter is installed in the hot test bed and all connector cables attached, verify that the following items are completed:

- Ensure all connectors are attached and associated hardware is secure.
- Check that system units are connected to ground, preferably at a single point.
- Verify that ground wires are connected between the RT-1694(P), the DC power supply, and a known good ground.
- Check securing hardware to be sure the equipment cannot be tipped over or moved.
- Check that area cooling is adequate for removing heat that may develop during equipment operation.
- Verify that the power source is of adequate capability and adequately protected for the radio's load and that installation of the power cable is correct.
- Check any companion equipment, such as the power supply, or remote control, for operational readiness.

8.6.2 Phase 2 - Initial Turn-On and Preliminary Tests

To turn the unit on, refer to Table 2-2 in Chapter 2. Special preliminary tests are not necessary.

8.6.3 Phase 3 - Installation Verification Test

To verify receiver-transmitter performance. run BIT. Refer to Table 2-2 in Chapter 2.

8-7/8-8

CHAPTER 9

ACCESSORIES

9.1 INTRODUCTION

This chapter contains accessory information describing support packages and equipment accessories that are available for the RT-1694(P) Receiver-Transmitter [RT- 1694(P)1. These items add capabilities, provide supplemental instruction in operations and maintenance, recommend spares and tools for product preservation and repair, and list associated documentation to enhance the overall mission effectiveness of the receiver-transmitter. These items may be ordered directly from Harris/RF Communications using the order number provided with each description.

9.1.1 Support Packages

Support packages are items that are not required to utilize the receiver-transmitter, but furnish the user with a source of instruction and a means of maintaining equipment integrity. Support packages are considered and generated for each maintenance level. For information regarding maintenance levels, refer to Chapter 1, Paragraph 1.2. A summary of support packages and order numbers is provided in Table 9-1. Refer to the following paragraphs:

- Extended Warranties and Service Contracts Paragraph 9.1.1.1
- Training Paragraph 9.1.1.2
- Tools Paragraph 9.1.1.3
- Test Equipment Paragraph 9.1.1.4
- Maintenance Aids Paragraph 9.1.1.5
- Manuals Paragraph 9.1.1.6
- Spares Kits Paragraph 9.1.1.7

9.1.1.1 Extended Warranties and Service Contracts

Harris/RF Communications offers extended warranties and service contracts. An extended warranty lengthens the original warranty provided with Harris/RF Communications equipment and systems. Customers who want factory-trained field service personnel to assist in the installation, operation, maintenance, and service of their communications equipment can order a service contract. For more information, call the Harris/RF Communications marketing office (telephone: 716-244-5830).

9.1.1.2 Training

Training provides the user with valuable operation and maintenance knowledge gained through instruction and hands-on experience.

When ordering non-English training, please specify at time of order.

The following is a description of the levels of training:

• Level I Training provides thorough understanding of basic operating functions, equipment inspection procedures, and the use of operator cards.

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- Level II Training furnishes the skills for performing corrective maintenance, localizing faults to a unit, performance of general scheduled maintenance procedures, use of basic test equipment, and use of the System (Level II) Manual.
- Level III Training equips maintenance personnel with the skills needed to perform corrective maintenance and to localize faults to modules, assemblies, and chassis-mounted components. The training also equips personnel with skills to conduct necessary alignment and adjustments, to conduct detailed scheduled maintenance, and to use test equipment, maintenance aids, and the Maintenance (Level III) Manual.
- Level IV Training imparts the knowledge to perform corrective maintenance, locate defective components, alignments and adjustments, set up and use advanced support equipment, and use the Depot (Level IV) Manual.
- Radio System Training includes a complete training package that supports all major radio system units for Levels I, II, and III.

9.1.1.3 Tools

Tool kits for Maintenance Levels 11, 111, and IV are available to ensure that common items required to install, maintain, and disassemble/reassemble the unit are available to the maintainer. The following is a description of the tool kits:

- Level I Tools are not required.
- Level II Tools include items needed to install or remove the unit from the radio system and to perform general scheduled maintenance.
- Level III Tools include items required to perform corrective and scheduled maintenance down to the module or chassis-mounted component.
- Level IV Tools include items required to perform component-level repair and complete overhaul of the unit.
- Level II and III Receiver-Transmitter Tools include items required to perform Level II and III maintenance on the receiver-transmitter, without duplicating items.
- Level II and III Radio System Tools include all items required to perform Level III and III maintenance on all major units of the radio system, without duplicating items.

9.1.1.4 Test Measurement Equipment

Test equipment kits for Maintenance Levels I1, III, and IV are available to ensure that measurement items required to perform corrective and scheduled maintenance are available to the maintainer. These are used to take measurements off' a unit, system. or hot test bed. The following is a description of the test measurement equipment kits.

- Level I Test Measurement Equipment is not required.
- Level II Test Measurement Equipment includes measurement items needed to perform corrective maintenance. Scheduled maintenance, and fault localization to the unit.
- Level III Test Measurement Equipment includes measurement items required to perform corrective and scheduled maintenance down to the module or chassis-mounted component, such as a multimeter, power meter, and oscilloscope

- Level II and III Radio System Test Measurement Equipment includes all measurement items required to perform Level II and III maintenance on all major units of the radio system, without duplicating items.
- Level IV Test Measurement Equipment includes measurement items required to perform component-level repair and complete overhaul of the unit.

9.1.1.5 Maintenance Aids

Maintenance aids are special or non-standard tools and test equipment required to perform corrective and scheduled maintenance as specified in the applicable maintenance manual procedures. Special/non-standard tools and test equipment includes items that can only be procured from Harris/RF Communications, such as extender cards, test fixtures, and modified tools. The following is a description of the maintenance aids:

- Level I Maintenance Aids are not required.
- Level H Maintenance Aids are not required.
- Level III Maintenance Aids include items that support corrective and scheduled maintenance tasks associated with Level III maintenance such as extender cards, performance fixtures, pressurization kits, and breakout boxes.
- Level IV Maintenance Aids include items that support corrective maintenance tasks associated with Level IV maintenance such as extender cards, extender cables, test fixtures, automatic test equipment, and tools.

9.1.1.6 Manuals

Manuals are an invaluable, comprehensive resource for the installation, operation, and maintenance of the unit. Manuals also provide a listing of the support equipment recommended to optimize the unit's capabilities and minimize equipment down time.

When ordering non-English manuals, please specify at time of order.

The following is a description of the manuals:

- Level I Manual is in the form of operator cards that guide the user in the installation and basic operation of the unit. The cards are an abbreviated form of the information provided in the Level II manual, and are used to facilitate usage in the field.
- Level H1 Manual contains system-level information regarding installation and operation of each significant piece of equipment in the radio system. It also includes procedures for performing corrective maintenance and fault localization to the unit as well as general scheduled maintenance.
- Level III Manuals provide information required to perform corrective and scheduled maintenance down to the module or chassis-mounted component.
- Level IV Manuals document all the necessary procedures, tools, test equipment, and schematic diagrams required to perform component-level repair and complete overhaul of the unit.

10515-0006-2300

10515-0006-2500

10515-0006-2600

9.1.1.6.1 Associated Manuals

Manuals that may be referred to in the text of this manual are provided in Table 9-1.

Support Package	Maintenance Concept Supported	Order Number
Training Courses	Level I Level II Level III Level II and III (unit only) Level II and III (system)	1051540006-0100 10515-0006-0200 10515-0006-0300 10515-0006-0500 10515-0006-0600
Tool Kits	Level I Level II Level III Level I and II (unit only) Level II and III (system)	not required 10515-0006-1200 10515-0006-1300 10515-0006-1500 10515-0006-1600
Test Measurement Equipment Kits	Level I Level II	not required 10515-0006-2200

Level III

Level II and III (unit only)

Level II and III (system)

Table 9-1. Receiver-Transmitter Support Packages

Maintenance Aids	Level I Level III Level III (unit only) Level III (system)	not required not required 10515-0006-3300 10515-0006-3400
Manuals	Level I Level II Level III	10372-0004,-0006 10515-00064200 10515-00074300
Spares Kits	Level I Level II Level III	not required 10515-0006-5200 10515-0006-5300
Hot Test Bed Kits	Level I Level II Level II (unit only) Level III (system)	not required not required 10515-0006-6300 10515-0006-6400

9.1.1.7 Spares Kits

The maintainer uses spare pans kits to return equipment which has malfunctioned to operational readiness in as short a period of time as possible. The kit may include those items that are consumed during corrective and scheduled maintenance tasks, such as solder, tape, tie wraps, grease, etc.

The following is a description of the spares kits:

- Level I Spares Kit is not required.
- Level II Spares Kit, other than complete units, contains items that may be externally accessed from the equipment and are usually consumable in nature, such as fuses, filters, or lamps.
- Level III Spares Kit includes those items used to repair the unit by replacing a faulty module, Printed Wire Board (PWB), or chassis-mounted component. Both corrective and scheduled maintenance scenarios are considered. Spares kits contain items sufficient in quantity to provide a basic level of coverage for a minimal number of units, typically five or less. For spares support of more than five units, contact Harris/RF Communications directly.
- Level IV Hot Test Bed Kit is not currently available.

9.1.1.8 Hot Test Bed Kits

Hot Test Bed Kits are available for Maintenance Level III to ensure that equipment necessary to set up a test bed is available to the maintainer. The test bed is a classification of test equipment from which radio equipment characteristics can be measured. Hot Test Bed Kits consist of power supplies, signal generators, radio receiver-transmitters, and cables.

- Level I Hot Test Bed Kit is not required.
- Level II Hot Test Bed Kit is not required.
- Level III Hot Test Bed Kit for the receiver-transmitter includes system setup items necessary to test the RT-1694(P) at Level III maintenance.
- Level III Hot Test Bed Kit for the radio system includes system setup items necessary to test the radio system at Level III maintenance, without duplicating items.
- Level IV Hot Test Bed Kit for the receiver-transmitter includes system setup items necessary to test the RT-1694(P) at Level IV maintenance.
- Level IV Hot Test Bed Kit for the radio system includes system setup items necessary to test the radio system at Level IV maintenance, without duplicating items.

9.1.2 Equipment Accessories

Equipment accessories are items that are not provided with the receiver-transmitter, but can be procured to increase the application and capabilities of the unit. Table 9-2 lists the accessories available for the receiver-transmitter.

Item Name	Description	Part Number
Rechargeable Nickel-Cadmium Battery	The BB590/U consists of a pair of rechargeable Nickel-Cadmium batteries for the AN/PRC-138 Manpack battery case. The average life of the battery in a high usage/medium power environment is 4 - 6 hours.	BB-590/U
Lightweight Lithium Battery	The BA-5590/U is a lightweight, long-life battery for the AN/PRC-1 38 Manpack Radio Set. A 10372-0300 Battery Case is used to hold one or two BA-5590/U batteries. <i>The BA-5590/U cannot</i> <i>be recharged.</i>	BA-5590/U
Rechargeable Lead-Acid Battery	The BB-490/U consists of a pair of rechargeable lead-acid batteries for the AN/PRC- 138 Manpack battery case. The average life of this battery in a high usage/medium power environment is 6 - 8 hours.	BB490/U
Lightweight Battery Case	The 10372-1306 is a ULTEM 2100 [™] hi-grade, hi-impact plastic battery case with a 25% reduction in weight from the previous standard battery case. It holds two standard Ni-Cad or Lithium battery units.	10372-1306
Battery Case	The 10372-0300 is a standard aluminum battery case which snaps onto the RT-1694(P) back panel and holds two BB-590/U Ni-Cad, two BB490/U lead-acid, or two BA-5590/U Lithium Battery units. An extra case would allow the user to easily detach a spent battery and case and install new batteries and a case onto the back panel of the receiver-transmitter.	10372-0300
Battery Charger - Trickle	The 10309-0550 provides simultaneous trickle charging of up to six BB-590/U nickel-cadmium batteries. Charging time of a fully discharged battery is 14 hours. This battery charger operates on 115 to 230 Vac at 50/60 MHz. Specify voltage when ordering. This charger is not suitable for lead-acid batteries.	10309-0550

Table 9-2.	Receiver-Transmitter Accessories

Item Name	Description	Part Number		
Fast Charger	The 10372-0304 is a fast charger for up to four nickel-cadmium batteries. This microprocessor- controlled unit incorporates fast-charge, balancing charge, maintenance charge, and recovery charge programs to properly charge and maintain the BB-590/U and other Ni-Cad battery types. It operates on 100 to 265 Vac at 50 to 60 Hz. The typical charge time for one fully discharged BB-590/U is approximately 30 minutes.	10372-0304		
Solar Charger	This solar panel operates at 24 Vdc to charge one nickel-cadmium battery. Charge time depends on weather conditions. Cables are included.	10372-0750-01		
Lead-Acid Battery Charger	The 10372-0950-01 charges two lead-acid battery units in 14 - 16 hours. It operates on 115 or 230 Vac at 50/60 Hz.	10372-0950-01		
Manpack Whip Antenna Kit	The OE-505 is the standard antenna kit for the AN/PRC-138 Manpack. The kit includes an AT-271A/PRC-25 10-foot (3.1 m) Collapsible Whip Antenna (10012-0241), an AB-591/PRC-25 Flexible Base, a 10372-1203-01 Whip Adapter, and a 10372-0249-01 Equipment Bag. One OE-505 Manpack Whip Antenna Kit is supplied with each AN/PRC-138 Transceiver.	OE-505		
Manpack Whip Antenna - 10 Foot (3.1 Meters)	The 10012-0241 is a 10-foot (3.1 m) whip antenna consisting of an AT-271A/PRC-25 Collapsible Whip Antenna and an AB-591/PRC-25 Flexible Base. The 10012-0241 requires use of the 10372-1203-01 Whip Adapter when used with the AN/PRC-138 Manpack. The 10012-0241 is supplied with the AN/PRC-138 Manpack as part of the OE-505 Manpack Whip Antenna Kit.	10012-0241		
Whip Adapter for 10-Foot (3.1 Meter) Antenna	The 10372-1203-01 is used to adapt the 10372-0241 Manpack Whip Antenna to the AN/PRC-138 Manpack Transceiver. The 10372-1203-01 is supplied with the AN/PRC-138 Manpack as pan of the OE-505 Manpack Antenna Kit	10372-1203-01		
Canvas Antenna Bag	The 10372-0249-01 is a heavy-duty canvas bag to carry the 10372-1203-01 Whip Adapter, the 10012-0241 Whip Antenna, and the H-250/U Lightweight Handset for the AN/PRC-138 Manpack. The 10372-0249-01 is supplied with the AN/PRC- 138 Manpack as part of the OE-505 Manpack Whip Antenna Kit.	10372-0249-01		

Table 9-2.	Receiver-Transmitter Accessories - Continued

Item Name	Description	Part Number			
VHF Log-Periodic Transportable Antenna	The RF-289A is a tactical, portable log-periodic antenna system for operation in the 30 to 90 MHz range with a gain of 4 dBi in 30 to 35 MHz, 4.5 dBi in 35 to 76 MHz, and 6 dBi forward gain over average soil. The RF-289A can be configured for vertical or horizontal polarization and can be manually rotated. The package includes a 20-foot (6.1 m) mast, 35 feet (11 m) of RG-58A/U Coax Cable, ground stakes, a mounting base, guy ropes, and a hammer.	RF-289A			
VHF Omnidirectional, Transportable Antenna	The RF-290 is a tactical, portable, omnidirectional VHF 30 MHz to 90 MHz antenna. It is easily erected and designed for broadband operations. The system comes complete with a 33-foot (10 m) mast. an X(-foot coax cable with connectors, ground stakes, a base plate, a guy assembly, and a hammer.	RF-290			
Antenna - Portable Near Vertical Incidence Skywave (NVIS)	The RF-1936P is a Near-Vertical-Incidence- Skywave antenna system. It is rapidly deployable for short- to medium-range communications. The RF-1936P covers the HF and lo-VHF spectrums. It can be erected in five minutes by two people. The system requires use of an antenna coupler. The package includes a mast assembly and sections, a base plate, a hammer, and ground stakes.	RF-1936P			
Antenna - Portable Dipole	The RF-1940 is a lightweight, portable dipole antenna operating in the 3 MHz to 30 MHz range. Its maximum input power is 500 watts. The unit is self-contained, using flat spools lengthened according to the frequency used. An additional throw line attaches to trees and masts. The RF connector is BNC for direct connection to a Manpack.	RF-1940			
Vehicular Whip Antenna	The SB-V16B is a vehicular, 16-foot (4.9 m), fiberglass whip antenna which covers the full operating range of the AN-PRC/138 Manpack with a maximum power output of up to 400 watts. This antenna is self-supporting with a feed-through base and mounting hardware.	SB-V16B			

Table 9-2	Receiver-Transmitter Accessories - Continued
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Item Name	Description	Part Number
Fast Charger	The 10372-0304 is a fast charger for up to four nickel-cadmium batteries. This microprocessor- controlled unit incorporates fast-charge, balancing charge, maintenance charge, and recovery charge programs to properly charge and maintain the BB-590/U and other Ni-Cad battery types. It operates on 100 to 265 Vac at 50 to 60 Hz. The typical charge time for one fully discharged BB-590/U is approximately 30 minutes.	10372-0304
Solar Charger	This solar panel operates at 24 Vdc to charge one nickel-cadmium battery. Charge time depends on weather conditions. Cables are included.	10372-0750-01
Lead-Acid Battery Charger	The 10372-0950-01 charges two lead-acid battery units in 14 - 16 hours. It operates on 115 or 230 Vac at 50/60 Hz.	10372-0950-01
Manpack Whip Antenna Kit	The OE-505 is the standard antenna kit for the AN/PRC-138 Manpack. The kit includes an AT-271A/PRC-25 10-foot (3.1 m) Collapsible Whip Antenna (10012-0241), an AB-591/PRC-25 Flexible Base, a 10372-1203-01 Whip Adapter, and a 10372-0249-01 Equipment Bag. One OE-505 Manpack Whip Antenna Kit is supplied with each AN/PRC- 138 Transceiver.	OE-505
Manpack Whip Antenna - 10 Foot (3.1 Meters)	The 10012-024I is a 1-foot (3.1 m) whip antenna consisting of an AT-271A/PRC-25 Collapsible Whip Antenna and an AB-591/PRC-25 Flexible Base. The 10012-0241 requires use of the 10372-1203-01 Whip Adapter when used with the AN/PRC-138 Manpack. The 10012-0241 is supplied with the AN/PRC-138 Manpack as part of the OE-505 Manpack Whip Antenna Kit.	10012-0241
Whip Adapter for 10-Foot (3.1 Meter) Antenna	The 10372-1203-01 is used to adapt the 10372-0241 Manpack Whip Antenna to the AN/PRC-138 Manpack Transceiver. The 10372-1203-01 is supplied with the AN/PRC-138 Manpack as part of the OE-505 Manpack Antenna Kit.	10372-1203-01
Canvas Antenna Bag	The 10372-0249-01 is a heavy-duty canvas bag to carry the 10372-1203-01 Whip Adapter, the 10012-0241 Whip Antenna, and the H-250/U Lightweight Handset for the AN/PRC- 138 Manpack. The 10372-0249-01 is supplied with the AN/PRC-138 Manpack as part of the OE-505 Manpack Whip Antenna Kit.	103720249-01

Table 9-2. Receiver-Transmitter Accessories - Continued

/HF Log-Periodic Transportable	The RF-289A is a tactical, portable log-periodic antenna system for operation in the 30 to 90 MHz range with a gain of 4 dBi in 30 to 35 MHz, 4.5 dBi in 35 to 76 MHz, and 6 dBi forward gain over average soil. The RF-289A can be configured for vertical or horizontal polarization and can be	RF-289A
	manually rotated. The package includes a 20-foot (6.1 m) mast, 35 feet (11 m) of RG-58A/U Coax Cable, ground stakes, a mounting base, guy ropes, and a hammer.	
/HF Omnidirectional, ransportable Antenna	The RF-290 is a tactical, portable, omnidirectional VHF 30 MHz to 90 MHz antenna. It is easily erected and designed for broadband operations. The system comes complete with a 33-foot (10 m) mast, an 80-foot coax cable with connectors, ground stakes, a base plate, a guy assembly, and a hammer.	RF-290
ntenna - Portable Near Vertical ncidence Skywave (NVIS)	The RF-1936P is a Near-Vertical-Incidence- Skywave antenna system. It is rapidly deployable for short- to medium-range communications. The RF-1936P covers the HF and lo-VHF spectrums. It can be erected in five minutes by two people. The system requires use of an antenna coupler. The package includes a mast assembly and sections, a base plate, a hammer, and ground stakes.	RF-1936P
ntenna - Portable Dipole	The RF-1940 is a lightweight, portable dipole antenna operating in the 3 MHz to 30 MHz range. Its maximum input power is 500 watts. The unit is self-contained, using flat spools lengthened according to the frequency used. An additional throw line attaches to trees and masts. The RF connector is BNC for direct connection to a Manpack.	RF-1940
/ehicular Whip Antenna	The SB-V 16B is a vehicular, 16-foot (4.9 m), fiberglass whip antenna which covers the full operating range of the AN-PRC/138 Manpack with a maximum power output of up to 400 watts. This antenna is self-supporting with a feed-through base and mounting hardware.	SB-V16B

Table 9-2.	Receiver-Transmitter Accessories - C	ontinued

Item Name	Description	Part Number		
Vehicular Metallic "V" Antenna	The SB-V216B is a vehicular antenna configured to enhance short-range HF communications by improving NVIS propagation performance. The antenna is an adjustable "V" configuration consisting of two metallic radiators: one 16 feet (4.9 m) in length and the other 9 feet (2.7 m). The angle of each radiator is mechanically adjustable to provide optimum NVIS performance. The SB-V216B may be configured as a single radiation element for longer range communications. This antenna will mount directly to the RF-292 Universal Antenna Mount.	SB-V2 1 6B		
Backpack Harness for AN/PRC- 138 Manpack	The 10372-0450-01 is a radio carrying bag with an adjustable shoulder strap for forward or side sling access. The bag attaches to the Backpack Harness 10372-045001 for backpack configuration.	10372-0450-01		
Manpack Radio Carrying Bag	The 10372-0460-01 consists of a rugged, lightweight ruck pack harness and frame. It holds the AN/PRC-138 Manpack in a dorsal access configuration. The 10372-0460-01 Radio Carrying Bag fits inside a ruck pack to the harness. It contains pouches for carrying accessories.	10372-0460-01		
Ranger Backpack	The 10372-0470-01 is designed for use by U.S. Army Rangers and consists of a rugged, lightweight backpack design to fit a variety of different manpack radios. The backpack has side pockets for an antenna kit and back pouch for extra batteries. The backpack contains internal	10372-0470-01		
H-250/U Lightweight Handset	flaps for kevlar inserts. The 10075-1344-01 is a high-grade, lightweight MIL handset for use with the RT- 1694(P). One Handset is supplied with each FALCON - Series Transceiver System. It is recommended for use with the LPC Digitized Voice Option.	10075-1344-01		
Headset with Boom Microphone - Dynamic Mic Element - Single Earpiece	The RF-3014-01 is a high-grade MIL headset with an adjustable boom microphone and a single earpiece for use with the RT-1694(P).	RF-3014-01		
Headset with Boom Microphone - Dynamic Mic Element - Dual Earpiece	The RF-3014-02 is a high-grade MIL headset with an adjustable boom microphone and a dual earpiece for use with the RT- 1694(P). 9-9	RF-3014-02		

Table 9-2. Receiver-Transmitter Accessories - Continued

Item Name	Description	Part Number		
CW Key with Knee Clip	The RF-3016-03 is a MIL-grade telegraph key mounted on a clip that may be fitted over an operator's knee. It is useful for vehicular CW operation, and is used with the RT-1694(P).	RF-3016-03		
CW Base-Station Key	The RF-3016-04 is a MIL-grade telegraph key for use with the RT-1694(P) in base station applications. The unit includes key, cable, and plug.	RF-301644		
Palm Microphone	The noise-canceling microphone in this palm-held unit includes a built-in, Push-to-Talk (PTT) switch and a coiled cable that terminates in a standard (U-229/U) five-contact connector. The RF-294-07 is intended for use with the RT-1694(P).	RF-294-07		
Headset - Dual Earpiece	The RF-294-08 is a high-grade, MIL, two-earpiece headset unit with a flexible headband, a coiled cable with a clip to attach to the user's clothing, and a standard (U-229/U) five-contact connector. The RF-294-08 is intended for use with the RT-1694(P).	RF-294-08		

Table 9-2.	Receiver-Transmitter Accessories - Continued

9-10

APPENDIX A

MAINTENANCE ALLOCATION CHART

SECTION 1. INTRODUCTION

A-1 The Army Maintenance System MAC.

- a. This introduction (section I) provides a general explanation of all maintenance and repair functions authorized at various maintenance levels under the standard Army Maintenance System concept.
- b. The Maintenance Allocation Chart (MAC) in section II designates overall authority and responsibility for the performance of maintenance functions on the identified end item or component. The application of the maintenance functions to the end item or component will be consistent with the capacities and capabilities of the designated maintenance levels, which are shown on the MAC in column (4) as:

Unit - includes two subcolumns, C (operator/crew) and O (unit) maintenance.

Direct Support - includes an F subcolumn.

General Support - includes an H subcolumn.

Depot - includes a D subcolumn.

- c. Section III lists the tools and test equipment (both special tools and common tool sets) required for each maintenance function as referenced from section II.
- d. Section IV contains supplemental instructions and explanatory notes for a particular maintenance function.

A-2 <u>Maintenance Functions</u>. Maintenance functions are limited to and defines as follows:

- a. Inspect. To determine the serviceability of an item by comparing its physical, mechanical, and/or electrical characteristics with established standards through examination (e.g., sight, sound, or feel).
- b. Test. To verify serviceability by measuring the mechanical, pneumatic, hydraulic, or electrical characteristics of an item and comparing those characteristics with prescribed standards.
- c. Service. Operations required periodically to keep an item in proper operating condition; e.g., to clean (includes decontaminate, when required), to preserve, to drain, to paint, or to replenish fuel, lubricants, chemical fluids, or gases.
- d. Adjust. To maintain or regulate, within prescribed limits, by bringing into proper position, or by setting the operating characteristics to specified parameters.
- e. Align. To adjust specified variable elements of an item to bring about optimum or desired performance.

- f. **Calibrate**. To determine and cause corrections to be made or to be adjusted on instruments or test, measuring, and diagnostic equipment used in precision measurement. Consists of comparisons of two instruments, one of which is a certified standard of known accuracy, to detect and adjust any discrepancy in the accuracy of the instrument being compared.
- g. **Remove/Install**. To remove and install the same item when required to perform service or other maintenance functions. Install may be the act of emplacing, seating, or fixing into position a spare, repair part, or module (component or assembly) in a manner to allow the proper functioning of an equipment or system.
- h. **Replace**. To remove an unserviceable item and install a serviceable counterpart in its place. "Replace" is authorized by the MAC and assigned maintenance level is shown as the third position code of the SMR code.
- i. **Repair.** The application of maintenance services¹ including fault location/troubleshooting², removal/installation, and disassembly/assembly³ procedures, and maintenance actions⁴ to identify troubles and restore serviceability to an item by correcting specific damage, fault, malfunction, or failure in a part, subassembly, module (component or assembly), end item, or system.
- j. Overhaul. That maintenance effort (service/action) prescribed to restore an item to a completely serviceable/operational condition as required by maintenance standards in appropriate technical publications (i.e., DMWR). Overhaul is normally the highest degree of maintenance performed by the Army. Overhaul does not normally return an item to like-new condition.
- k. Rebuild. Consists of those services/actions necessary for the restoration of unserviceable equipment to a likenew condition in accordance with original manufacturing standards. Rebuild Is the highest degree of materiel maintenance applied to Army equipment. The rebuild operation includes the act of returning to zero those age measurements (e.g., hours/miles considered in classifying Army equipment/components.

¹Services - Inspect, test, service, adjust, align calibrate, and/or replace.

²Fault location/troubleshooting - The process of investigating and detecting the cause of equipment malfunctioning; the act of isolating a fault within a system or unit-under-test (UUT).

³Disassembly/assembly - The step-by-step breakdown (taking apart) of a spare/functional group coded item to the level of its least component, that is assigned an SMR code for the level of maintenance under consideration (i.e., identified as maintenance significant).

⁴Actions - Welding, grinding, riveting, straightening, facing, machining, and/or resurfacing.

A-3 Explanation of Columns In the MAC. Section II

- a. **Column 1, Group Number**. Column 1 lists functional group code numbers, the purpose of which is to identify maintenance significant components, assemblies, subassemblies, and modules with the next higher assembly.
- b. **Column 2, Component/Assembly**. Column 2 contains the item names of components, assemblies, subassemblies, and modules for which maintenance is authorized.
- c. **Column 3, Maintenance Function**. Column 3 lists the functions to be performed on the item listed in Column 2. (For detailed explanation of these functions, see paragraph B-2).
- d. Column 4, Maintenance Level. Column 4 specifies each level of maintenance authorized to perform each function listed in Column 3, by indicating work time required (expressed as man-hours In whole hours or in decimals) in the appropriate subcolumn. This work-time figure represents the active time required to perform that maintenance function at the indicated level of maintenance. If the number or complexity of the tasks within the listed maintenance function vary at different maintenance levels, appropriate work-time figures are shown for each level. The work-time figure represents the average time required to restore an item (assembly, subassembly, component, module, end item, or system) to a serviceable condition under typical field operating conditions. This time includes preparation time (including any necessary disassembly/assembly time), troubleshooting/fault location time, and quality assurance time in addition to the time required to perform the specific tasks identified for the maintenance functions authorized in the maintenance allocation chart. The symbol designations for the various maintenance levels are as follows:

C	Operator or Crew Maintenance
0	Unit Maintenance
F	Direct Support Maintenance
Н	General Support Maintenance
D	Depot Maintenance

- e. Column 5, Tools and Test Equipment Reference Code. Column 5 specifies, by code, those common tool sets (not individual tools), common TMDE, and special tools, special TMDE, and special support equipment required to perform the designated function. Codes are keyed to tools and test equipment in section III.
- f. **Column 6, Remarks**. When applicable, this column contains a letter code, in alphabetical order, which is keyed to the remarks contained in section IV.

A-4 Explanation of Columns In Tool rind Test Equipment Requirements, Section III.

a. Column 1, Reference Code. The tool and test equipment reference code correlates with a code used in the MAC, section II, column 5.

- b. Column 2, Maintenance Level. The lowest level of maintenance authorized to use the tool or test equipment.
- c. Column 3, Nomenclature. Name or identification of the tool or test equipment.
- d. Column 4, National Stock Number. The National Stock Number of the tool or test equipment.
- e. Column 5, Tool Number. The manufacturer's part number, model number, or type number.

A-5 Explanation of Columns in Remarks, Section IV

- a. Column 1, Remarks code. The code recorded in column 6, section II.
- b. Column 2, Remarks. This column lists information pertinent to the maintenance function being performed as indicated in the MAC, section II.

Section II. MAINTENANCE ALLOCATION CHART FOR RT-1 694A(P)(V)1/PRC-138 RECEIVER-TRANSMITTER

(1)	(2)	(3)	(4) MAINT LEVEL - MANHRS				(6)		
GRP		MAINT	UN	IIT	DIR	OIR GEN DEP		TEST EQP	REMARKS
NUM	COMPONENT/ASSY	FUNCT	С	0	F	Н	D	REF CODE	CODE
00	RT-1694A(P)(V)1/PRC-138 RECEIVER-TRANSMITTER	INSPECT SERVICE REPLACE	0.1 0.1 0.0 8						J K
		TEST REPLACE TEST REPAIR		0.08 0.08	0.08 0.20			1 1 THRU 19 2,3,4,5,6	A C,D,E,F A, L G
01	CCA, INTERFACE	REPLACE REPAIR			0.18		*	2,3,4	H I
02	CCA, LPC VOCODER	REPLACE REPAIR			0.18		*	2,3,4	H I
03	CCA, SIG PROCESSOR	REPLACE REPAIR			0.18		*	2,3,4	H I
04	CCA, RCVR/EXCTR	REPLACE REPAIR			0.19		*	2,3,4	H I
05	CCA, REF GEN/SYNTH	REPLACE REPAIR			0.19		*	2,3,4	H I
06	CCA, PWR SPLY	REPLACE REPAIR			0.24		*	2,3,4	H I
07	CCA, PWR AMP/BAT	REPLACE REPAIR			0.19		*	2,3,4	B,H I
08	CCA, ANT CPLR	REPLACE REPAIR			0.18		*	2,3,4	H I
09	CCA, FRONT PANEL	REPLACE REPAIR			0.17		*	2,3,4	H I
10	CCA, MOTHERBOARD	REPLACE REPAIR			0.24		*	2,3,4	H I

SECTION III. TOOLS AND TEST EQUIPMENT FOR RT-1694A(P)(V)1 /PRC-138 RECEIVER-TRANSMITTER

TOOL/TEST EQ REF CODE	MAINT- LEVEL	NOMENCLATURE	NATIONAL STOCK NUMBER	TOOL NUMBER
1	O, F	SYSTEM BIT	NONE	
2	F	TOOL KIT, ELECTRONIC EQUIP	5180-00-610-8177 TK-105/G	
3	F	ESD MAT	6530-01-169-1322	1872
4	F	GROUND STRAP	5920-01-127-6766	3M-2064
5	F	POWER SUPPLY	6130-00-249-2748	6268B
6	F	CABLE, BATTERY ELIMINATOR	NONE	10372-9330
7	F	SIGNAL GENERATOR, RF	6625-01-358-4922	8657A
8	F	ADAPTER, N-TYPE(M) TO BNC(F)	593500-259-0205	M55339/20-00201
9	F	CABLE ASSY, RF, BNC(M)	5995-00-070-8747	10503A
10	F	BREAKOUT BOX	5985-01-395-6898	1008-1100
11	F	AUDIO ANALYZER	6625-01-221-9295	8903B
12	F	CABLE ASSY, AUXILIARY	NONE	10372-9850
13	F	POWER SUPPLY	6130-00-247-4664	6291A
14	F	HANDSET (H-250/U)	5965-01-247-4723	10075-1344-01
15	F	POWER METER, RF	6625-01-316-6448	437B
16	F	POWER SENSOR	6625-01-094-8263	8482B
17	F	ATTENUATOR	NONE	77B6-30
18	F	FREQUENCY COUNTER	6625-01-176-8354	5385A
19	F	DIGITAL MULTIMETER	6625-01-265-6000	AN/PSM-45A
		A-6		

Section IV. REMARKS FOR RT-1 694A(P)(V)1/PRC-138 RECEIVER-TRANSMITTER

REMARKS CODE	REMARKS	
A	SELF-TEST, SYSTEM BIT	
В	F1 AND F3 FUSES ARE NON-REPAIRABLE ON A8A1 CIRCUIT CARD ASSEMBLY	
С	THE H-250/U HANDSET IS A NON-REPAIRABLE ON THE RT-1694: ISOLATED USING BIT AND REPLACED AND TESTED IN .07 MANHRS	
D	THE OE-505 WHIP ANTENNA IS A NON- REPAIRABLE ON THE RT-1694: ISOLATED USING BIT AND REPLACED AND TESTED IN .07 MANHRS	
E	FRONT PANEL KNOBS 10012-2021 AND 10243-2021 ARE NON-REPAIRABLE AND CAN BE REPLACED AT THE UNIT LEVEL WITH TOOL 2	
F	FRONT PANEL HANDLES 10372-1041-01 ARE NON-REPAIRABLE AND CAN BE REPLACED AT THE UNIT LEVEL WITH TOOL 2	
G	REPAIR BY REPLACING FRONT PANEL KNOBS, HANDLES, CIRCUIT CARDS	
н	REPLACED WHEN INDICATED BY TEST AGAINST NEXT HIGHER ASSEMBLY	
I	REPAIRED AT CONTRACTOR DEPOT	
J	REPLACE BATTERIES IN BATTERY PACK OR THE MEMORY BACKUP BATTERY	
к	REPLACE MISSING OR DAMAGED MANPACK AND BATTERY PACK HARDWARE (BELTS, STRAPS, FRAME, RT-1694A(P)(V)1/PRC-138 ACCESSORY KIT, ETC.)	
L	TROUBLESHOOT TO THE BOARD LEVEL USING BIT AND THE TEST BED. IF NO BIT INDICATION IS PRESENT TROUBLESHOOT THE SYSTEM USING THE NON-BIT TROUBLESHOOTING PROCEDURES. NOTE: THE NON-BIT TROUBLESHOOTING PROCEDURES REFERENCE TESTS WHICH THE HARRIS MANUALS DOCUMENT AS "SCHEDULED MAINTENANCE". THERE IS NO REQUIREMENT TO PERFORM THESE TESTS ON A SCHEDULED BASIS BUT THEY WILL BE PERFORMED AS PART OF THE NON-BIT TROUBLE SHOOTING AS REQUIRED. INTERIM CONTRACTOR SUPPORT WILL BE USED TO PERFORM REPAIR RELATED TO THE NON-BIT TROUBLESHOOTING UNTIL ADDITIONAL TEST EQUIPMENT IS MADE AVAILABLE TO THE FIELD.	

A-7/A-8

By Order of the Secretary of the Army:

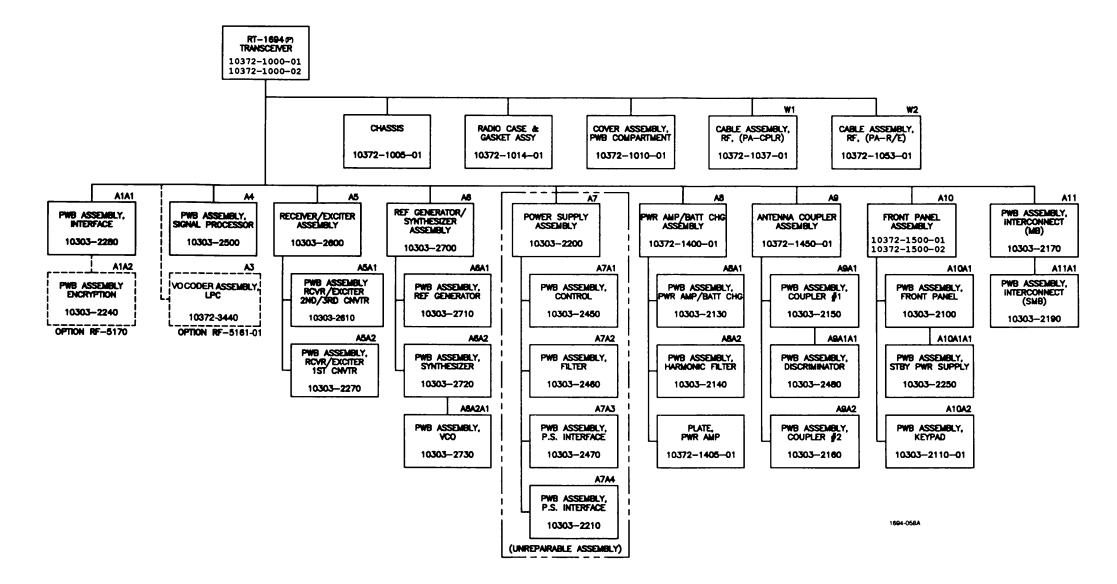
DENNIS J. REIMER General, United States Army Chief of Staff

Official: Joel B. Hula

JOEL B. HUDSON Administrative Assistant to the Secretary of the Army

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Figure 1-3. RT-1694(P) Family Tree

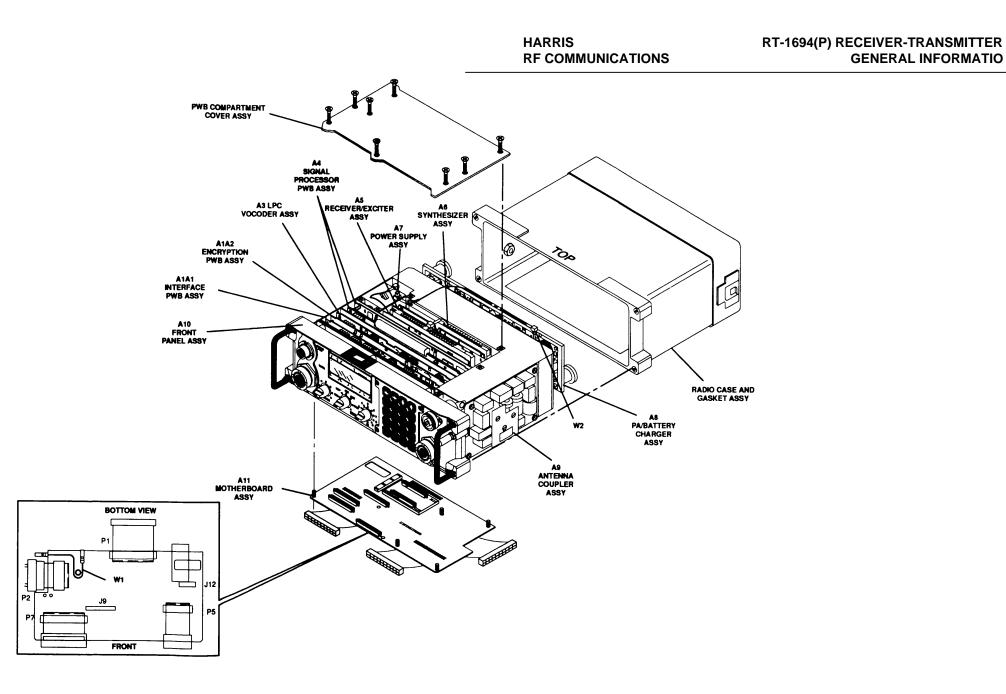
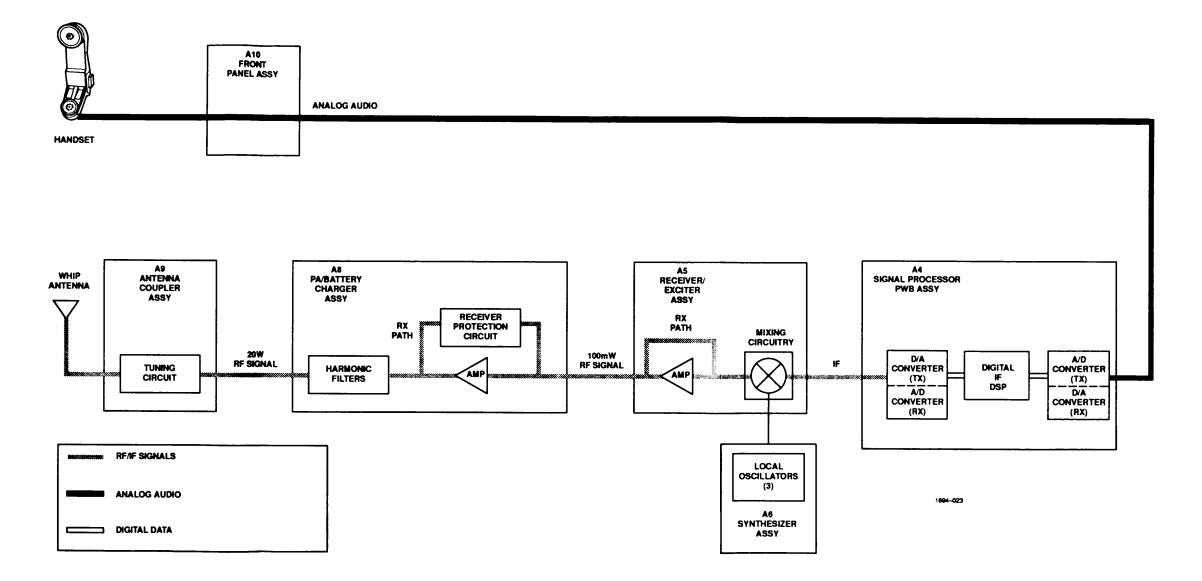
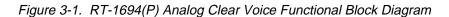


Figure 1-6. Locations of Assemblies

1-21/1-22

HARRIS	RT-1694(P) RECEIVER-TRANSMITTER
RF COMMUNICATIONS	FUNCTIONAL DESCRIPTION





3-3/3-4

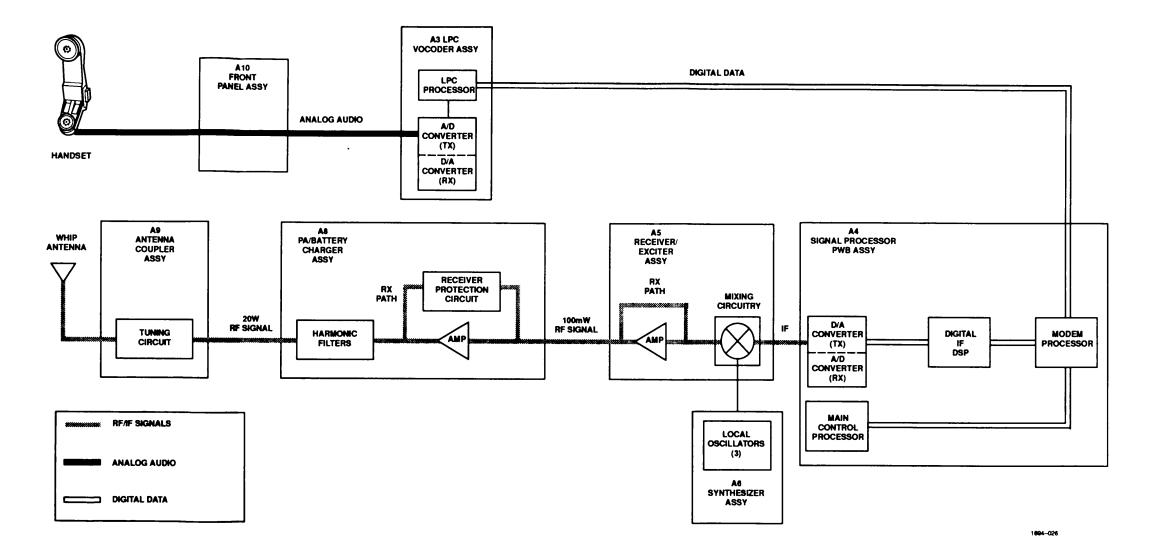


Figure 3-2. RT-1694(P) Digital Voice Functional Block Diagram

HARRIS RF COMMUNICATIONS

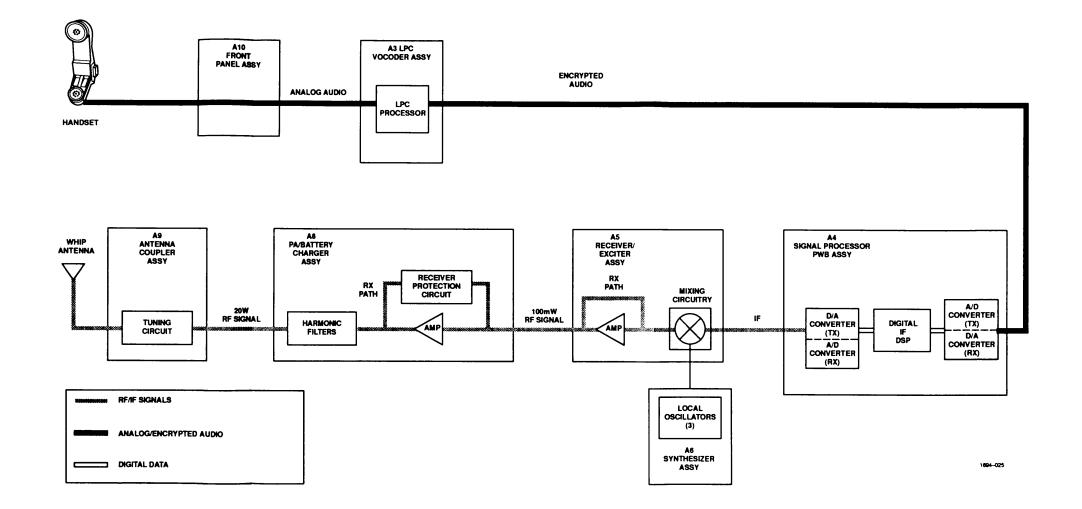
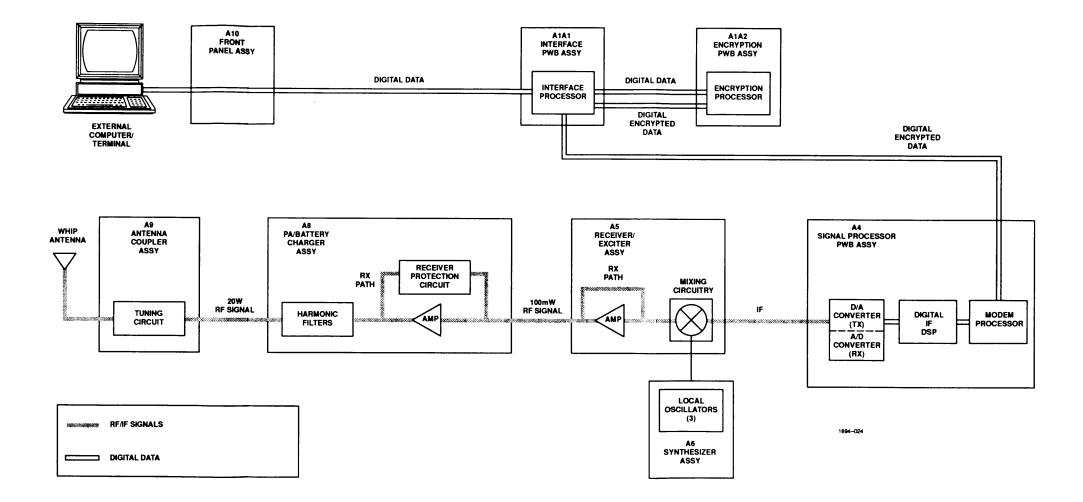


Figure 3-3. RT-1694(P) Analog Voice Security (AVS) Simplified Functional Block Diagram

3-9/3-10



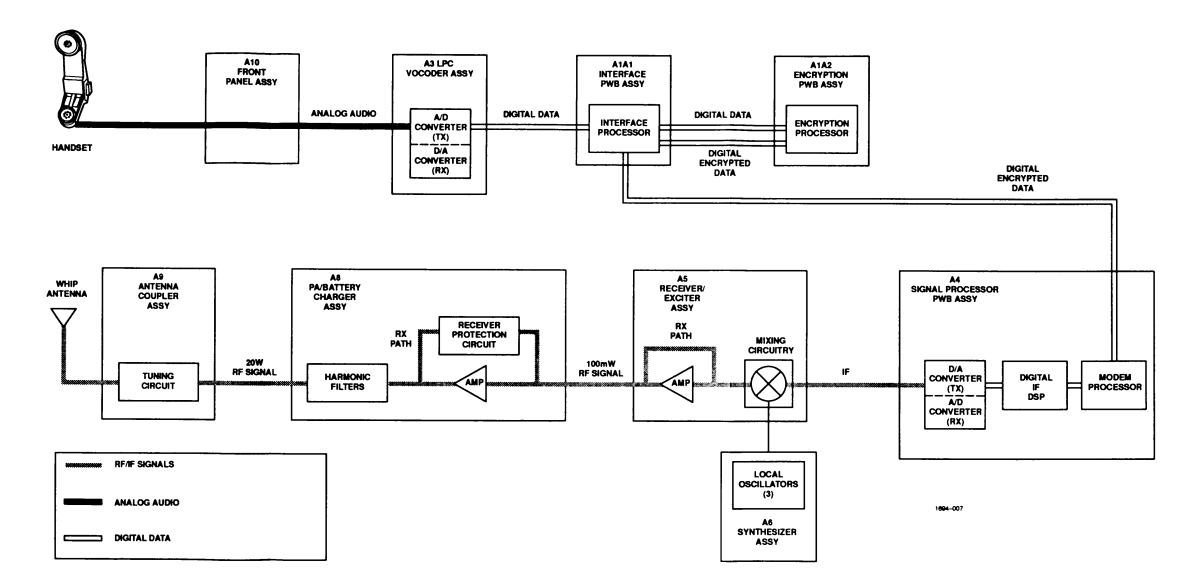
HARRIS

RF COMMUNICATIONS

Figure 3-4. RT-1694(P) Encrypted Digital Data Simplified Functional Block Diagram

3-15/3-16

RT-1694(P) RECEIVER-TRANSMITTER FUNCTIONAL DESCRIPTION



HARRIS

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Figure 3-5. RT-1694(P) Encrypted Digital Voice Simplified Functional Block Diagram

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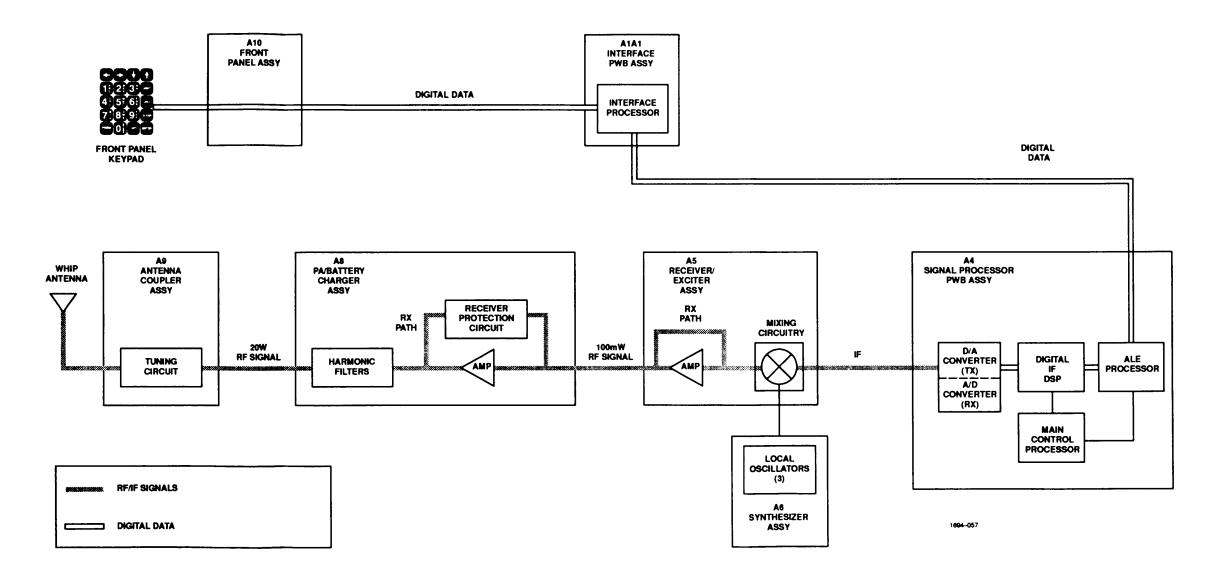


Figure 3-6. RT-1694(P) Automatic Link Establishment (ALE) Simplified Functional Block Diagram

3-19/3-20

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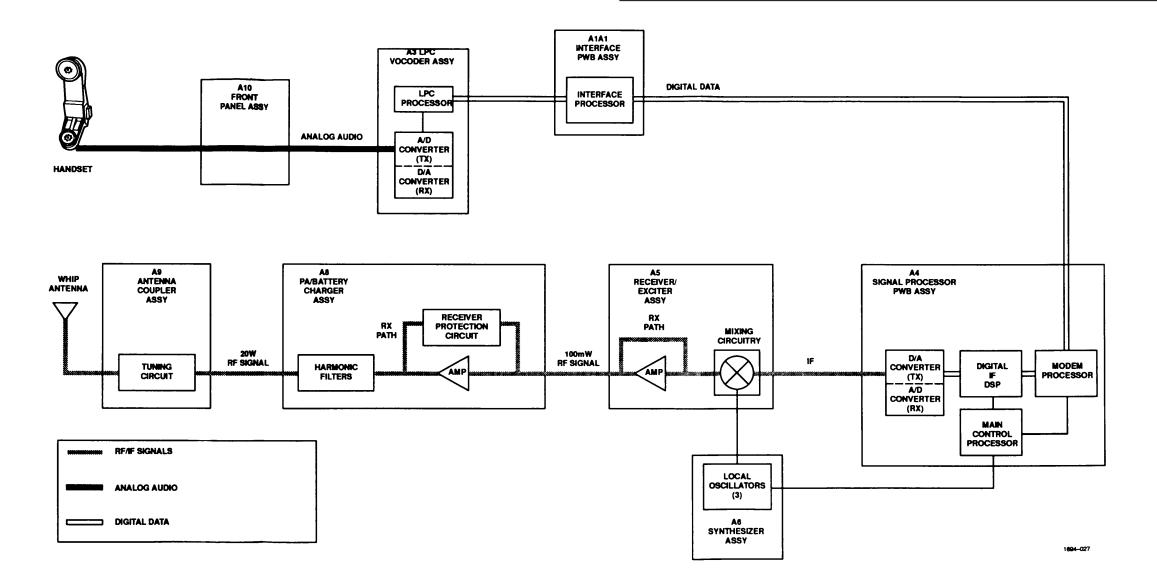


Figure 3-7. RT-1694(P) Frequency Hopping Simplified Functional Block Diagram

3-23/3-24

HARRIS	RT
RF COMMUNICATIONS	

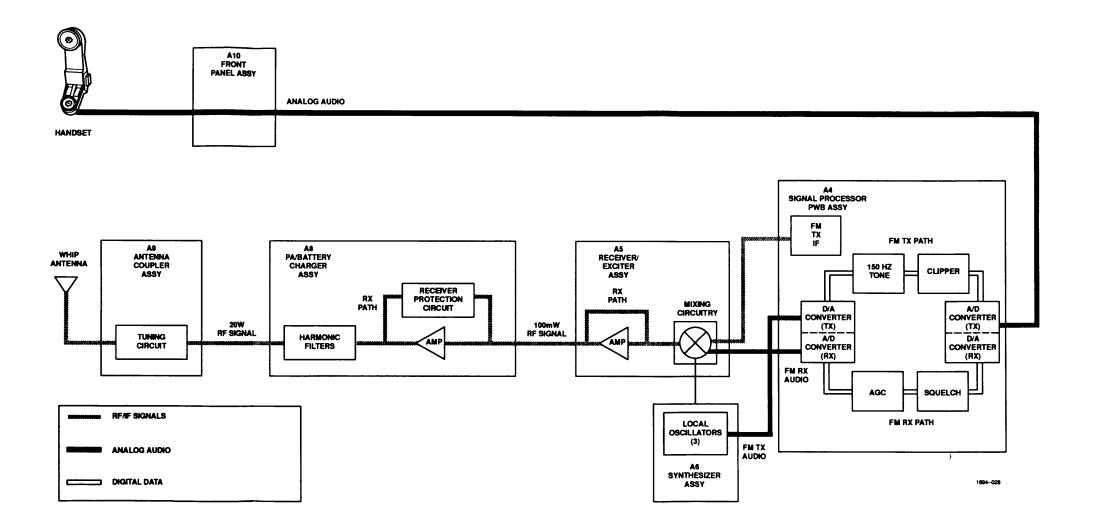


Figure 3-8. RT-1694(P) Frequency Modulation Simplified Functional Block Diagram

3-27/3-28

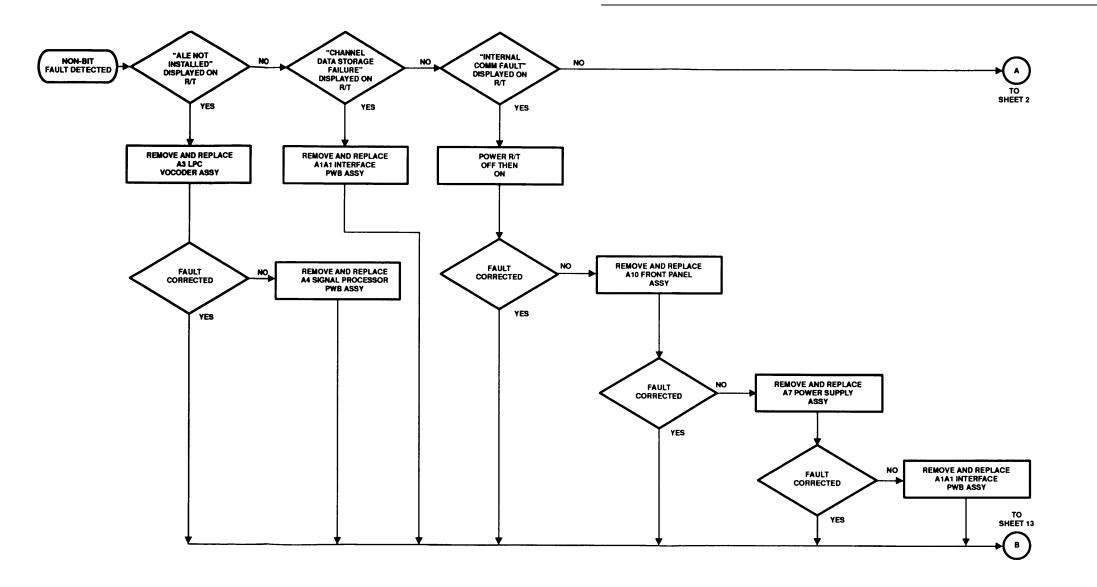


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 1 of 13)

5-11/5/12

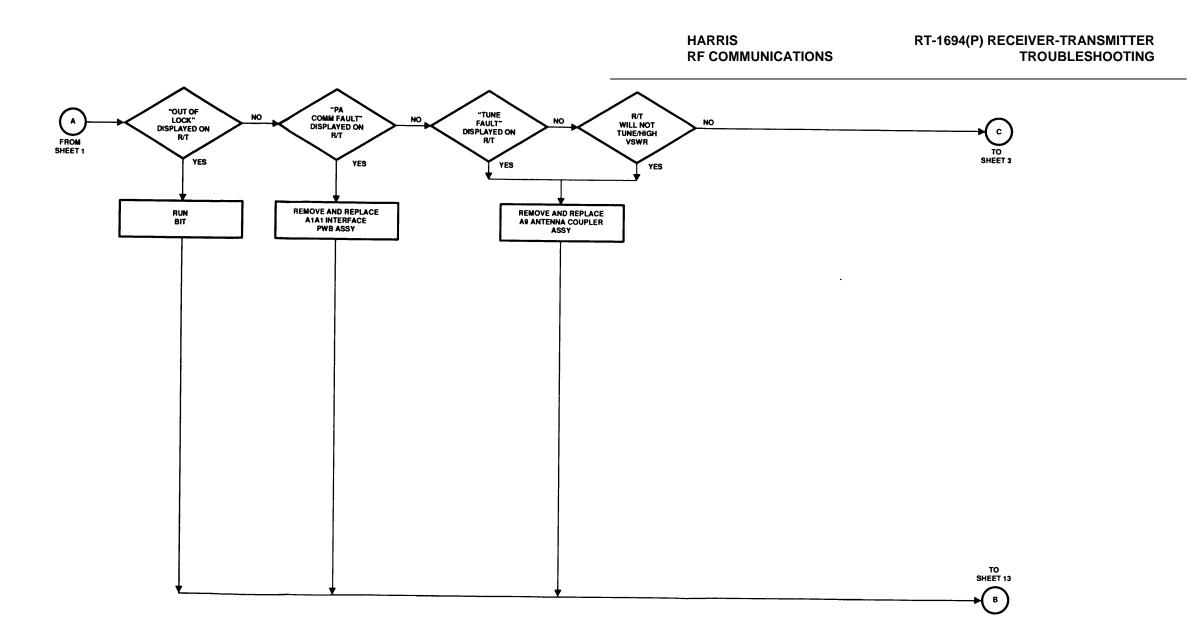


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 2 of 13)

5-13/5-14

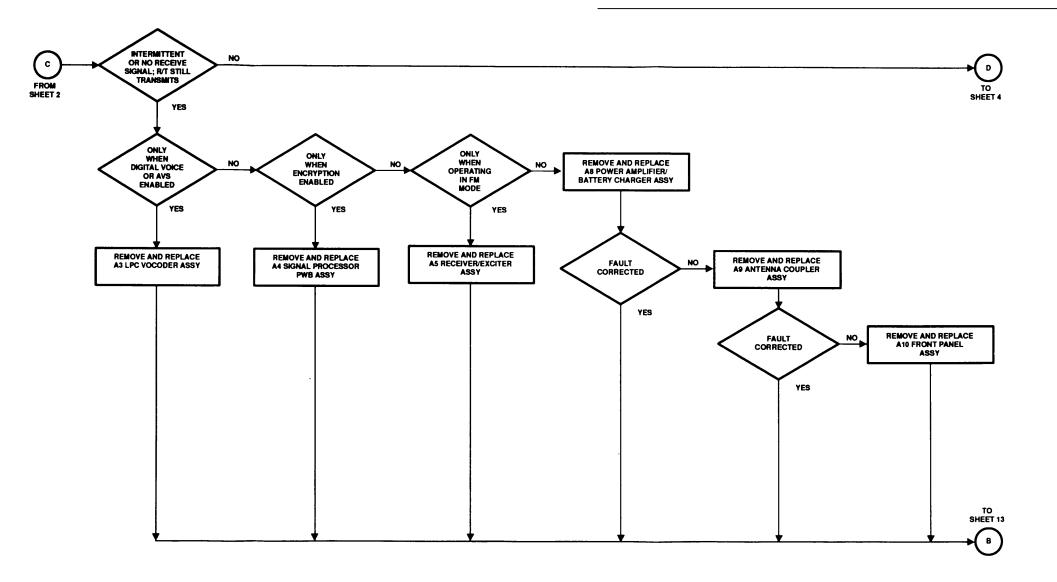


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 3 of 13)

5-15/5-16

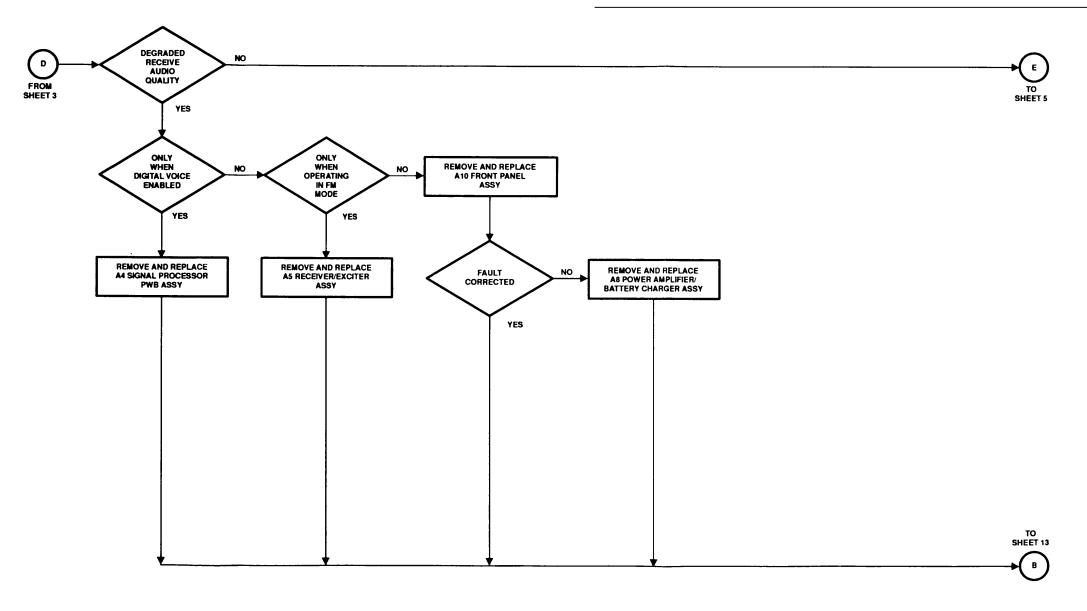


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 4 of 13)

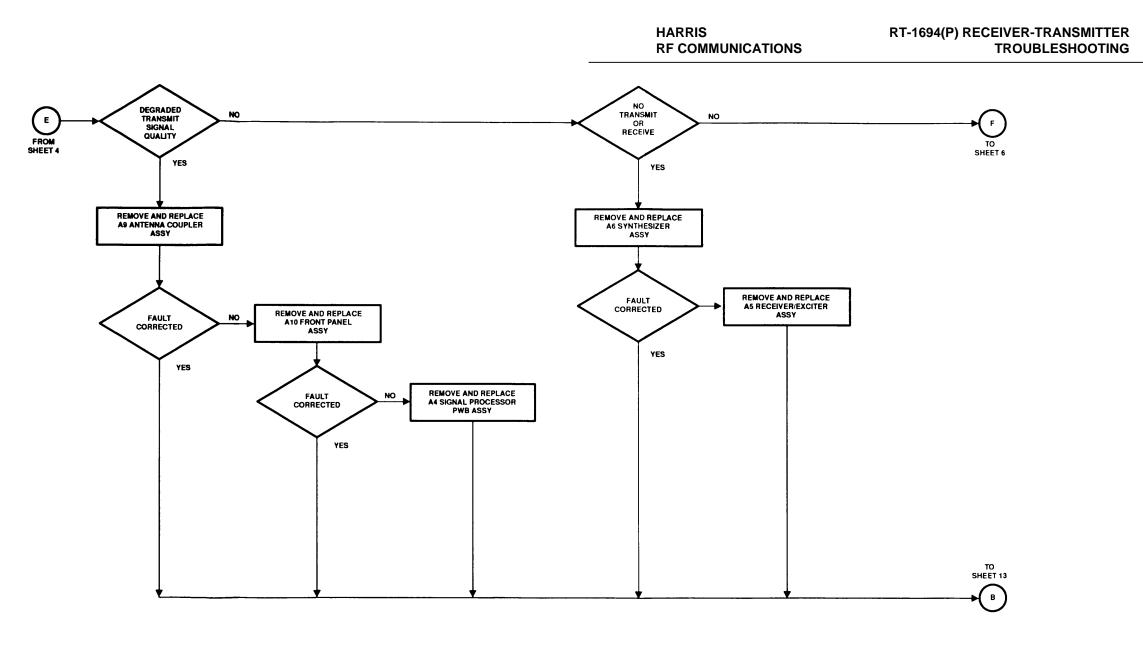


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 5 of 13)

5-19/5-20

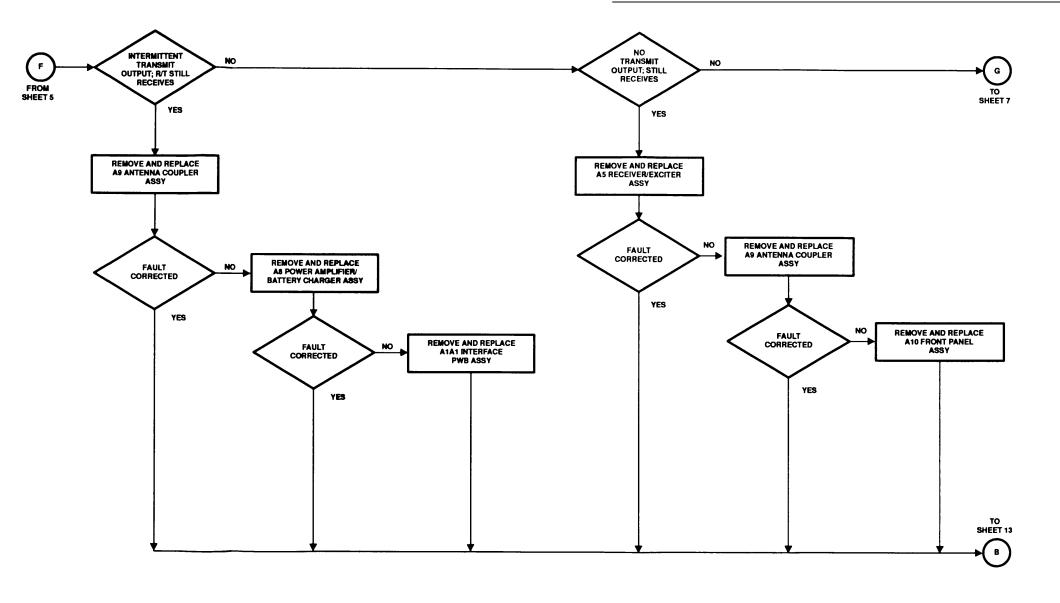


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 6 of 13)

5-21/5-22

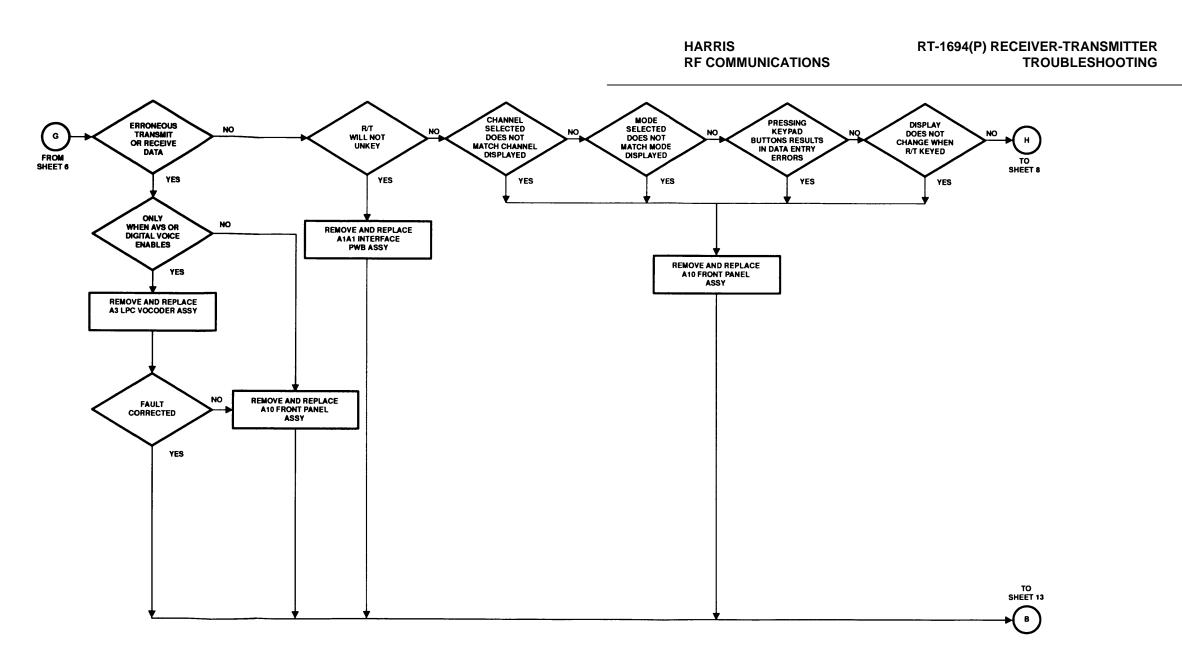


Figure 5-3. Non-BIT Fault Logic Diagram Sheet (7 of 13)

5-23/5-24

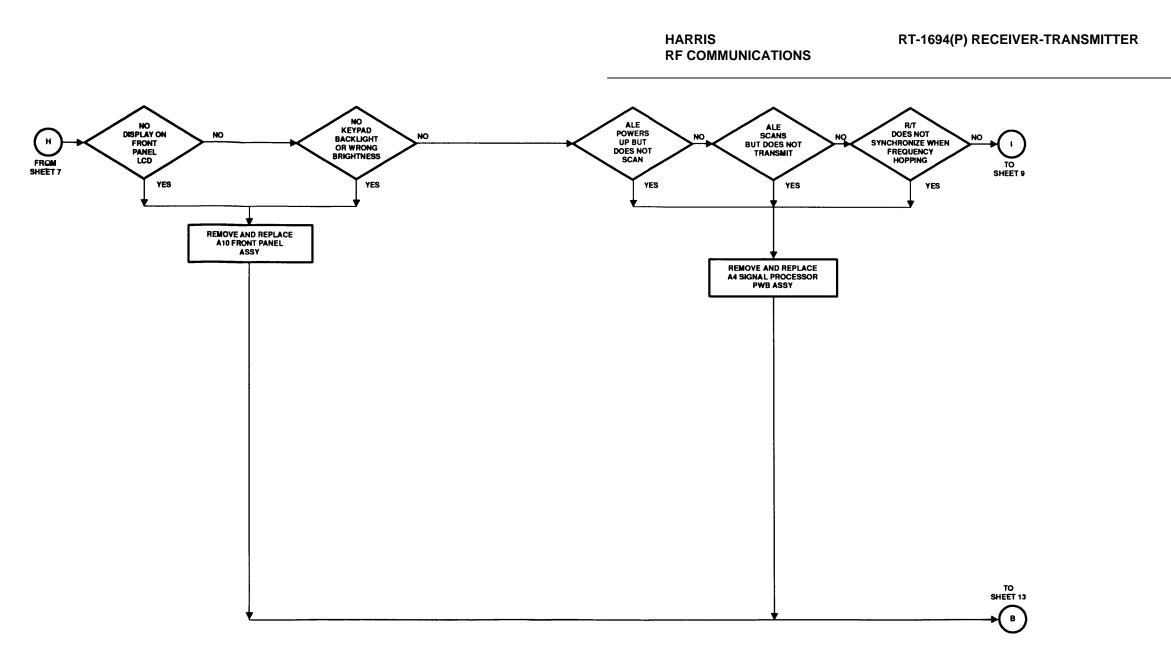


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 8 of 13)

5-25/5-26

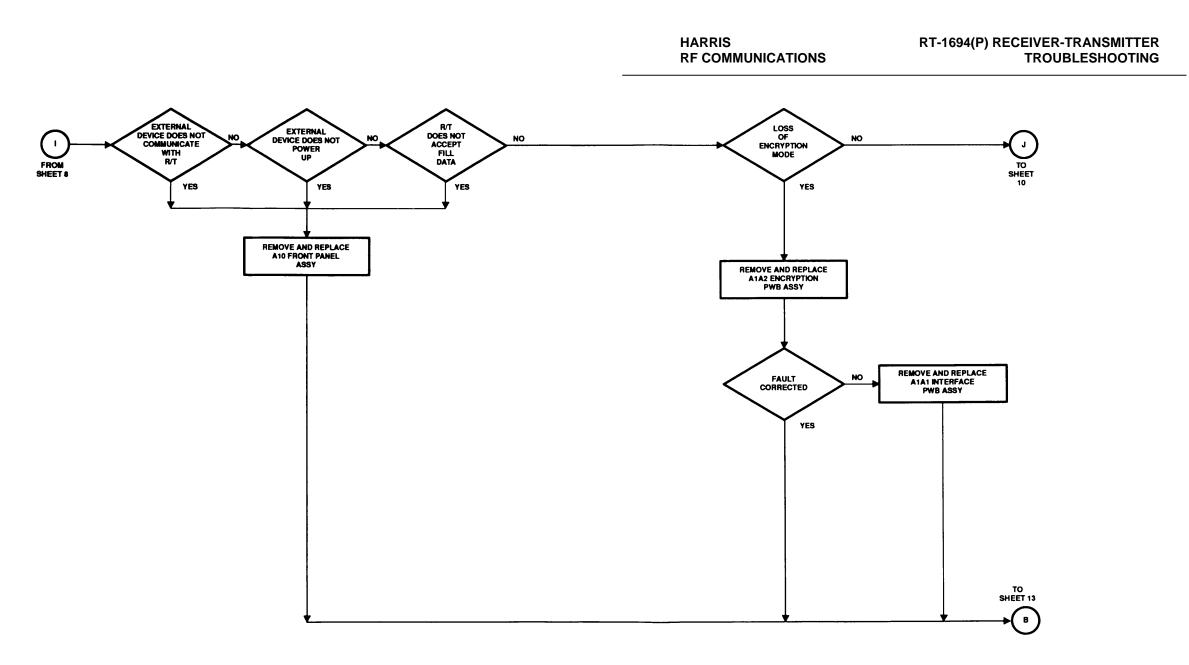


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 9 of 13)

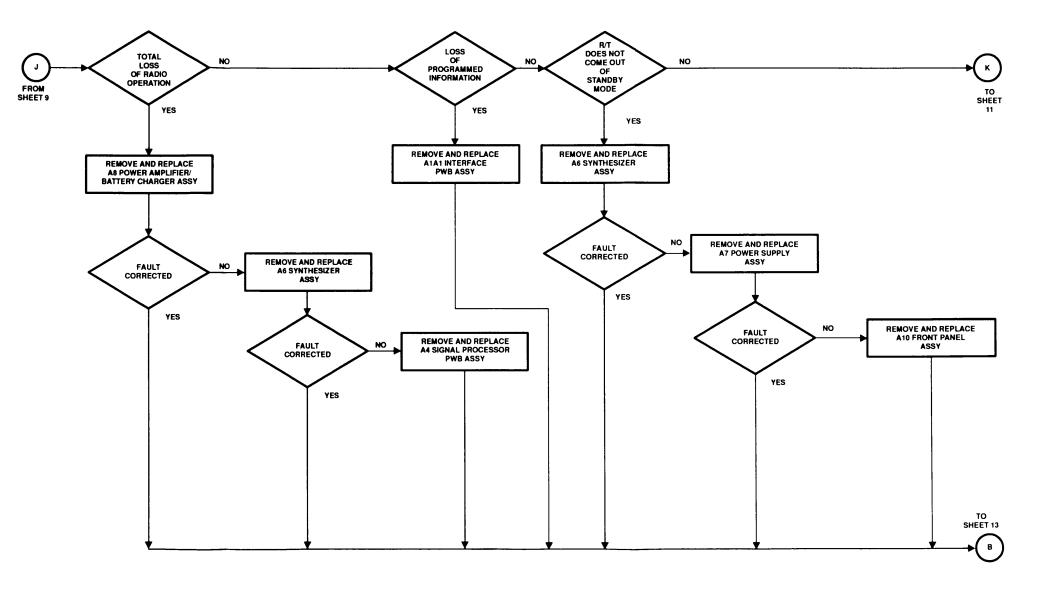
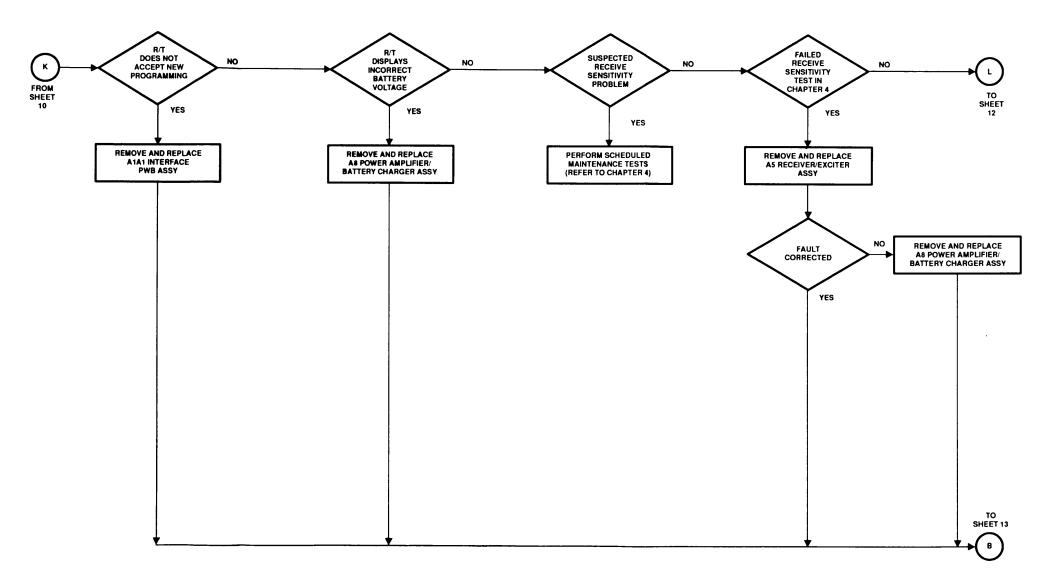


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 10-13)

5-29./5-30

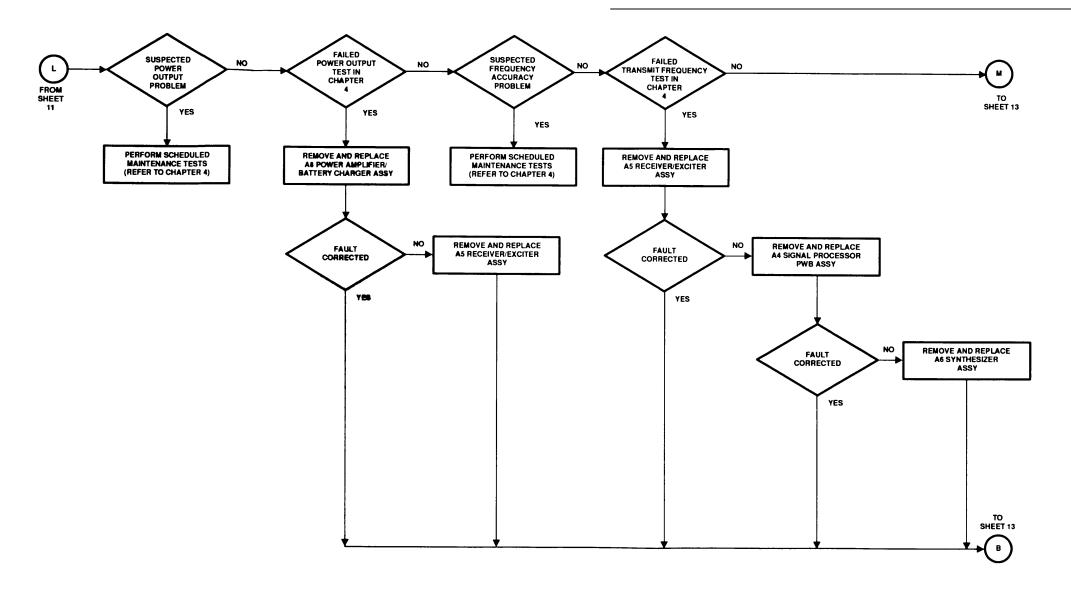


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Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 11 of 13)

5-31/5-32



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Figure 5-3. Non-BIT Fault Logic Diagram (Sheet12 of 13)

5-33/5-34

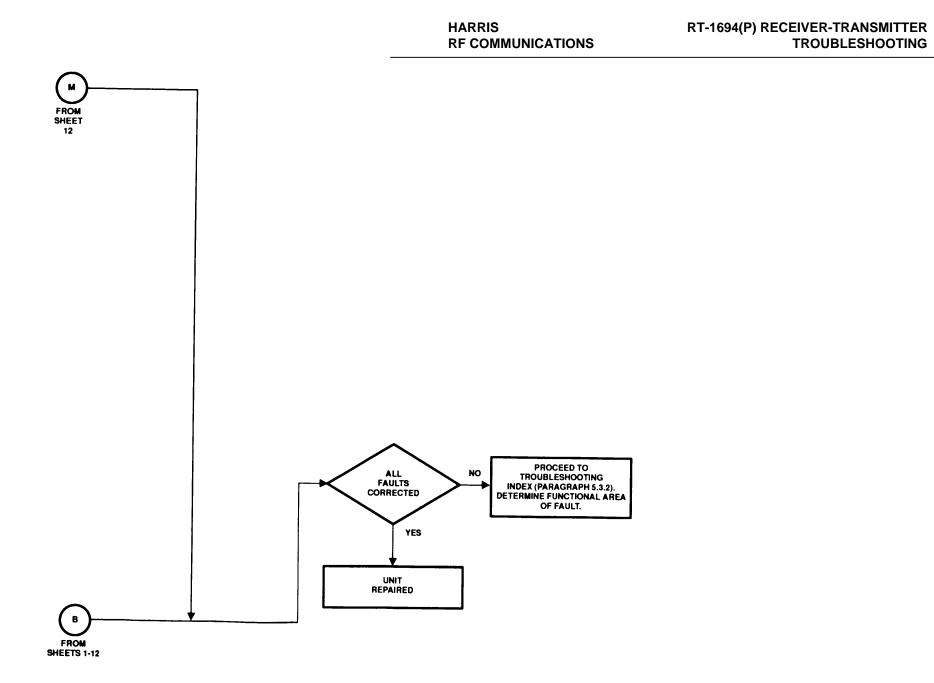


Figure 5-3. Non-BIT Fault Logic Diagram (Sheet 13 of 13)

5-35/5-36

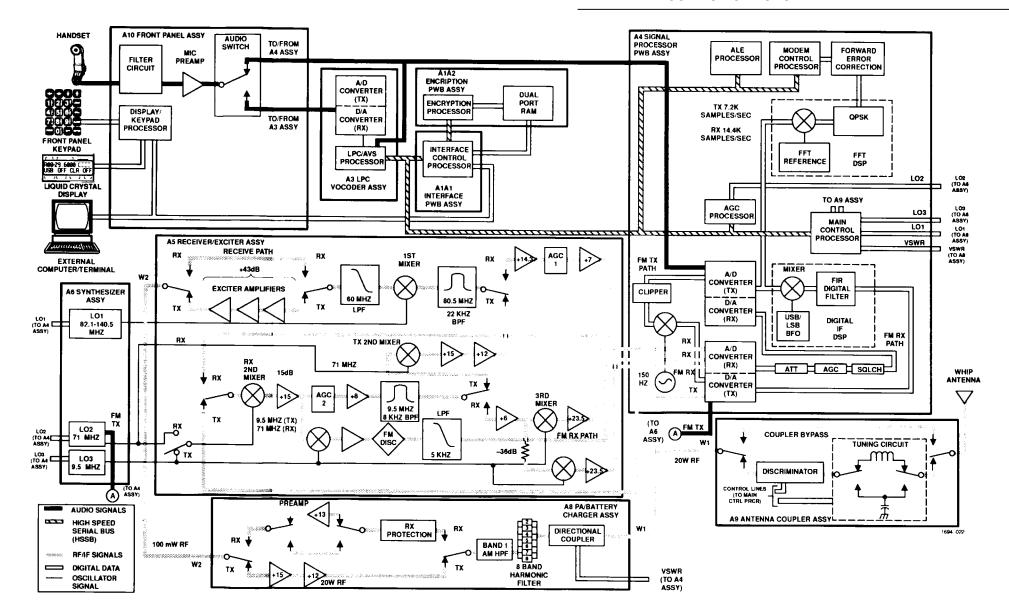


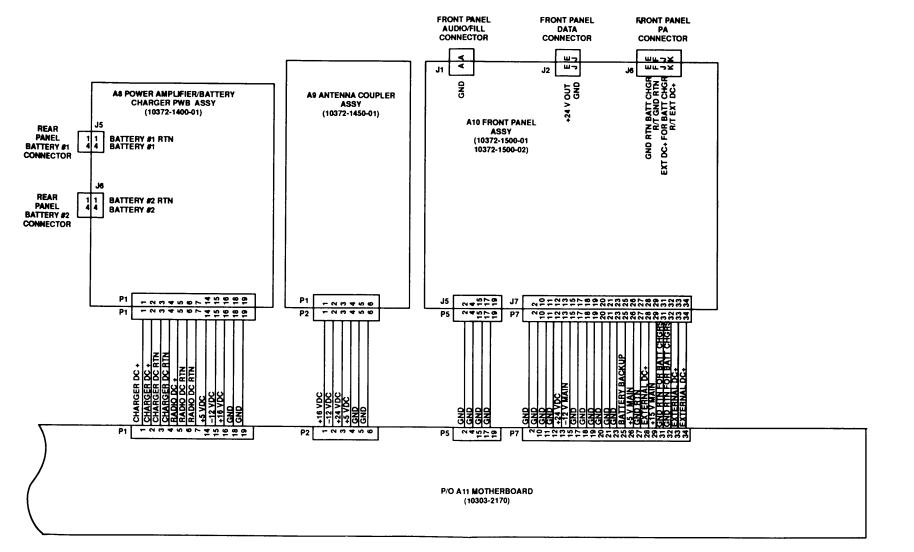
Figure 5-4. RF/IF/Audio/Digital/Control Signal Path Diagram

5-39/5-40

		_	HARRIS RF COMM	UNICATIONS	RT-1694(P) RECEIVER-TRANSMITTER TROUBLESHOOTING	
A1A2 ENCRYPTION PWB ASSY (10303-2240) SU WS COO SO SO P2 P2 P2 P2 P2 P2 P2 P2 P2 P2		[]		[]	[]	
	A3 LPC VOCODER ASSY (10372-3440-01)	A4 SIGNAL PROCESSOR PWB ASSY (10303-2500)	A5 RECEIVER/ EXCITER ASSY (10303-2600)	A6 SYNTHESIZER ASSY (10303-2700)	A7 POWER SUPPLY ASSY (10303-2200)	
A1A1 INTERFACE PWB ASSY (10303-2280) ΟΕΕΕΕ ΥΣΟΤΟ ΤΟΟΕΕΕ ΥΠΟΟΟΟΟΟΟ ΤΟΟΕΕΕ ΥΠΟΟΟΟΟΟΟ ΤΟΟΕΕΕ ΤΟΟΟΟΟΟΟΟ ΟΟΕΕΕΕ ΤΟΟΟΟΟΟΟΟ	TNERNANA	Superior Superior	40000000000000000000000000000000000000	000 000 000 000 000 000 000 000	TITEN ATTA TABLE A STERY A BATTERY A BATT	

1694-036(A) SHEET 1 OF 2

Figure 5-5. Power Distribution Diagram (Sheet 1 of 2)



1694-036(A) SHEET 2 OF 2

Figure 5-5. Power Distribution Diagram (Sheet 2 of 2)

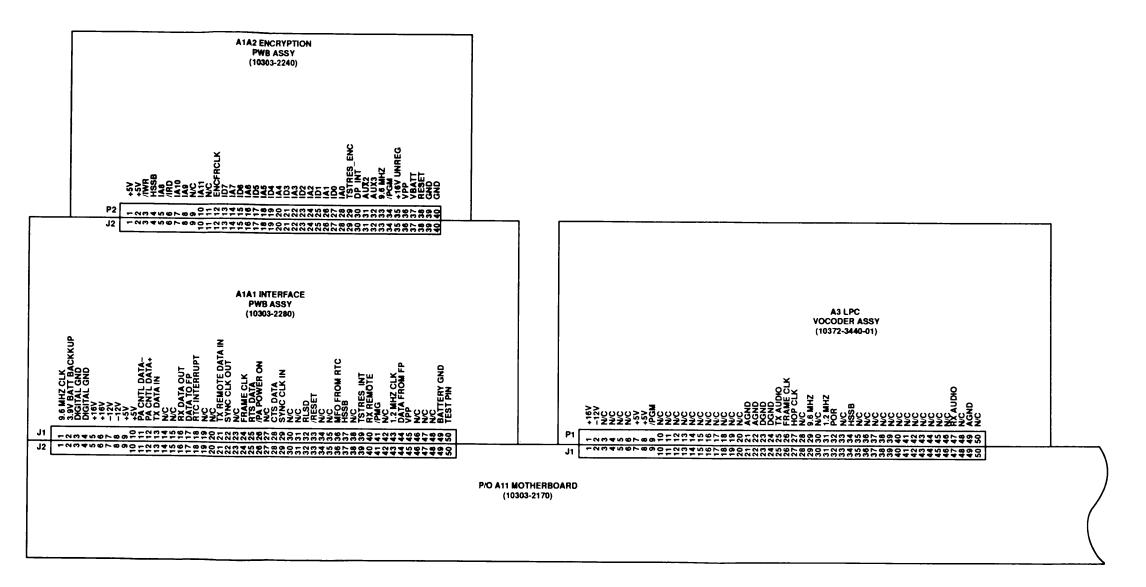


Figure 5-6. RT-1694(P) Receiver-Transmitter Interconnect Schematic Diagram (Sheet 2 of 6)

5-45/5-46



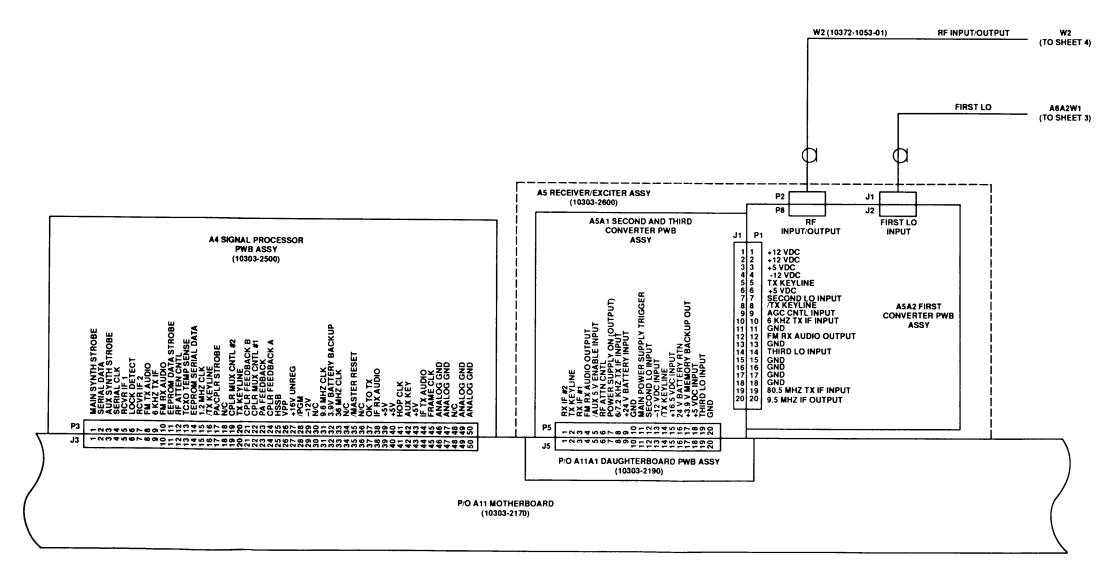
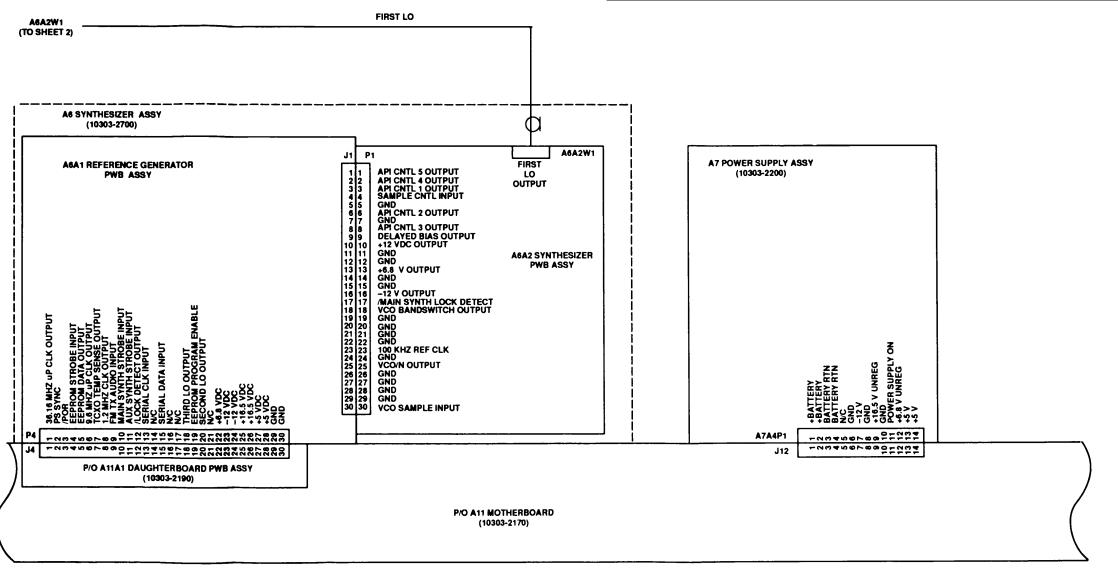


Figure 5-6. RT-1694(P) Receiver-Transmitter Interconnect Schematic Diagram (Sheet 2 of 6)

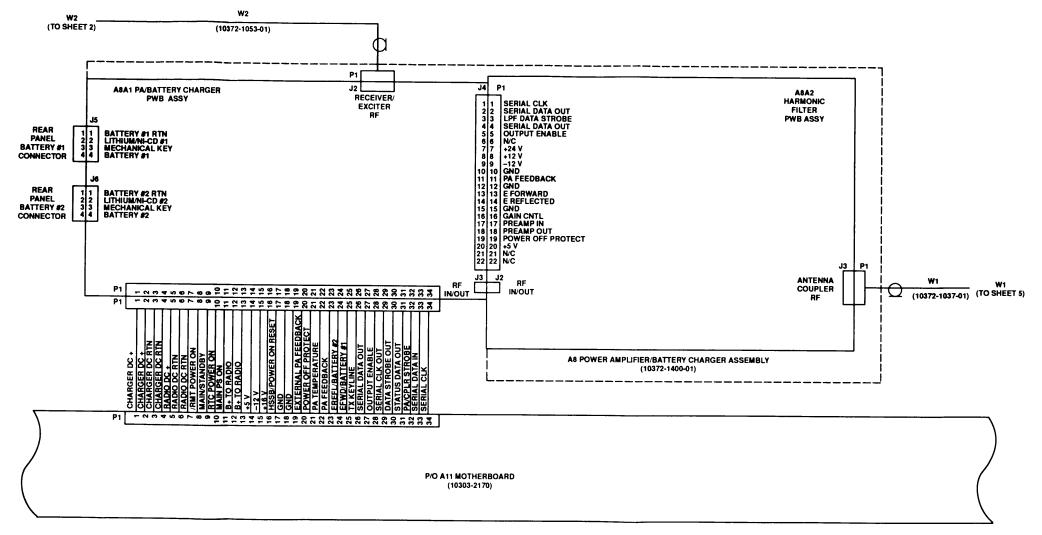
5-47/5-48



1694-037(A) SHEET 3 OF 6

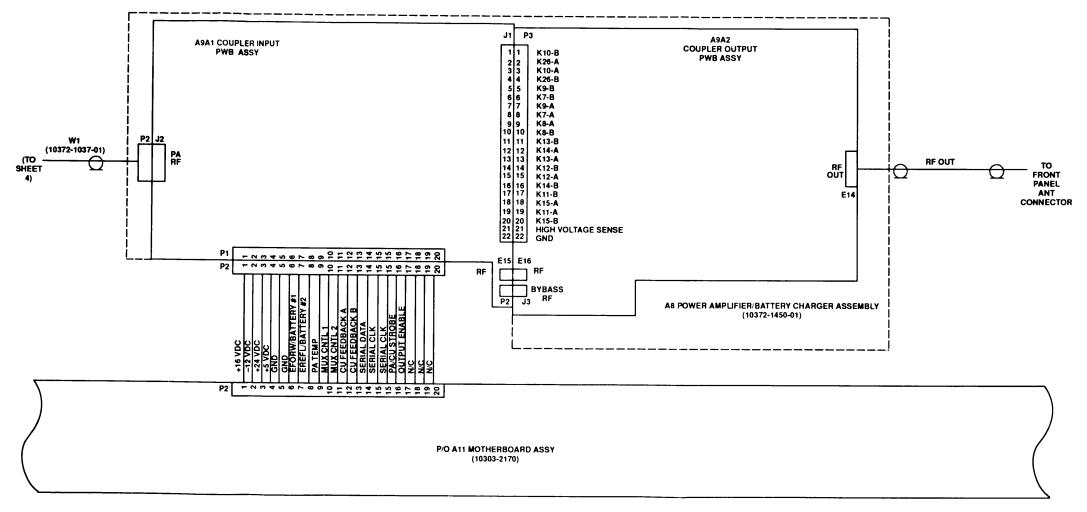
Figure 5-6. R-1694(P) Receiver Transmitter Interconnect Schematic Diagram (Sheet 3 of 6)

HARRIS	RT-1694
RF COMMUNICATIONS	



1694–037(A) SHEET 4 OF 6

Figure 5-6. RT-1694(P) Receiver-Transmitter Interconnect Schematic Diagram (Sheet 4 of 6)



1694-037(A) SHEET 5 OF 6

Figure 5-6. RT-1694(P) Receiver-Transmitter Interconnect Schematic Diagram (Sheet 5 of 6)

5-53/5-54

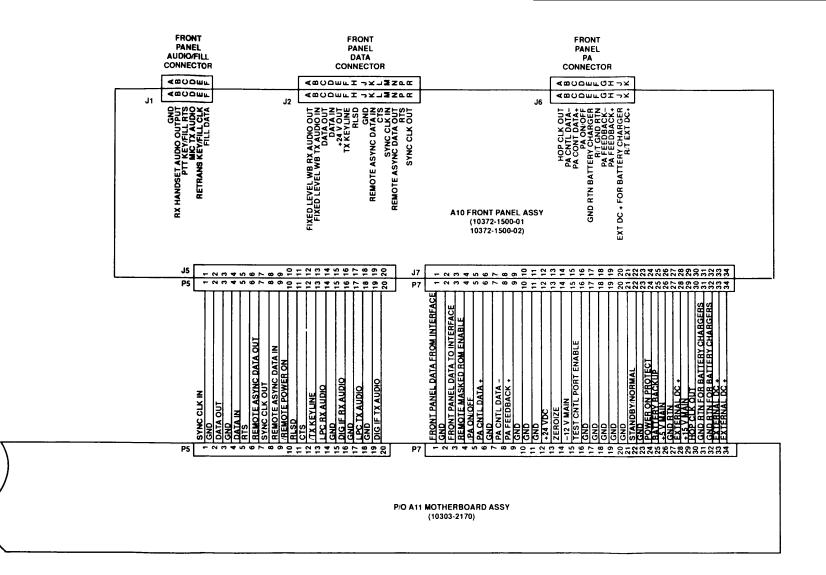


Figure 5-6. RT-1694(P) Receiver-Transmitter Interconnect Schematic Diagram (Sheet 6 of 6)

5-55/5-56

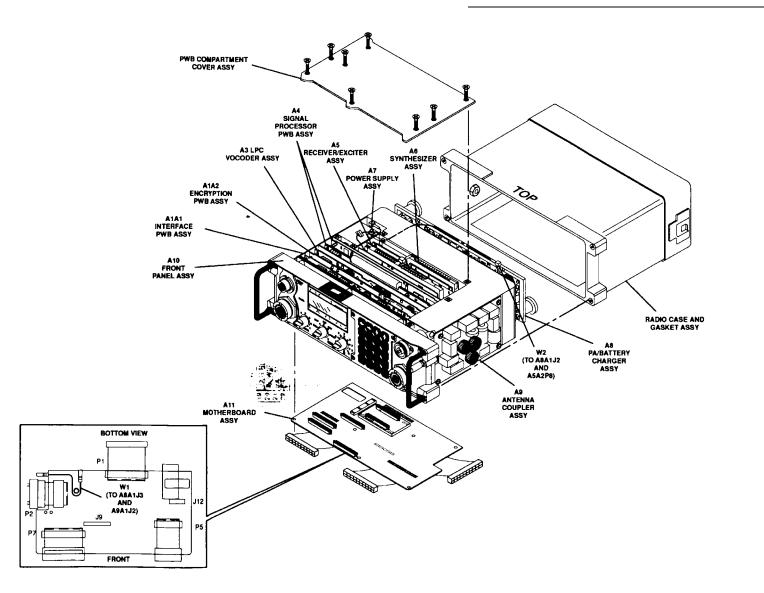


Figure 6-1. RT-1694(P) Master Connection and Hardware Locations

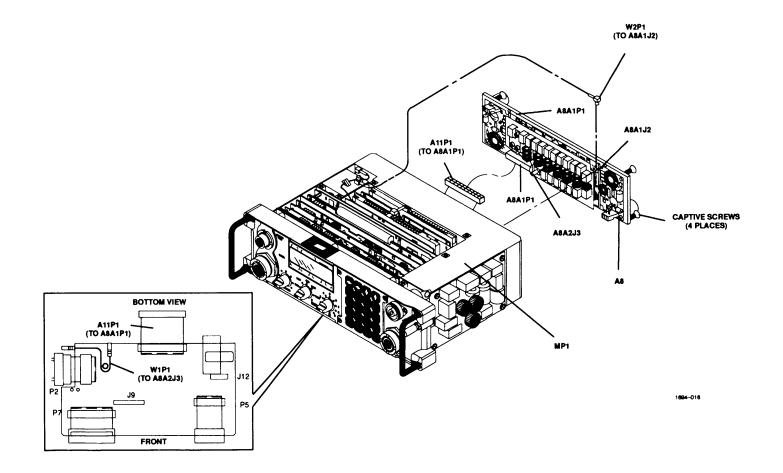


Figure 6-10. A8 Power Amplifier/Battery Charger Assembly Connector and Hardware Locations

6-29/6-30

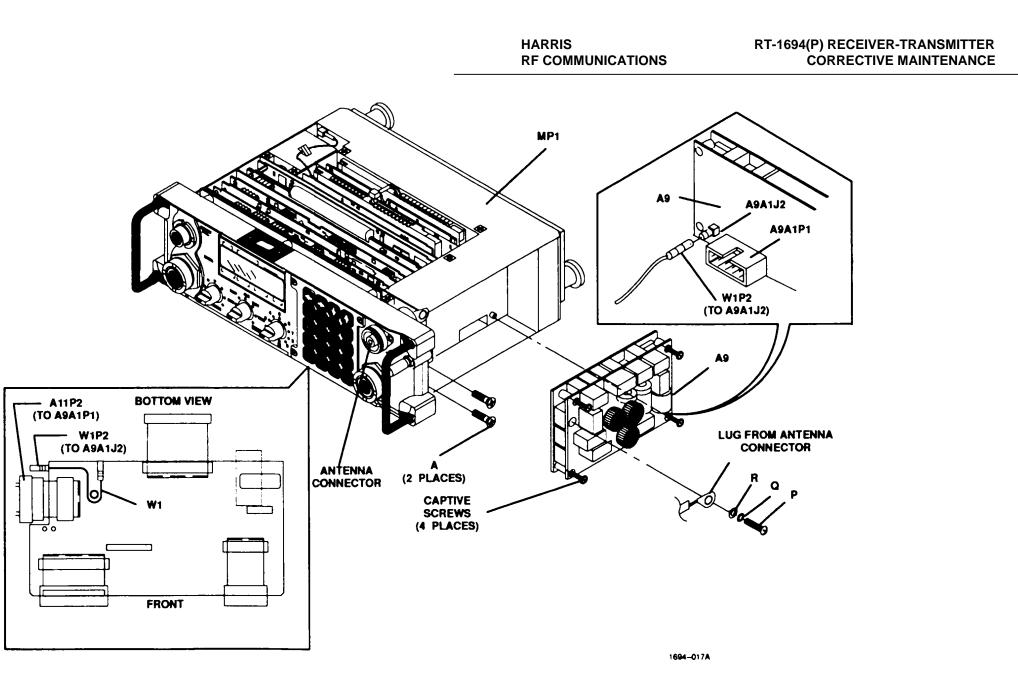


Figure 6-11. A9 Antenna Coupler Assembly Connector and Hardware Locations

6-33/6-34

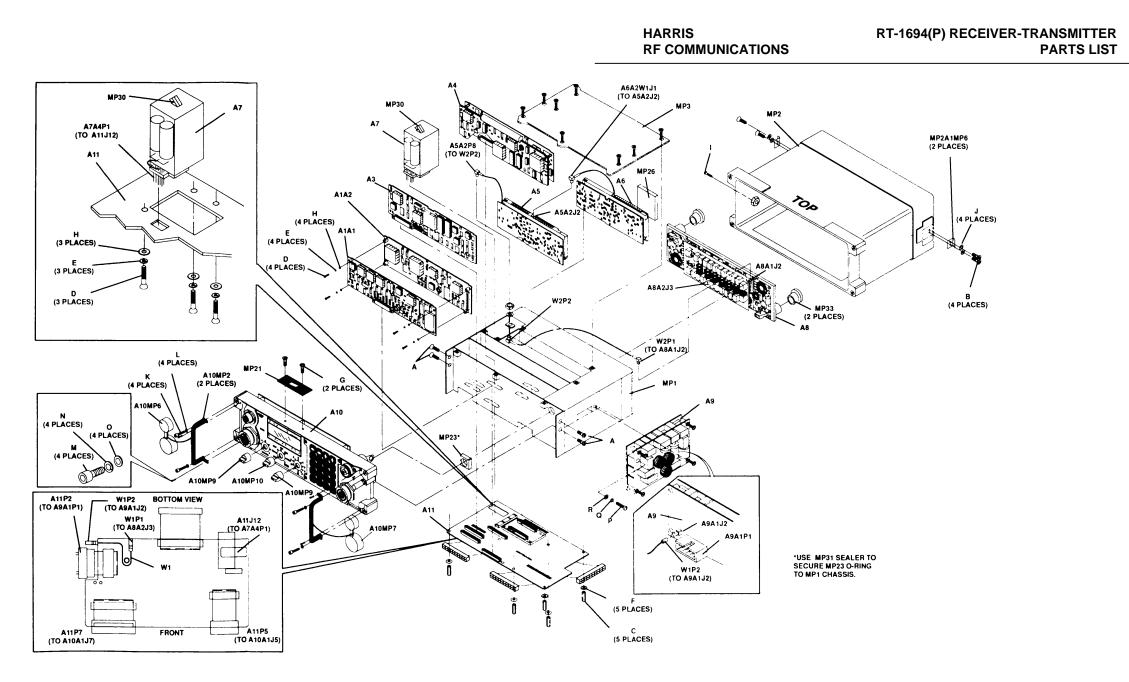


Figure 7-1. RT-1694(P) Receiver-Transmitter Illustrated Parts List

/ ["]		Some	THONG	WRONG WITH THIS PUBLICATIO	
	DOP FOR	N JOT DOWN THE E ABOUT IT ON THIS M, CAREFULLY TEAR IT	\mathbf{M}	(PRINT YOUR UNIT'S COMPLETE ADDRESS)	
		FOLD IT AND DROP IT HE MAIL'	DATES	ENT	
PUBLICATION NUL	<u> </u>	PUBLICATION		PUBLICATION TITLE	
TM 11-582		23 Jul		Radio Frequency R-2176/FRN	
BE EXACTPIN	-POINT WHERE IT	IS IN THIS SPACE TEL	L WHAT IS	WRONG	
	1 1				

PIN: 075488-000